Toshiba Personal Computer QOSMIO F10 Maintenance Manual

TOSHIBA CORPORATION

File Number 960-498

Copyright

© 2004 by Toshiba Corporation. All rights reserved. Under the copyright laws, this manual cannot be reproduced in any form without the prior written permission of Toshiba. No patent liability is assumed with respect to the use of the information contained herein.

Toshiba QOSMIO F10 Maintenance Manual

First edition October 2004

Disclaimer

The information presented in this manual has been reviewed and validated for accuracy. The included set of instructions and descriptions are accurate for the QOSMIO F10 at the time of this manual's production. However, succeeding computers and manuals are subject to change without notice. Therefore, Toshiba assumes no liability for damages incurred directly or indirectly from errors, omissions, or discrepancies between any succeeding product and this manual.

Trademarks

IBM is a registered trademark and IBM PC is a trademark of International Business Machines Corporation.

Intel, Intel SpeedStep, Centrino and Pentium are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries/regions.

Windows and Microsoft are registered trademarks of Microsoft Corporation.

Photo CD is a trademark of Eastman Kodak.

Bluetooth is a trademark owned by its proprietor and used by TOSHIBA under license. Memory Stick is a registered trademark and i.LINK is a trademark of Sony Corporation.

Other trademarks and registered trademarks not listed above may be used in this manual.

Preface

This maintenance manual describes how to perform hardware service maintenance for the Toshiba Personal Computer QOSMIO F10.

NOTE: Each model of QOSMIO F10 has a different configuration. For each model's configuration, refer to the parts list dedicated to it.

The procedures described in this manual are intended to help service technicians isolate faulty Field Replaceable Units (FRUs) and replace them in the field.

SAFETY PRECAUTIONS

Four types of messages are used in this manual to bring important information to your attention. Each of these messages will be italicized and identified as shown below.

DANGER: "Danger" indicates the existence of a hazard that could result in death or serious bodily injury, if the safety instruction is not observed.

WARNING: "Warning" indicates the existence of a hazard that could result in bodily injury, if the safety instruction is not observed.

CAUTION: "Caution" indicates the existence of a hazard that could result in property damage, if the safety instruction is not observed.

NOTE: "Note" contains general information that relates to your safe maintenance service.

Improper repair of the computer may result in safety hazards. Toshiba requires service technicians and authorized dealers or service providers to ensure the following safety precautions are adhered to strictly.

- Be sure to fasten screws securely with the right screwdriver. Be sure to use the PH Point size "0" and "1" screwdrivers complying with the ISO/DIS 8764-1:1996. If a screw is not fully fastened, it could come loose, creating a danger of a short circuit, which could cause overheating, smoke or fire.
- If you replace the battery pack or RTC battery, be sure to use only the same model battery or an equivalent battery recommended by Toshiba. Installation of the wrong battery can cause the battery to explode.

The manual is divided into the following parts:

Chapter 1 Hardware Overview describes the QOSMIO F10 system unit and each FRU.

Chapter 2 Troubleshooting Procedures explains how to diagnose and resolve FRU problems.

Chapter 3 Test and Diagnostics describes how to perform test and diagnostic operations for maintenance service.

Chapter 4 Replacement Procedures describes the removal and replacement of the FRUs.

Appendices The appendices describe the following:

- ? Handling the LCD module
- ? Board layout
- ? Pin assignment
- ? Keyboard scan/character codes
- ? Key layout
- ? Wiring diagrams
- ? BIOS Rewrite procedures
- ? EC/KBC Rewrite procedures
- ? Reliability

Conventions

This manual uses the following formats to describe, identify, and highlight terms and operating procedures.

Acronyms

On the first appearance and whenever necessary for clarification acronyms are enclosed in parentheses following their definition. For example:

Read Only Memory (ROM)

Keys

Keys are used in the text to describe many operations. The key top symbol as it appears on the keyboard is printed in **boldface** type.

Key operation

Some operations require you to simultaneously use two or more keys. We identify such operations by the key top symbols separated by a plus (+) sign. For example, **Ctrl + Pause** (**Break**) means you must hold down **Ctrl** and at the same time press **Pause** (**Break**). If three keys are used, hold down the first two and at the same time press the third.

User input

Text that you are instructed to type in is shown in the boldface type below:

DISKCOPY A: B:

The display

Text generated by the computer that appears on its display is presented in the type face below:

Format complete
System transferred

Table of Contents

Chap	oter 1 Hardware Overview	
1.1	Features	1-1
1.2	System Block Diagram	1-5
1.3	2.5-inch Hard Disk Drive	1-10
1.4	Optical Drive	1-14
1.5	Keyboard	1-19
1.6	TFT Color Display	1-20
1.7	Power Supply	1-22
1.8	Batteries	1-24
1.9	AC Adapter	1-27
Chap	oter 2 Troubleshooting Procedures	
2.1	Troubleshooting	2-1
2.2	Troubleshooting Flowchart	2-2
2.3	Power Supply Troubleshooting	2-6
2.4	System Board Troubleshooting	2-16
2.5	USB 3.5" FDD Troubleshooting	2-37
2.6	2.5" HDD Troubleshooting	2-40
2.7	Keyboard Troubleshooting	2-45
2.8	Touch Pad Troubleshooting	2-46
2.9	Display Troubleshooting	2-47
2.10	Optical Drive Troubleshooting	2-50
2.11	Modem Troubleshooting	2-51
2.12	LAN Troubleshooting	2-52
2.13	Wireless LAN Troubleshooting	2-53
2.14	Sound Troubleshooting	2-56
2.15	TV Tuner Troubleshooting	2-58

Chapter 3 Tests and Diagnostics

3.1	The Diagnostic Test	3-1
3.2	Executing the Diagnostic Test	3-4
3.3	Setting of the hardware configuration	3-8
3.4	Heatrun Test	3-11
3.5	Subtest Names	3-12
3.6	System Test	3-14
3.7	Memory Test	3-16
3.8	Keyboard Test	3-17
3.9	Display Test	3-18
3.10	Floppy Disk Test	3-21
3.11	Printer Test	3-23
3.12	Async Test	3-25
3.13	Hard Disk Test	3-26
3.14	Real Timer Test	3-29
3.15	NDP Test	3-31
3.16	Expansion Test	3-32
3.17	CD-ROM/DVD-ROM Test	3-34
3.18	Error Code and Error Status Names	3-35
3.19	Hard Disk Test Detail Status	3-38
3.20	Only One Test	3-40
3.21	Head Cleaning	3-47
3.22	Log Utilities	3-48
3.23	Running Test	3-50
3.24	Floppy Disk Drive Utilities	3-51
3.25	System Configuration	3-56
3.26	Wireless LAN Test Program (Intel-made b/g)	3-58
3.27	Wireless LAN Test Program (Intel-made a/b/g)	3-62
3.28	Wireless LAN Test Program (Askey-made)	3-67
3.29	LAN/Modem/Bluetooth/IEEE1394 Test Program	3-71
3.30	Sound Test Program	3-85
3.31	SETUP	3-91

Chapter 4 Replacement Procedures

4.1	Overview	4-1
4.2	Battery pack/PC card/Bridge Media	4-8
4.3	HDD4	1-12
4.4	Memory module	1 -15
4.5	Keyboard/Bluetooth4	1 -17
4.6	Switch membrane	1-22
4.7	Optical drive	1-24
4.8	Display assembly4	1-26
4.9	SD board/MDC4	1-32
4.10	Fan	1-34
4.11	Wireless LAN board	1-36
4.12	System board	1-37
4.13	RTC battery4	1-40
4.14	TV tuner module/Guide	1-41
4.15	Heat sink/CPU4	1-44
4.16	VGA Heat sink	1-47
4.17	PC card cover	1-48
4.18	Speaker/VGA fan	1-49
4.19	Battery latch	1-51
4.20	Touch pad4	1-53
4.21	SJ board	1-55
4.22	Microphone	1-57
4.23	LCD unit/FL inverter	1-58
4.24	Wireless antennas/ LCD harness	1-63
4.25	Hinge4	1-67
4.26	Fluorescent lamp4	1-70

Appendices

Appendix A	Handling the LCD Module	A-1
Appendix B	Board Layout	B-1
Appendix C	Pin Assignment	C-1
Appendix D	Keyboard Scan/Character Codes	D-1
Appendix E	Key Layout	E-1
Appendix F	Wiring Diagrams	F-1
Appendix G	BIOS Rewite procedures	G-1
Appendix H	EC/KBC Rewrite procedures	H-1
Appendix I	Reliability	I-1

Chapter 1 Hardware Overview

Chapter 1 Contents

1.1	Features		1-1
1.2	System Blo	ock Diagram	1-5
1.3	2.5-inch H	ard Disk Drive	1-10
1.4	Optical Dri	ive	1-14
1.5	Keyboard		1-19
1.6	TFT Color	Display	1-20
	1.6.1	LCD Module	1-20
	1.6.2	FL Inverter Board	1-21
1.7	Power Sup	ply	1-22
1.8	Batteries		1-24
	1.8.1	Main Battery	1-24
	1.8.2	Battery Charging Control	
	1.8.3	RTC battery	1-26
1.9	AC Adapte	er	1-27

Figures		
Figure 1-1	Front of the computer and the system units configuration	1-4
Figure 1-2	System block diagram	1-5
Figure 1-3	2.5-inch HDD	1-10
Figure 1-4	DVD Super Muti drive	1-14
Figure 1-5	Keyboard	1-19
Figure 1-6	LCD module	1-20
Tables		
Table 1-1	2.5-inch HDD dimensions	1-10
Table 1-2	2.5-inch HDD specifications	1-12
Table 1-3	DVD Super Multi drive outline dimensions	1-14
Table 1-4	DVD Super Multi specifications	1-15
Table 1-5	LCD module specifications	1-20
Table 1-6	FL inverter board specifications	1-21
Table 1-7	Power supply output rating	1-22
Table 1-8	Battery specifications	1-24
Table 1-9	Time required for charges of main battery	1-25
Table 1-10	Data preservation time	1-25
Table 1-11	Time required for charges of RTC battery	1-26
Table 1-12	AC adapter specifications	1-27

1 Hardware Overview 1.1 Features

1.1 Features

The QOSMIO F10 series are high performance all-in-one PCs running a Pentium-M processor.

The features are listed below.

? Microprocessor

Microprocessor that is used depends on the model.

Mobile Intel ® Pentium ®-M

```
Pentium-M
1.50GHz (Processor Number; 715)
1.60GHz (Processor Number; 725)
1.70GHz (Processor Number; 735)
1.80GHz (Processor Number; 745)
2.00GHz (Processor Number; 755)
2.10GHz (Processor Number; 765)
```

L1 cache : 64KB (32KB + 32KB)

L2 cache: 2MB

? Memory

Two DDR333 SO-DIMM slots. Memory modules can be installed to provide a maximum of 2GB. Memory modules are available in 256MB, 512MB and 1,024MB sizes.

? VRAM

nVIDIA NV36M is mounted as GPU. VRAM area is 64MB or 128MB.

? HDD

Single 60GB, 80GB or 100GB internal drive. 2.5 inch x 9.5mm height.

? USB FDD

USB 3.5-inch FDD supports 720KB and 1.44MB.

? Display

LCD

Built-in 15.4-inch, XGA (1,280 x 800 dots), 262,144 colors, amorphous silicon TFT color display. Clear Super View LCD.

CRT

Supported via a RGB connector.

TV-out

S-VIDEO/Composite out port is supported. (Supporting NTSC, PAL and SECAM)

D-VIDEO out port is supported.

? Monitor-IN port

This port can be used as AV input port (for composite video data) and also as line-in port which enables connection of a stereo device for audio input.

? TV-tuner (Mini PCI slot)

On some models, the TV tuner is equipped on the mini PCI slot. This enables to watch or record TV programs on the PC.

According to the government regulation, it is not permitted to bring this PAL/SECAM TV tuner into Korea.

? Remote controller

A remote controller for watching TV is supplied for some models.

? Keyboard

An-easy-to-use 85(US)/86(UK)-key keyboard provides a numeric keypad overlay for fast numeric data entry or for cursor and page control. The keyboard also includes two keys that have special functions in Microsoft? Windows? XP. It supports software that uses a 101- or 102-key enhanced keyboard.

? Optical devices

A DVD Super Multi drive is equipped. Some models support DVD+R Double layer disks.

1 Hardware Overview 1.1 Features

? Battery

The RTC battery is mounted inside the computer. The main battery is a detachable lithium ion battery (4,400mAh:Li-Ion, 6-cell).

? USB (Universal Serial Bus)

Four USB ports are provided. The ports comply with the USB2.0 standard, which enables data transfer speeds 40 times faster than USB1.1 standard. USB1.1 is also supported.

? PC card slot

PC card slot accepts one Type II (5mm thick) card. The slot is equipped with an ejector. Supports ToPIC-100 (3.3V/CardBus).

? Bridge Media slot

One SD card/Memory stick (PRO)/xDPicture card/Multi media card slot. Data can be read and written by inserting each media to the slot. Memory stick Duo/PRO Duo and memory stick adapter are not supported.

? Sound system

This model has an external moraural microphone jack, stereo headphone jack, internal stereo speakers and internal microphone.

? Wireless LAN (Mini PCI slot)

On some models, the wireless LAN is equipped on the mini PCI slot.

? LAN/MODEM

Connectors for LAN and Modem are separately mounted.

? IEEE 1394 port

The computer has one IEEE 1394 port. It enables high-speed data transfer directly from external devices such as digital video cameras.

? Bluetooth

Depending on the model, the computer is equipped with a dedicated Bluetooth module which supports v1.2. This enables a communication to devices that support Bluetooth Version 1.1 and 1.2. It can be switched on or off with a switch on the computer.

1.1 Features 1 Hardware Overview

Speaker (L) S-VIDEO(IN) Speaker (R) Ext.Mic Int.Mic CN9613 CN6002 CN6003 J6001 CN6000 TV antenna J2410 SJ board (FCLSJ*) DS6000 CN9560 PJ9550 Composite CN9612 -INHeadphone SD board CN3000 MDC CN2410 (FCLSD*) CN4621 CN9614 USB(Port 4) CN9510 CN9615 CN4620 CRT CN5080 CN9500 CN5801 CN4612 TV tuner CN2400 CN2110 PC card Network J4100 PJ5600 LCD CN1820 Optical drive Bluetooth CN4400 USB (port0) HDD CN4611 CN1800 System board USB (port2) CN4630 (FCLSY*) CN3230 Keyboard USB (port3) CN4631 CN3201 Touch Pad 1394 CN4200 CN8490 RTC battery DC-IN CN8800 IS2101 Bridge Media Battery CN8810 CN5502 D-Video CN8770 Fan Fan (VGA) CN8780 CN5501 S-Video (OUT) CN9650 CN3400 CN1400/1401 CN2200 Membrane SW Wireless LAN Memory A/B card Debug Port Wireless LAN antenna(Aux)

Figure 1-1 shows the front of the computer and the system units configuration.

Figure 1-1 Front of the computer and the system units configuration

Wireless LAN antenna(Main)

1.2 System Block Diagram

Figure 1-2 shows the system block diagram.

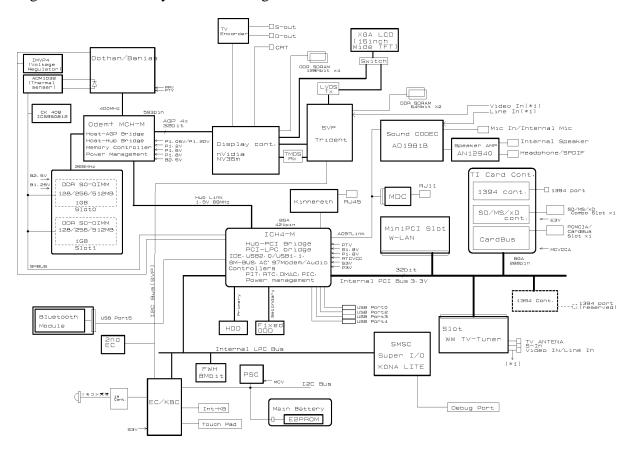


Figure 1-2 System block diagram

The PC contains the following components.

? CPU

Mobile Intel ® Pentium ®-M

Pentium-M
1.50GHz (Processor Number; 715)
1.60GHz (Processor Number; 725)
1.70GHz (Processor Number; 735)
1.80GHz (Processor Number; 745)
2.00GHz (Processor Number; 755)
2.10GHz (Processor Number; 765)

L1 cache : 64KB (32KB + 32KB)

L2 cache: 2MB

Bus: 400Hz Core voltage: 1.340 to 0.748V

? Memory

Two memory slots capable of accepting DDR-SDRAM (PC2700) 256MB, 512MB, or 1,024MB memory modules for a maximum of 2GB.

- ? 200-pin small-size DIMM
- ? 2.5V operation
- ? PC2700 support
- ? BIOS ROM (Flash memory)
 - ? 8Mbit (512K?16-bit chip)
 - ? 224KB used for system BIOS
 - ? 64KB used for VGA-BIOS
 - ? 64KB used for logo/icon
 - ? 60KB used for Intel PXE
 - ? 32KB used for ACPI
 - ? 17KB used for booting
 - ? 16KB used for MBI
 - ? 16KB used for Parameter Block
 - ? 19KB are reserved.

? Chipset

This gate array has the following elements and functions.

- ? North Bridge (Intel 855PME (MCH-M, B-step))
 - ? Pentium-M processor System Bus support
 - ? DRAM Controller : DDR333/DDR266/DDR200 support
 - ? AGP Interface (AGP R2.0, AGP x 4 modes)
 - ? Hub Link Interface
 - ? 593-ball 37.5mmx37.5mm FC-BGA Package
- ? South Bridge (Intel 82801DBM (ICH4-M))
 - ? PCI slot
 - ? IDE controller
 - ? DMA controller
 - ? USB host interface
 - ? USB 2.0 host controller
 - ? UHCI host controller
 - ? Interrupt controller
 - ? SM Bus interface
 - ? ACPI Power management
 - ? Firmware Hub interface
 - ? Low Pin count (LPC) interface
 - ? Real time clock
 - ? AC'97 Rev. 2.3 interface
 - ? Alert ON LAN (AOL)
 - ? 421-pin 31mmx31mm BGA Package
- ? PC card controller (Texas Instruments-made PCI7411)
 - ? PCI Interface (PCI Rev. 2.3)
 - ? PC Card Controller
 - ? IEEE1394 Controller
 - ? Flash Media Controller
 - ? SD Host Controller

- ? VGA controller
 - ? nVIDIA NV36M
 - ? VRAM 64MB/128MB
 - ? AGP 4x (32bit)
 - ? TMDS
 - ? TV Encoder
- ? Super I/O (SMSC-made LPC47N217)
 - ? Two serial ports (NS16C550 compatible) (1 port is used as Debug port)
- ? Other main system chips
 - ? PSC (Toshiba-made TMP87PM48U x 1)
 - ? Clock Generator (ICS-made 950812CGT x 1)
 - ? EC/KBC (Renesas-made HD64F2163BVTE10V x 1)
 - ? FWH (ATM-made AT49LW080-33TC/33TL or St-Micro-made M50FW080N1 x 1)
 - ? AC97-CODEC (ADI-made AD1981BJSTZ x 1)
 - ? Audio AMP (Matsushita-made AN12941AVF x1)
 - ? TV Encoder (Conexant-made CX25875 x 1)
 - ? SVP (Trident-made 6970-LF x 1)
- ? Mini PCI card slot

Two mini PCI card slots are equipped. A wireless LAN module and a TV tuner module are installed on each slot.

- ? Wireless LAN module (Intel-made 802.11b/g or 802.11a/b/g, or Askey-made 802.11b/g or 802.11a/b/g x 1)
 - 2.4GHz DSSS wireless LAN card is equipped in the mini PCI card slot. Conformity with IEEE 802.11b/g or IEEE 802a/b/g. Transfer speed is maximum of 11Mbit/sec. Supports 128bit WEP.
- ? TV tuner module (Toshiba-made MCPG01 x 1)

It is a capture module with built-in TV tuner function supporting worldwide broadcasting. It has also MPEG2 hardware encoding function. It encodes TV broadcasting signal and composite video, s-video and stereo audio signal to MPEG2 format in real time.

? LAN (Intel-made ED82562 (Kinnereth) x 1)

Controls LAN. Supports 100Base-TX and 10Base-T.

? MODEM (Askey-made 1456VQL4 x 1)

Supported by MDC.

Uses secondary AC97 line.

Data and FAX transmission is available.

Supports ITU-TV.90 or .92.

The transfer speed of data receiving is 56kbps, of data sending is 33.6kbps and of FAX is 14.4kbps. Actual speed depends on the quality of the line used.

Connected to telephone line through RJ11 MODEM jack.

1.3 2.5-inch Hard Disk Drive

A compact, high-capacity HDD with a height of 9.5mm. Contains a 2.5-inch magnetic disk and magnetic heads.

Figure 1-3 shows a view of the 2.5-inch HDD and Tables 1-1 and 1-2 list the specifications.

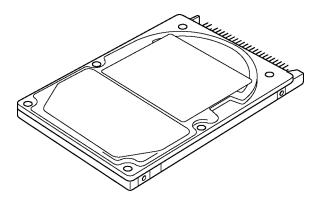


Figure 1-3 2.5-inch HDD

Table 1-1 2.5-inch HDD dimensions (1/

		Standard value						
Param	eter	TOSHIBA HDD2188B	TOSHIBA HDD2189B	TOSHIBA HDD2191V	TOSHIBA HDD2194B	TOSHIBA HDD2A02B	TOSHIBA HDD2A08B	
	Width (mm)	69.85						
Outline	Height (mm)	9.5						
dimensions	Depth (mm)	100.0						
	Weight (g)	99 (MAX) 95 98 102(MA					102(MAX)	

		Standard value						
Parameter		HGST G8BC0000Z611	HGST G8BC0000Z811	HGST G8BC0001N610	HGST G8BC0001N810	HGST G8BC0001NA10		
	Width (mm)	69.85						
Outline	Height (mm)	9.5						
dimensions	Depth (mm)	10	0.0	100.2				
	Weight (g)	99 102 (max)						

Table 1-1 2.5-inch HDD dimensions (2/2)

Parameter		Standard value					
		FUJITSU G8BC00019610	FUJITSU G8BC0001C610	FUJITSU G8BC0001HA10			
	Width (mm)	70					
Outline	Height (mm)	9.5					
dimensions	Depth (mm)	100.0					
	Weight (g)		99 (MAX)				

Table 1-2 2.5-inch HDD specifications (1/2)

	Specification (TOSHIBA)						
Parameter	HDD2189B	HDD2194B	HDD2188B	HDD2191V	HDD2A02B	HDD2 D08B	
Storage size (formatted)	60GB 80GB 100GB						
Speed (RPM)	4,200	5,400	4,200	5,400	4,200	5,400	
Data transfer speed (Mbits/s)	175.0- 341.7	258.0- 394.0	175.0- 341.7	154.3- 298.0	170-373	230.6- 445.9	
Interface transfer rate (MB/s)	100 (Ultra DMA mode)						
Storage density (Kbpi)	-	735	735 (MAX)	-	759	756(MAX)	
Track density (Ktpi)	88.1 88.8 88.1 78.9 110-120 110						
Average random seek time (read) (ms)	12						
Average random seek time (write) (ms)	12						
Motor startup time (ms)			4				

	Specification (HGST)					
Parameter	G8BC0000Z611	G8BC0001N610	G8BC0000Z811	G8BC0001N810	G8BC0001NA10	
Storage size (formatted)	60GB 80GB 100GB					
Speed (RPM)	4,200	5,400	4,200	5,400	5,400	
Data transfer speed (Mbits/s)	350 493 350 493					
Interface transfer rate (MB/s)	100 (Ultra DMA mode)					
Storage density (Kbpi)	- 764 - 764 76					
Track density (Ktpi)	63 113.2 96 113.2 113.2					
Average random seek time (read) (ms)	12					
Average random seek time (write) (ms)	14					
Motor startup time (ms)	5	3.5	5	3.5	3.5	

Table 1-2 2.5-inch HDD specifications (2/2)

	Specification (FUJITSU)			
Parameter	G8BC00019610	G8BC0001C610	G8BC0001HA10	
Storage size (formatted)	60	100GB		
Speed (RPM)	4,200	5,400	4,200	
Data transfer speed (Mbits/s)	330.4	443.2		
Interface transfer rate (MB/s)	100 (Ultra DMA mode)			
Storage density (Kbpi)	-			
Track density (Ktpi)	-			
Average random seek time (read) (ms)	12			
Average random seek time (write) (ms)	-			
Motor startup time (ms)	3.5 4.0			

1.4 Optical Drive

This model equipped with the DVD super multidrive as the optical drive. Some drives support double layer specification.

The DVD Super Multi drive accommodates either 12 cm (4.72-inch) or 8 cm (3.15-inch) CD, CD-R/RW and DVD. It is a high-performance drive that reads DVD-ROM at maximum 8-speed and CD at maximum 24-speed (3,600 KB per second). Writing speed depends on the drive.

The DVD Super Multi drive supporting DVD+R Double layer accommodates either 12 cm (4.72-inch) or 8 cm (3.15-inch) CD, CD-R/RW and DVD. It is a high-performance drive that reads DVD-ROM at maximum 8-speed and CD at maximum 24-speed (3,600 KB per second). Also, it writes CD-R at up to 24-speed, CD-RW at up to 10-speed, DVD-R and DVD+R at maximum 8-speed, DVD-RW and DVD+RW at maximum 4-speed, DVD-RAM at maximum 3-speed and DVD+R (double layer) at maximum 2.4-speed.

The DVD Super Multi drive is shown in Figure 1-4. The dimensions and specifications of the DVD Super Multi drive are described in Table 1-3, Table 1-4.

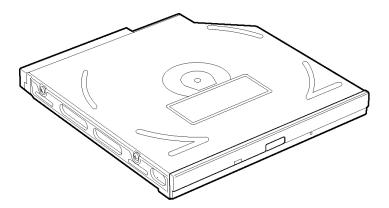


Figure 1-4 DVD Super Multi drive

Table 1-3 DVD Super Multi drive outline dimensions

Parameter		Standard value				
	Maker	MATSUSHITA (G8CC0001S610)			TEAC (G8CC00024611)	
Outline Width (mm)		128				
dimensions	Height (mm)	12.7 (excluding projections)				
	Depth (mm) 129.0					
	Mass (g)	210 (+/-10)				

1 Hardware Overview 1.4 Optical Drive

Table 1-4 DVD Super Multi drive specifications (1/4)

Parameter		Drive Specification		
		MATSUSHITA (G8CC0001S610)		
	Read(KB/s)	DVD-ROM MAX 8X CAV CD-ROM MAX 24X CAV		
Data transfer speed	Write	CD-R 16x (Zone CLV) CD-RW 4X (CLV) High Speed CD-RW 8X (CLV) DVD-R 4x (Zone CLV) DVD-RW 2x (CLV) DVD+R 2.4x (CLV) DVD+RW 2.4x (CLV) DVD+RW 2.4x (CLV)		
	ATAPI interface (MB/s)	PIO mode 16.6 MB/s (PIO MODE4 supported) DMA mode 16.6 MB/s (Multi-ward MODE2 supported) Ultra DMA mode 33.3 MB/s(Ultra DMA MODE2 supported)		
Access time	CD-ROM	150 (Random)		
(ms)	DVD-ROM	180 (Random)		
Buffer n	nemory	2MB		
Supported disk format	CD	CD-DA, CD-ROM, CD-ROM XA, Photo CD, Video CD, CD-Extra(CD+),CD-text		
	DVD	DVD-ROM, DVD-R (3.9GB/4.7GB), DVD-RW (Ver1.1) DVD+R/+RW, DVD Video, DVD-RAM (2.6GB/4.7GB/9.4GB)		

1.4 Optical Drive 1 Hardware Overview

Table 1-4 DVD Super Multi drive specifications (2/4)

Parameter		Drive Specification		
		Matsushita (G8CC00021610)		
	Read(KB/s)	DVD-ROM MAX 8X CAV CD-ROM MAX 24X CAV		
Data transfer speed	Write	CD-R MAX 24x (Zone CLV) CD-RW 4X (CLV) HSRW MAX 10X (CLV) USRW 10X (CLV) DVD-R MAX 8x (Zone CLV) DVD-RW MAX 4x (Zone CLV) DVD+R MAX 8x (Zone CLV) DVD+R MAX 4x (Zone CLV) DVD+RW MAX 4x (Zone CLV) DVD-RAM 3x (ZCLV) (4.7GB)		
	ATAPI interface (MB/s)	PIO mode 16.6 MB/s (PIO MODE4 supported) DMA mode 16.6 MB/s (Multi-ward MODE2 supported) Ultra DMA mode 33.3 MB/s(Ultra DMA MODE2 supported)		
Access time	CD-ROM	150 (Random)		
(ms)	DVD-ROM	180 (Random)		
Buffer memory		2MB		
Supported disk format	CD	CD-DA, CD-ROM, CD-ROM XA, Photo CD, CD-Extra(CD+),CD-text		
	DVD	DVD-R, DVD-R, DVD-RW (Ver1.1) DVD+R/RW, DVD Video, DVD-RAM (2.6GB/4.7GB)		

1 Hardware Overview 1.4 Optical Drive

Table 1-4 DVD Super Multi drive specifications (3/4)

Parameter		Drive Specification Matsushita (G8CC00021611) Supporting Double Layer		
Data transfer speed	Write	CD-R MAX 24x (Zone CLV) CD-RW 4X (CLV) HSRW MAX 10X (CLV) USRW 10X (CLV) DVD-R MAX 8x (Zone CLV) DVD-RW MAX 4x (Zone CLV) DVD+R MAX 8x (Zone CLV) DVD+R MAX 4x (Zone CLV) DVD+RW MAX 4x (Zone CLV) DVD+RW MAX 4x (Zone CLV) DVD+RW MAX 4x (Zone CLV) DVD-RAM 3x (ZCLV) (4.7GB) DVD+R DL 2.4x (Zone CLV)		
	ATAPI interface (MB/s)	PIO mode 16.6 MB/s (PIO MODE4 supported) DMA mode 16.6 MB/s (Multi-ward MODE2 supported) Ultra DMA mode 33.3 MB/s(Ultra DMA MODE2 supported)		
Access time	CD-ROM	150 (Random)		
(ms)	DVD-ROM	180 (Random)		
Buffer memory		2MB		
Supported disk format	CD	CD-DA, CD-ROM, CD-ROM XA, Photo CD, CD-Extra(CD+),CD-text		
	DVD	DVD-ROM, DVD-R, DVD-RW (Ver1.1) DVD+R/RW, DVD Video, DVD-RAM (2.6GB/4.7GB)		

1.4 Optical Drive 1 Hardware Overview

Table 1-4 DVD Super Multi drive specifications (4/4)

Parameter		Drive Specification TEAC (G8CC00024611) Supporting Double Layer		
Data transfer speed	Write	CD-R MAX 24x (Zone CLV) CD-RW 4X (CLV) HSRW MAX 10X (CLV) USRW 10X (CLV) DVD-R MAX 8x (Zone CLV) DVD-RW MAX 4x (Zone CLV) DVD+R MAX 8x (Zone CLV) DVD+RW MAX 4x (Zone CLV) DVD-RAM 3x (ZCLV) (4.7GB) DVD+R DL 2.4x (Zone CLV)		
	ATAPI interface (MB/s)	PIO mode 16.6 MB/s (PIO MODE4 supported) DMA mode 16.6 MB/s (Multi-ward MODE2 supported) Ultra DMA mode 33.3 MB/s(Ultra DMA MODE2 supported)		
Access time	CD-ROM	130 (Random)		
(ms)	DVD-ROM	130 (Random)		
Buffer memory		2MB		
Supported disk format	CD	CD-DA, CD-ROM, CD-ROM XA, Photo CD CD-Extra(CD+),CD-text		
	DVD	DVD-ROM, DVD-R, DVD-RW DVD+R/RW, DVD Video, DVD-RAM (2.6GB/4.7GB)		

1 Hardware Overview 1.5 Keyboard

1.5 Keyboard

A keyboard which consists of 85(US)/86(UK) keys is mounted on the system unit. The keyboard is connected to membrane connector on the system board and controlled by the keyboard controller.

Figure 1-5 is a view of the keyboard.



Figure 1-5 Keyboard

See Appendix E for details of the keyboard layout.

1.6 TFT Color Display

The TFT color display is 15.4 inch and consists of LCD module and FL inverter boards.

1.6.1 LCD Module

The LCD module used for the TFT color display uses two backlights as the light source and can display a maximum of 262,144 colors with 1,280 x 800 resolution.

Figure 1-6 shows a view of the LCD module and Table 1-5 lists the specifications.

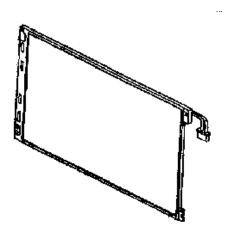


Figure 1-6 LCD module

Table 1-5 LCD module specifications

ltom	Specifications
ltem	Samsung (G33C0002A110)
Number of Dots	1,280(W) No 800(H)
Dot spacing (mm)	0.25875(H)No 0.25875(V)
Display range (mm)	331.2(H)No 207.0(V)

1.6.2 FL Inverter Board

The FL inverter board supplies a high frequency current to illuminate the LCD module FL.

Table 1-6 lists the FL inverter board specifications.

Table 1-6 FL inverter board specifications

ltem		Specifications		
		G71C0004F310		
Input	Voltage (V)	5 (DC)		
	Power (W)	18		
Output	Voltage (V)	900 (rms)		
	Current (f=70KHz)(mA)	7 (rms) (x 2 output)		

1.7 Power Supply

The power supply supplies twenty-five different voltages to the system board.

The power supply microcontroller has the following functions.

- 1. Judges if the DC power supply (AC adapter) is connected to the computer.
- 2. Detects DC output and circuit malfunctions.
- 3. Controls the battery icon, and DC IN icon.
- 4. Turns the battery charging system on and off and detects a fully charged battery.
- 5. Turns the power supply on and off.
- 6. Provides more accurate detection of a low battery.
- 7. Calculates the remaining battery capacity.
- 8. Controls the transmission of the status signal of the main battery.

Table 1-7 lists the power supply output specifications.

Table 1-7 Power supply output rating (1/2)

	Voltage	Power supplied (Yes/No)			
Name	[V]	Power OFF Suspend mode	Power OFF Boot mode	No Battery	Use
PPV	1.308 – 0.748	No	No	No	СРИ
PTV	1.07	No	No	No	CPU, MCH, ICH4-M
PGV	1.20	No	No	No	GPU
1R8-P1V	1.8	No	No	No	CPU, MCH, ICH4-M
1R2-P1V	1.2	No	No	No	MCH
1R25-B1V	1.25	Yes	No	No	DDR-SDRAM Termination
1R5-P1V	1.5	No	No	No	MCH, ICH4-M, GPU
1R5-S1V	1.5	Yes	Yes	No	ICH4-M
2R5-P2V	2.5	No	No	No	GPU, SDRAM(GFX), SVP, LVDS
2R5-B2V	2.5	Yes	No	No	MCH, DDR-SDRAM
FM-E3V	3.3	No	No	No	Media Bridge
BT-P3V	3.3	No	No	No	Bluetooth

Table 1-7 Power supply output rating (2/2)

	Voltage	Power supplied (Yes/No)				
Name	[V]	Power OFF Suspend mode	Power OFF Boot mode	No Battery	Use	
USB0PS-E5V	5	Yes	No	No	USB	
USB1PS-E5V	5	Yes	No	No	USB	
SND-P5V	5	No	No	No	AN12941	
A4R7-P4V	4.7	No	No	No	AD1981B, AN12941	
MCV	5	Yes	Yes	No	PSC	
P3V	3.3	No	No	No	Clock Generator, Thermal Sensor, SDRAM(SPD), ICH4-M, Mini-PCI, LAN, WW-Tuner, FWH, Super I/O, AD1981B,IEEE1394, TV-Encoder, LCD, Headphone, GPU, SVP, TMDS, AMP	
P5V	5	No	No	No	Mini-PCI, HDD, ODD, WW- Tuner, KB, T-PAD, GPU	
E3V	3.3	Yes	No	No	Card Cont., Mini-PCI, MDC	
E5V	5	Yes	No	No	PC-Card, USB	
S3V	3.3	Yes	Yes	No	ICH4-M, IR Cont.	
M3V	3.3	Yes	Yes	No	EC/KBC	
M5V	5	Yes	Yes	No	EC/KBC, System LED	
R3V	2.0 - 3.6	Yes	Yes	Yes	ICH4-M(RTC)	

1.8 Batteries

The PC has the following two batteries.

- ? Main battery
- ? Real time clock (RTC) battery

Table 1-8 lists the specifications for these two batteries.

Table 1-8 Battery specifications

Battery Name		Battery Element	Output Voltage	Capacity
	G71C0004H210			4,400 mAh
Main battery	G71C0004H610	Lithium ion	10.8V	
	G71C0004H110	Littlidiii loli		
	G71C0004H510			
Real time clock (RTC) battery	P71035009115	Nickel hydrogen	2.4V	15 mAh

1.8.1 Main Battery

The main battery is the primary power supply for the computer when the AC adapter is not connected. In Stand by mode, the main battery maintains the current status of the computer.

1 Hardware Overview 1.8 Batteries

1.8.2 Battery Charging Control

Battery charging is controlled by a power supply microprocessor. The power supply microprocessor controls power supply and detects a full charge when the AC adaptor and battery are connected to the computer.

? Battery Charge

When the AC adapter is connected, normal charging is used while the system is turned on and quick charge is used while the system is turned off. (See Table 1-9)

Table 1-9 Time required for charges of main battery

Condition	Charging Time	
Normal charge	About 4.0 to 12.0 hours	
Quick charge	About 3.0 hours	

Charge is stopped in the following cases.

- 1. The main battery is fully charged
- 2. The main battery is removed
- 3. Main battery or AC adapter voltage is abnormal
- 4. Charging current is abnormal

? Data preservation time

When turning off the power in being charged fully, the preservation time is as follows: (See Table 1-10)

Table 1-10 Data preservation time

Condition	preservation time		
Standby	About 2 days		
Shutdown, Hibernation	About 15 days		

1.8.3 RTC Battery

The RTC battery provides the power supply to maintain the date, time, and other system information in memory.

Table 1-11 lists the Time required for charges of RTC battery and data preservation time.

Table 1-11 Time required for charges of RTC battery

Condition	Time	
Power ON (Lights Power LED)	More than 8 hours	
Data preservation tome (Full-charged)	About a month	

1 Hardware Overview 1.9 AC Adapter

1.9 AC Adapter

The AC adapter is used to charge the battery.

Table 1-12 lists the AC adapter specifications.

Table 1-12 AC adapter specifications

Parameter	Specification
	(G71C00024410)
Power	90W (Peak 105W)
Input voltage	AC 100 to 240V
Input frequency	50Hz/60Hz
Input voltage	1.3A or less
Output voltage	DC 15V
Output current	6.0A

Chapter 2 Troubleshooting Procedures

Chapter 2 Contents

2.1	Troubleshooting		2-1
2.2	Troubleshooting F	lowchart	2-2
2.3	Power Supply Troubleshooting		
	Procedure 1	Power Status Check	2-6
	Procedure 2	Error Code Check	2-8
	Procedure 3	Connection Check	2-14
	Procedure 4	Charging Check	2-14
	Procedure 5	Replacement Check	2-15
2.4	System Board Tro	ubleshooting	2-16
	Procedure 1	Message Check	2-17
	Procedure 2	Debug Port Check	2-19
	Procedure 3	Diagnostic Test Program Execution Check	2-36
	Procedure 4	Replacement Check	2-36
2.5	USB 3.5" FDD Tro	oubleshooting	2-37
	Procedure 1	FDD Head Cleaning Check	2-37
	Procedure 2	Diagnostic Test Program Execution Check	2-38
	Procedure 3	Connector Check and Replacement Check	2-39
2.6	2.5" HDD Trouble	shooting	2-40
	Procedure 1	Partition Check	2-40
	Procedure 2	Message Check	2-41
	Procedure 3	Format Check	2-42
	Procedure 4	Diagnostic Test Program Execution Check	2-43
	Procedure 5	Connector Check and Replacement Check	2-44
2.7	Keyboard Troubles	shooting	2-45
	Procedure 1	Diagnostic Test Program Execution Check	2-45
	Procedure 2	Connector Check and Replacement Check	2-45
2.8	Touch Pad Trouble	eshooting	2-46
	Procedure 1	Diagnostic Test Program Execution Check	2-46
	Procedure 2	Connector Check and Replacement Check	2-46

2.9	Display Troublesho	2-47	
	Procedure 1	External Monitor Check	2-47
	Procedure 2	Diagnostic Test Program Execution Check	2-47
	Procedure 3	Connector Check and Cable Check	2-48
	Procedure 4	Replacement Check	2-49
2.10	Optical Drive Trou	bleshooting	2-50
	Procedure 1	Diagnostic Test Program Execution Check	2-50
	Procedure 2	Connector Check and Replacement Check	2-50
2.11	Modem Troublesho	ooting	2-51
	Procedure 1	Diagnostic Test Program Execution Check	2-51
	Procedure 2	Connector Check and Replacement Check	2-51
2.12	LAN Troubleshoot	ing	2-53
	Procedure 1	Diagnostic Test Program Execution Check	2-53
	Procedure 2	Connector Check and Replacement Check	2-53
2.13	Wireless LAN Tro	ubleshooting	2-54
	Procedure 1	Transmitting-Receiving Check	2-54
	Procedure 2	Antennas' Connection Check	2-55
	Procedure 3	Replacement Check	2-56
2.14	Sound Troubleshoo	oting	2-57
	Procedure 1	Diagnostic Test Program Execution Check	2-57
	Procedure 2	Connector Check	2-57
	Procedure 3	Replacement Check	2-58
2.15	TV Tuner Troubles	shooting	2-59
	Procedure 1	Connector Check and Replacement Check	2-59

Figures

Figure 2-1 Figure 2-2	Troubleshooting flowchart	
Tables		
Table 2-1	Battery icon	2-6
Table 2-2	DC IN icon	2-7
Table 2-3	Error code	2-9
Table 2-4	Debug port (Boot mode) error status	2-20
Table 2-5	Debug port (Suspend mode) error status	2-29
Table 2-6	Debug port (Resume mode) error status	2-32
Table 2-7	FDD error code and status	2-38
Table 2-8	2.5" Hard disk drive error code and status	2-43

2.1 Troubleshooting

Chapter 2 describes how to determine which Field Replaceable Unit (FRU) in the computer is causing the computer to malfunction. (The "FRU" means the replaceable unit in the field.) The FRUs covered are:

1. Power supply6. Touch pad11. Wireless LAN2. System Board7. Display12. Sound3. 3.5" USB FDD8. Optical Drive13. TV Tuner4. 2.5" HDD9. Modem5. Kevboard10. LAN

The Test Program operations are described in Chapter 3. Detailed replacement procedures are described in Chapter 4.

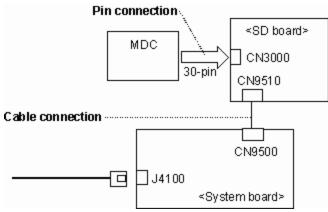
NOTE: After replacing the system board or CPU, it is necessary to execute the subtest 01 Initial configuration of 3.3 Setting of the hardware configuration in Chapter 3.

The following tools are necessary in addition to tools described in Chapter 3 for implementing the Diagnostics procedures:

- 1. Phillips screwdrivers
- 2. Toshiba MS-DOS system FD
- 3. Tester

There are following two types of connections in the figures of board and module connection in and after 2.3 Power Supply Troubleshooting.

- (1) Cable connection is described as line in the figures.
- (2) Pin connection is described as arrow in the figure.
- <e.g> Connection of modem



2.2 Troubleshooting Flowchart

Use the flowchart in Figure 2-1 as a guide for determining which troubleshooting procedures to execute. Before going through the flowchart steps, verify the following:

- Ask the user if a password is registered and, if it is, ask him or her to enter the password.
- Verify with the customer that Toshiba Windows XP Home Edition or Windows XP Media Center Edition is installed on the hard disk. Non-Windows operating systems can cause the computer to malfunction.
- Make sure all optional equipment is removed from the computer.

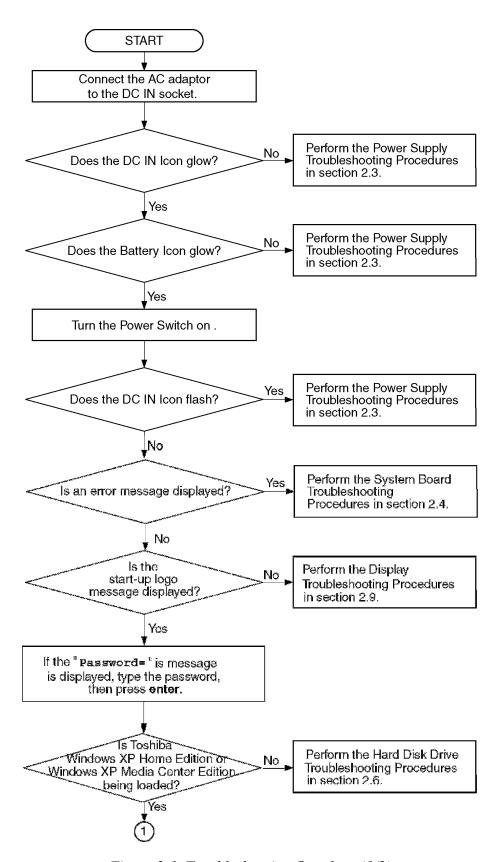


Figure 2-1 Troubleshooting flowchart (1/2)

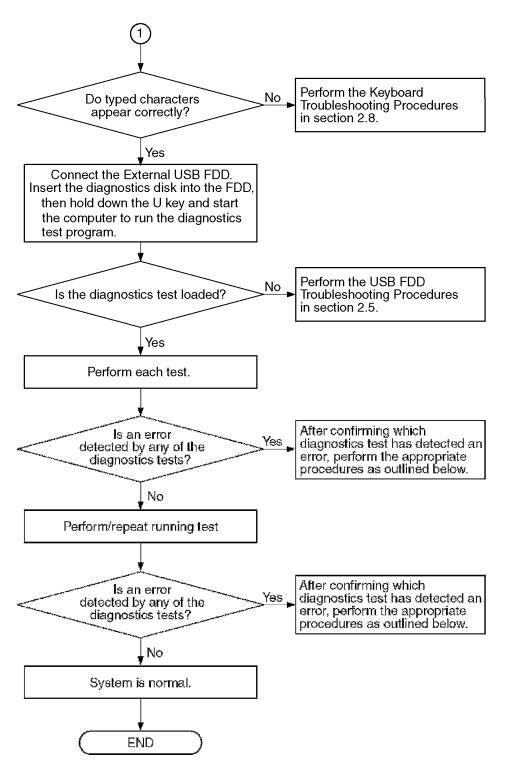


Figure 2-1 Troubleshooting flowchart (2/2)

If the diagnostics program cannot detect an error, the problem may be intermittent. The Test program should be executed several times to isolate the problem. Check the Log Utilities function to confirm which diagnostic test detected an error(s), and perform the appropriate troubleshooting procedures as follows:

- 1. If an error is detected on the system test, memory test, display test, printer test, Async test, expansion test, real timer test, NDP test or Modem/LAN/Bluetooth/IEEE1394 test, perform the System Board Troubleshooting Procedures in Section 2.4.
- 2. If an error is detected on the floppy disk test, perform the USB FDD Troubleshooting Procedures in Section 2.5.
- 3. If an error is detected on the hard disk test, perform the HDD Troubleshooting Procedures in Section 2.6.
- 4. If an error is detected on the test for keyboard in ONLY ONE test program, perform the Keyboard Troubleshooting Procedures in Section 2.7.
- 5. If an error is detected on the test for touch pad in ONLY ONE test program, perform the Touch pad Troubleshooting Procedures in Section 2.8.
- 6. If an error is detected on the display test, perform the Display Troubleshooting Procedures in Section 2.9.
- 7. If an error is detected on the CD-ROM/DVD-ROM test, perform the Optical Drive Troubleshooting Procedures in Section 2.10.
- 8. If an error is detected on the Modem test, perform the Modem Troubleshooting Procedures in Section 2.11.
- 9. If an error is detected on the LAN test, perform the LAN Troubleshooting Procedures in Section 2.12.
- 10. If an error is detected on the Wireless LAN test, perform the Wireless LAN Troubleshooting Procedures in Section 2.13.
- 11. If an error is detected on the Sound test, perform the Sound Troubleshooting Procedures in Section 2.14.
- 12. If any trouble occurs on the TV tuner function, perform the TV tuner Troubleshooting Procedures in Section 2.15.

2.3 Power Supply Troubleshooting

The power supply controller controls many functions and components. To determine if the power supply is functioning properly, start with Procedure 1 and continue with the other Procedures as instructed. The procedures described in this section are:

Procedure 1: Power Status Check
Procedure 2: Error Code Check
Procedure 3: Connection Check

Procedure 4: Charging Check

Procedure 5: Replacement Check

Procedure 1 Power Status Check

The following icons indicate the power supply status:

∠ DC IN icon

The power supply controller displays the power supply status with the Battery icon and the DC IN icon as listed in the tables below.

Table 2-1 Battery icon

Battery icon	Power supply status		
Lights orange	Battery is charged and the external DC is input. It has no relation with ON/OFF of the system power.		
Lights green	Battery is fully charged and the external DC is input. It has no relation with ON/OFF of the system power.		
Blinks orange (even intervals)	The battery level is low while the system power is ON.		
Blinks orange once (at being switched on)	The system is driven by only a battery and the battery level is low.		
Doesn't light	Any condition other than those above.		

Table 2-2 DC IN icon

DC IN icon	Power supply status	
Lights green	DC power is being supplied from the AC adapter.	
Blinks orange	Power supply malfunction ^{*1}	
Doesn't light	Any condition other than those above.	

*1 When the power supply controller detects a malfunction, the DC IN icon blinks orange. It shows an error code.

When the icon is blinking, perform the following procedure.

- 1. Remove the battery pack and the AC adapter.
- 2. Re-attach the battery pack and the AC adapter.

If the icon is still blinking after the operation above, check the followings:

- Check 1 If the DC IN icon blinks orange, go to Procedure 2.
- Check 2 If the DC IN icon does not light, go to Procedure 3.
- Check 3 If the battery icon does not light orange or green, go to Procedure 4.

NOTE: Use the supplied AC adapter G71C00024410.

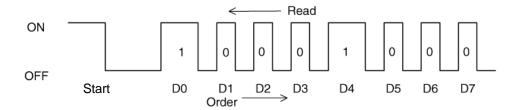
Procedure 2 Error Code Check

If the power supply microprocessor detects a malfunction, the DC IN icon blinks orange. The blink pattern indicates an error as shown below.

Ø	Start	Off for 2 seconds
Ø	Error code (8 bit)	
	"1"	On for one second
	"0"	On for half second
	Interval between data bits	Off for half second

The error code begins with the least significant digit.

Example: Error code 11h (Error codes are given in hexadecimal format.)



Check 1 Convert the DC IN icon blink pattern into the hexadecimal error code and compare it to the tables below. Then go to Check 2.

Table 2-3 Error code

Error code	Where error occurs
1*h	DC Power (AC Adapter)
2*h	Main battery
3:h	2nd battery
4*h	S3V output
5*h	1R5-C1V output (P61)
6*h	1R5-C1V output (P62)
7*h	PPV output
8*h	PTV output
9*h	E5V output
A*h	E3V output
B*h	2R5-P2V output
C*h	PGV output
D*h	1R25-B1V output
E*h	2R5-B2V output

∠ DC power supply (AC adapter)

Error code	Meaning
10h	AC Adapter output voltage is over 16.5V.
11h	Common Dock output voltage is over 16.5V.
12h	Current from the DC power supply is over 12.0A.
13h	Current from the DC power supply is over 0.5A when there is no load.
14h	Abnormal current has been sensed.

Main Battery

Error code	Meaning
21h	Main battery charge current is over 12.0A.
22h	Main battery discharge current is over 0.5A when there is no load.
23h	Main battery charge current is over 3.9A when AC adapter is not connected.
24h	Abnormal current has been sensed.
25h	Main battery charge current is over 0.3A when the charging is off.

✓ Second Battery

Error code	Meaning
31h	Second battery charge current is over 12.0A.
32h	Second battery discharge current is over 0.5A when there is no load.
33h	Second battery charge current is over 3.1A when AC adapter is not connected.
34h	Abnormal current has been sensed.
35h	Second battery charge current is over 0.3A when the charging is off.

≈ S3V output

Error code	Meaning
40h	S3V voltage is 2.81Vor less when the computer is powered on/off.
45h	S3V voltage is 2.81V or less when the computer is booting up.(CV support)

∠ 1R5-C1V output (P61)

Error code	Meaning
50h	1R5-C1 voltage is over 1.80V when the computer is powered on/off.
51h	1R5-C1 voltage is 1.275V or less when the computer is powered on.
52h	1R5-C1 voltage is 1.275V or less when the computer is booting up.
53h	1R5-C1 voltage is 1.275V or less while the computer is suspended.
54h	1R5-C1 voltage is abnormal while the computer is shutdown. (CV support)
55h	1R5-C1 voltage is 1.275V or less when the computer is booting up. (CV support)

∠ 1R5-C1V output

Error code	Meaning
60h	1R5-C1V voltage is over 2.16V when the computer is powered on/off.
61h	1R5-C1V voltage is 1.275V or less when the computer is powered on.
62h	1R5-C1V voltage is 1.275V or less when the computer is booting up.
63h	1R5-C1V voltage is 1.275V or less while the computer is suspended.
64h	1R5-C1V voltage is abnormal while the computer is shutdown. (CV support)
65h	1R5-C1V voltage is 1.275V or less when the computer is booting up. (CV support)

∠ PPV output

Error code	Meaning
70h	PPV voltage is over 1.80V when the computer is powered on/off.
71h	PPV voltage is 0.56V or less when the computer is powered on.
72h	PPV voltage is 0.56V or less when the computer is booting up.
73h	PPV voltage is 0.56V or more when the computer is powered off.

∠ PTV output

Error code	Meaning
80h	PTV voltage is over 1.26 when the computer is powered on/off.
81h	PTV voltage is 0.68V or less when the computer is powered on.
82h	PTV voltage is 0.68V or less when the computer is booting up.
83h	PTV voltage is 0.68V or more when the computer is powered off.
84h	PTV voltage is 0.68V or less while the computer is suspended.

≤ E5V output

Error code	Meaning
90h	E5V voltage is over 6.00V when the computer is powered on/off.
91h	E5V voltage is 4.50V or less when the computer is powered on.
92h	E5V voltage is 4.50V or less when the computer is booting up.
93h	E5V voltage is 4.50V or more when the computer is powered off.
94h	E5V voltage is 4.50V or less while the computer is suspended.

Error code	Meaning
A0h	E3V voltage is over 3.96V when the computer is powered on/off.
A1h	E3V voltage is 2.81V or less when the computer is powered on.
A2h	E3V voltage is 2.81V or less when the computer is booting up.
A3h	E3V voltage is 2.81V or more when the computer is powered off.
A4h	E3V voltage is 2.81V or less when the computer is suspended.

≈ 2R5-P2V output

Error code	Meaning
B0h	2R5-P2V voltage is over 3.00V when the computer is powered on/off.
B1h	2R5-P2V voltage is 1.53V or less when the computer is powered on.
B2h	2R5-P2V voltage is 1.53V or less when the computer is booting up.
B3h	2R5-P2V voltage is 1.53V or more when the computer is powered off.

∠ PGV output

Error code	Meaning	
C0h	PGV voltage is over 1.62V when the computer is powered on/off.	
C1h	PGV voltage is 0.68V or less when the computer is powered on.	
C2h	PGV voltage is 0.68V or less when the computer is booting up.	
C3h	PGV voltage is 0.68V or more when the computer is powered off.	
C4h	PGV voltage is 0.68V or less while the computer is suspended.	

≈ 1R25-B1V output

Error code	Meaning	
D0h	1R25-B1V voltage is over 1.50V when the computer is powered on/off.	
D1h	1R25-B1V voltage is 1.063V or less when the computer is powered on.	
D2h	1R25-B1V voltage is 1.063V or less when the computer is booting up.	
D3h	1R25-B1V voltage is 1.063V or more when the computer is powered off.	
D4h	1R25-B1V voltage is 1.063V or less while the computer is suspended.	

≈ 2R5-B2V output

Error code	Meaning	
E0h	2R5-B2V voltage is over 3.00V when the computer is powered on/off.	
E1h	2R5-B2V voltage is 2.125V or less when the computer is powered on.	
E2h	2R5-B2V voltage is 2.125V or less when the computer is booting up.	
E3h	2R5-B2V voltage is 2.125V or more when the computer is powered off.	
E4h	2R5-B2V voltage is 2.125V or less while the computer is suspended.	

Check 2 In the case of error code 10h or 12h:

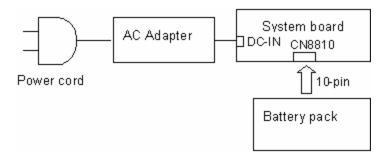
- Make sure the AC adapter and AC power cord are firmly plugged into the DC IN 15 V socket and wall outlet. If the cables are connected correctly, go to the following step:
- Connect a new AC adapter and AC power cord. If the error still exists, go to Procedure 5.

Check 3 In the case of error code 21h:

Check 4 For any other errors, go to Procedure 5.

Procedure 3 Connection Check

The wiring diagram related to the power supply is shown below:



Any of the connectors may be disconnected. Perform Check 1.

- Check 1 Make sure the AC adapter and the AC power cord are firmly plugged into the DC IN 15 V socket and wall outlet. If these cables are connected correctly, go to Check 2.
- Check 2 Replace the AC adapter and the AC power cord with new ones.
 - ? If the DC IN icon does not light, go to Procedure 5.
 - ? If the battery icon does not light, go to Check 3.
- Check 3 Make sure the battery pack is installed in the computer correctly. If the battery is properly installed and the battery icon still does not light, go to Procedure 4.

Procedure 4 Charging Check

Check if the power supply controller charges the battery pack properly. Perform the following procedures:

- Check 1 Make sure the AC adapter is firmly plugged into the DC IN socket.
- Check 2 Make sure the battery pack is properly installed. If the battery is properly installed, go to Check 3.
- Check 3 The battery pack may be completely discharged. Wait a few minutes to charge the battery pack while connecting the battery pack and the AC adapter. If the battery pack is still not charged, go to Check 4.
- Check 4 The battery's temperature is too high or low. Return the temperature to normal operating condition. If the battery pack is still not charged, go to Check 5.
- Check 5 Replace the battery pack with a new one. If the battery pack is still not charged, go to Procedure 5.

Procedure 5 Replacement Check

The power is supplied to the system board by the AC adapter. If either the AC adapter or the system board was damaged, perform the following Checks.

To disassemble the computer, follow the steps described in Chapter 4, *Replacement Procedures*.

- Check 1 Replace the AC adapter with a new one. If the AC adapter is still not functioning properly, perform Check 2.
- Check 2 Replace the system board with a new one.

2.4 System Board Troubleshooting

This section describes how to determine if the system board is defective. Start with Procedure 1 and continue with the other procedures as instructed. The procedures described in this section are:

Procedure 1: Message Check

Procedure 2: Debug Port Check

Procedure 3: Diagnostic Test Program Execution Check

Procedure 4: Replacement Check

Procedure 1 Message Check

When the power is turned on, the system performs the Initial Reliability Test (IRT) installed in the BIOS ROM. The IRT tests each IC on the system board and initializes it.

- ✓ If an error message is shown on the display, perform Check 1.
- ∠ If there is no error message, go to Procedure 2.
- Check 1 If one of the following error messages is displayed on the screen, press **F1** as the message instructs. These errors occur when the system configuration preserved in the RTC memory (CMOS type memory) is not the same as the actual configuration or when the data is lost.

If you press **F1** as the message instructs, the SETUP screen appears to set the system configuration. If error message (b) appears often when the power is turned on, replace the RTC battery. If any other error message is displayed, perform Check 2.

- *** Bad HDD type *** (a) Check system. Then press [F1] key *** Bad RTC battery *** (b) Check system. Then press [F1] key *** Bad configuration *** (C) Check system. Then press [F1] key *** Bad memory size *** (d) Check system. Then press [F1] key *** Bad time function *** (e) Check system. Then press [F1] key (f) *** Bad check sum (CMOS) *** Check system. Then press [F1] key *** Bad check sum (ROM) *** (g) Check system. Then press [F1] key
- Check 2 If the following error message is displayed on the screen, press any key as the message instructs.

The following error message appears when data stored in RAM under the resume function is lost because the battery has become discharged or the system board is damaged. Go to Procedure 3.

```
WARNING: RESUME FAILURE.
PRESS ANY KEY TO CONTINUE.
```

If any other error message displays, perform Check 3.

Check 3 The IRT checks the system board. When the IRT detects an error, the system stops or an error message appears.

If one of the following error messages (1) through (17), (22) or (23) is displayed, go to Procedure 4.

If error message (18) is displayed, go to the Keyboard Troubleshooting Procedures in Section 2.7.

If error message (19), (20) or (21) is displayed, go to the 2.5" HDD Troubleshooting Procedures in Section 2.6.

- (1) PIT ERROR
- (2) MEMORY REFRESH ERROR
- (3) TIMER CH.2 OUT ERROR
- (4) CMOS CHECKSUM ERROR
- (5) CMOS BAD BATTERY ERROR
- (6) FIRST 64KB MEMORY ERROR
- (7) FIRST 64KB MEMORY PARITY ERROR
- (8) VRAM ERROR
- (9) SYSTEM MEMORY ERROR
- (10) SYSTEM MEMORY PARITY ERROR
- (11) EXTENDED MEMORY ERROR
- (12) EXTENDED MEMORY PARITY ERROR
- (13) DMA PAGE REGISTER ERROR
- (14) DMAC #1 ERROR
- (15) DMAC #2 ERROR
- (16) PIC #1 ERROR
- (17) PIC #2 ERROR
- (18) KBC ERROR
- (19) HDC ERROR
- (20) HDD #0 ERROR
- (21) HDD #1 ERROR
- (22) TIMER INTERRUPT ERROR
- (23) RTC UPDATE ERROR

Procedure 2 Debug Port Check

Check the D port status by a debug port test. The tool for debug port test is shown below.

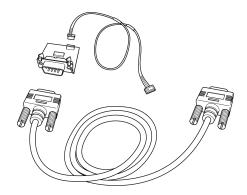
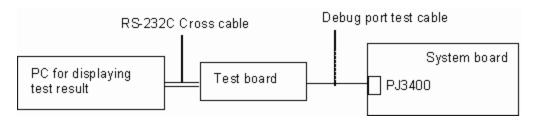


Figure 2-2 A set of tool for debug port test

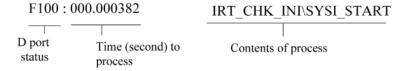
The test procedures are follows:

- 1. Connect the debug test cable to the connector CN3400 of the system board. For disassembling to connect the test cable, refer to Chapter 4.
- 2. Connect the debug port test cable and RS-232C cross-cable to the test board.
- 3. Connect the RS-232C cross-cable to the PC that displays the results.



- 4. Boot the computer in MS-DOS mode.
- 5. Execute GETDPORT.COM in the text menu in CPU REAL mode. (Insert the FD for starting D port into FDD and input "FD starting drive:>dport".)

The D port status is displayed in the following form;



- 6. When the D port status is FFFFh (normal status), go to Procedure 4.
- 7. When the D port status falls into any status in Table 2-4 except FFFFh, execute Check 1.

Table 2-4 Debug port (Boot mode) error status (1/9)

D port status	Inspection items	Details
	Permission of A20 and Clear of software reset bit	
	Prohibition of APIC	
	Initialization of MCHM, ICHM	
	Initialization of Super I/O	
	Initialization of debug port	
	Dummy read of 3 rd Bus data	
	Setting of printer port (for models supporting printer)	
F000h	PIT CH0 initialization (for HOLD_ON)	
	BIOS rewrite factor flag initialization	
	CHECK SUM CHECK	Transition to protected mode
		Boot block checksum (skipped when returned to S3)
		Halts when error occurs
		Checksum other than boot block (skip when returned to S3)
F001h	EC/KBC rewrite check	If "rewrite" is requested, go to "BIOS rewrite process".
	Transition of process to System BIOS IRT when returned to S3	
	Key input	When a key is pressed, check if it is Tilde key or Tab key.
F002h	BIOS rewrite request check	If Checksum check error occurred on except Boot Block or rewrite is required by user, go to "BIOS rewrite process".
F003h	Transits to System BIOS IRT.	
	BIOS rewrite process	Initialization of ICHM. D31
		DRAM configuration
		Permission of cache (L1 cache only)
		Memory clear
		Transition to real mode and copy of BIOS to RAM

Table 2-4 Debug port (Boot mode) error status (2/9)

D port status	Inspection items	Details
F004h/F005h	Saving key scan code	
	Setting TASK_1ms_TSC	
	Controlling fan	
	Initializing sound items (for	Enabling system speaker
	BEEP)	Releasing mute
		Making the volume max. (for models whose volume can be controlled)
	When BIOS, EC/KBC rewriting is requested	Blinks green (cycle:2s, on:1s, off:1s)
	When BIOS ROM is abnormal	Blinks orange (cycle:2s, on:1s, off:1s)
	Key input	Prohibition of USB
		BEEP
		Waiting for key input
	Reading CHGBIOSA.EXE / CHGFIRMA.EXE	FDC reset
		Setting parameters for 2HD(1.44MB)
		Reading of first sector, If it is the data of 1.44MB (2HD), the media type is definite.
		Setting of parameters for 2DD (720KB)
		Retrieval of "CHGBIOSA.EXE" from the root directory.
		Calculation of directory start head and sector
		Read 1 sector of the root directory
		Retrieval of entry of "CHGBIOSA.EXE" /"CHGFIRMA.EXE" from the sector read.
		Reading of EXE header of "CHGBIOSA.EXE" and "CHGFIRMA.EXE"
		Key input when error occurred.
		Execution of "CHGBIOSA.EXE" and "CHGFIRMA.EXE"
F100h	Prohibition of cache	
	Permission of L1/L2 cache of FlashROM area	

Table 2-4 Debug port (Boot mode) error status (3/9)

D port status	Inspection items	Details
(F100h)	Initialization of H/W (before DRAM	Initialization of MCHM
	recognition)	Initialization of ICH4M.D31.Func0
		Initialization of ICH4M.D31.Func1
		Initialization of USB.Func0,1,2,7
		Initialization of ICH4M.D31.Func3
		Initialization of ICH4M.D31.Func5
		Initialization of TI
	Initialization of PIT channel 1	(Setting the refresh interval to "30?s")
F101h	Checking DRAM type and size (at cold boot)	When unsupported memory connected, beeps and halts. When DRAM size = 0, halts.
	Testing the stack area of SM-RAM	When it can not be used, halts.
F102h	Configuring cache memory	
	Permission of L1/L2 cache memory	
	Checking the access of a CMOS (Only in Cold Boot)	When error detected, halts
	Examining the battery level of CMOS	
	Checksum check of CMOS	
	Initializing data in CMOS (1)	
	Setting up IRT status	(Setting of boot status and IRT busy flag, The rest bits are 0)
	Storing the size of DRAM	
F103h	Branch of resuming(only in Cold Boot)	When a CMOS error is detected, it does not resume.
		If "resume status code" is not set, no resume occurs.

Table 2-4 Debug port (Boot mode) error status (4/9)

D port status	Inspection items	Details
(F103h)		Resume error check S3 recovery error (ICH) Resume error F17AH SM-RAM checksum check Resume error F173H Memory configuration change check Resume error F173H Checksum check of system BIOS RAM area Resume error F179H Checksum check of expansion memory Resume error F176H Checksum check of PnP RAM Resume error F177H
		To resume process (RESUME_MAIN)
	To resume error process	Returns the CPU clock to "Low"
		Prohibition of all SMIs
		Clears resume status
		Returns to ROM
		Forwards the area of C0000h to EFFFFh to PCI (prohibition of DRAM)
		Sets resume error request
	Copying ROM/RAM of system BIOS	Halts, when error occurred
F104h	SMRAM initialization	
	WakeUp factor check	
	SMRAM base rewriting and CPU state map saving for BIOS	
	Permission of SMI based on ASMI	
F105h	Initialization of devices which need initialization before PCI bus initialization	PIT test (at Cold boot only) and initialization Setting of test pattern to channel 0 of PIT#0 Check whether the set test pattern can be read. Initialization of PIT channel 0 (Setting of timer interruption interval to 55ms) Initialization of PIT channel 2(Setting of the sound generator frequency to 664Hz) Test of PIT channel 1 (Check whether the refresh signal works properly in 30 micro-s refresh interval.) The system halts when the time is out. Test of PIT channel 2 (Check whether the speaker gate works properly)

Table 2-4 Debug port (Boot mode) error status (5/9)

D port status	Inspection items	Details
(F105h)		CPU clock measurement
		Check of parameter block A
		Permission of SMI except auto-off function
		Control of excess of rated input power
		Battery discharge current control (1CmA)
		AC adapter rated over current control
		Dividing procedures for time measuring by IRT
		Setting for clock generator
		CPU Initialization Micro code update Judging of CPU type Geyserville support check Setting of CPU clock to "high"
		Graphics Aperture Size setting (except when VGA_BUS=0)
F106h	Saving memory configuration to buffer	
	Reading of EC version	
	Update of flash ROM type	
	Judging of destination (Japan or except Japan) based on DMI data	
	CMOS default setting check	Sets default setting if bad battery or bad checksum (ROM, CMOS) is detected)
	ACPI table initialization (for execution of option ROM)	
	Initialization of devices which need initialization before PCI bus initialization	AC'97 control
		Initialization of temperature control information
		KBC initialization
		VGA display off, Reset control
		Sound initialization
		PC multi-box status acquisition (for models supporting Selectable bay)
		HC initialization, USB device connection recognition and initialization
		Control of built-in LAN permission/prohibition
	PIC initialization	
	PIC test	
	Password Initialization	

Table 2-4 Debug port (Boot mode) error status (6/9)

of DS	ous initialization (connection Bus)	
Initiali		
i i i i i i i i i i i i i i i i i i i	ization of LAN information	
Checl	k of WakeUp factor	
	generation for waiting PCI completion	
CMOS	S data initialization (2)	
PnP i	nitialization	
Settin	ng of setup items	
Multi-	ng for the completion of box status check (for models orting Selectable bay)	
H/W s	setting based on resource	
	generation for waiting PnP irce making completion	
Serial	l interruption control	(before use of interruption) (for models supporting YEBISU)
PnP I	H/W initialization	PC card slot initialization
		SIO initialization (for models supporting SIO)
		FIR initialization (for models supporting FIR)
PCI a	utomatic configuration	Making of work for automatic configuration
		Acquisition of PCI IRQ
		Configuration
		Saving of VGA configuration result
	generation for waiting CONFIGURATION letion	
	ization of H/W needed after configuration	Printer port setting (for models supporting printer)
		HDD initialization sequence start
		FDD initialization sequence start (for models supporting built-in FDD)
Enabl	ling power off	
Outpu	ut code generation	
F10Bh FIRS	T_64KB_CHECK	(Check of first 64KB memory)
F10Ch INIT_	INT_VECTOR	(Initialization of vectors)

Table 2-4 Debug port (Boot mode) error status (7/9)

D port status	Inspection items	Details
F10Dh	INIT_NDP	(Initialization of NDP)
F10Eh	INIT_SYSTEM (Initialization of system)	Storing of CMOS error status to IRT_ERR_STS_BUF
		CD POWER SW control (for models supporting CD Play function)
		Timer initialization start
		EC initialization & Reading of battery information
		Update of system BIOS (Update of EDID information for LCD)
F10Fh	INIT_DISPLAY (Waiting for VGA	Waiting for VGA power-on
	chip initialization completion, VGA BIOS initialization)	Waiting for Display access completion
F110h	Calling VGA BIOS	
F111h/F112h	DISP_LOGO	Displaying logo
F113h	SYS_MEM_CHECK (boot mode)	Check of convention memory
F114h	EXT_MEM_CHECK (boot mode)	Check of exception in the protected mode
F115h	Check of exception in the protected mode	DPORT=F116h when error occurs
	INIT_SYS_MEM (reboot mode)	Initialization of conventional memory
F117h	CHK_DMA_PAGE (boot mode)	Check of DMA Page Register
F118h	CHECK_DMAC (boot mode)	Check of DMAC
F119h	INIT_DMAC (boot mode)	Initialization of DMAC
F11Ah	CHECK_PRT (for models supporting printer)	Check of printer port existence
F11Bh	CHECK_SIO (for models supporting SIO)	Check of SIO
F11Ch	BOOT_PASSWORD (password check)	Waiting for FDD initialization completion (for models supporting built-in FDD)
		(In the case of "Reboot") Waiting for HDD initialization completion Check of key input during IRT (waiting for KBC initialization completion) I/O LOCK process (for models supporting I/O lock) ATA priority initialization

Table 2-4 Debug port (Boot mode) error status (8/9)

D port status	Inspection items	Details
(F11Ch)		(In the case of "Boot") BM loading process (for models supporting fingerprint authentication) Initialization of BM (for models supporting fingerprint authentication) Check of key input during IRT (waiting for KBC initialization completion) Input of password (waiting for HDD initialization completion) I/O LOCK process (for models supporting I/O lock) BM open (for models supporting fingerprint authentication)
F11Dh	EX_IO_ROM_CHECK	Check of option I/O ROM
F11Eh	PRE_BOOT_SETUP	Saving of value in 40:00h (for SIO saving/restoring)
		Setting of font address for resume password
		Setting of repeat parameter for USB KB
		Final check of key input during IRT
		Storing of T_SHADOW_RAM_SIZE
		Update of system resource before boot
		Rewriting of memory map data of INT15h E820h function
		Waiting for AC-Link initialization completion
		Renewal of table for DMI
		Copying ACPI table to uppermost of extension memory
		Waiting for completion of BIOS rewriting of PSC version
		Waiting for completion of setting clock generator When error occurred, halts at DPORT=F11FH
		Waiting for completion of initialization of Serial port (for models supporting SIO)
		Cancel of NMI Mask
		TIT check sum
		Clear of the IRT flag of Runtime side
		Update of check sum of Runtimeside
		Hibernation branch (for models supporting BIOS Hibernation)

Table 2-4 Debug port (Boot mode) error status (9/9)

D port status	Inspection items	Details
(F11Eh)		Initialization of Bluetooth (for models supporting Bluetooth)
		Check of existence of target maintenance card
		Prohibition of unused PC card
		Setting Wakeup status data for ACPI
		HW initialization before Boot, Waiting for initialization completion
		Notifies the DVI connection status to VGA BIOS (for models supporting DVI)
		Setting of battery save mode
		Setting of date
		Waiting for Bluetooth initialization completion (for models supporting Bluetooth)
		Update of DMI Wakeup factor, Update of SM-BIOS structure table
		PCI device configuration space close
		Cache control
		Process for CPU
		Make the CPU clock to be set by SETUP
		Waiting of motor-off completion of disabled HDD
		Final decision of USB FDD drive information
		Post processing of PRE_BOOT_SETUP
		Clear of PWRBTN_STS
		Enabling POWER Button
		Measure for chip set defective
F120h	Clear of IRT status	
	Update of check sum of Runtime side	
FFFFh	End	

Table 2-5 Debug port (Suspend mode) error status (1/3)

D port status	Inspection items	Details
	Sets the parallel port to D0 state (for models supporting printer)	
F12Fh	Release resources used for fingerprint authentication. (For models supporting fingerprint authentication)	
F130h	When powering-off request from OS is required, waits for the completion of dividing process because waiting in SUSPEND of Runtime returns the process to OS.	
	Forced execution of dividing (Permission of SMI for dividing)	
	Waiting for completion of dividing	
F131h	After prohibiting of all SMIs, permits I/O trap (EHCI) and external SMI.	
	Starts dividing to transmit periodically extension command (every 25 seconds) not to generate time-out of power-off.	
	Clears resume/power-off status.	
	Storing and initializing of special PCI configuration register	
	Prohibits clock control.	
	Judging of suspend process for boot or for resume	
	Branch to resume mode (DPORT=F132h) or boot mode(DPORT=F133h)	
F132h	Powering-off during resume process	Stops HC.
		Starts sequence for storing display system.
F133h	Resume error check in suspend mode.	Checks if during IRT processing.
		Checks if external option ROM is exist
		Checks if FDD's motor is turning or not (for models supporting built-in FDD)
	Execution of driver for suspend	
	Clear of data for Remote Lockout	
	Storing of FDD register (for models supporting built-in FDD)	
	Storing of USB register	
	Stop of HC.	

Table 2-5 Debug port (Suspend mode) error status (2/3)

LED Status	Test item	Contents
(F133h)	Storing CPU register	
	Permission of system area and memory cache (for high-speed operation)	
	Suspending of HDD	
	Storing KBC,SCC and MOUSE	
	Storing of PCI device	
	Storing of PIT	
	Starts sequence for storing display system.	
	Storing of PIC	
	Storing of DMAC	
	Storing of system status command port	
	Storing of SIO (for models supporting SIO)	
	Storing of PCMCIA card	
	Storing of RTC	
	Storing of HW unique to system	
	Calculation of check sum (conventional memory)	
F134h	Suspending for boot mood	
F137h	Processing of VGA –off (boot mode)	
	Suspending of HDD (boot mode)	
	Transition to S5 of Bluetooth (boot mode) (For models supporting Bluetooth)	
F138h	Processing for boot/ resume/suspend for PnP (Stores PnP resource information into Flash ROM.)	
	Processing for boot/ resume/suspend for password (Stores password information into Flash ROM.)	
F139h	Waiting for completion of suspending for HDD password	
F13Ah	Prohibition of PCI arbiter	
	Setting of Wakeup event	
	Power-off of PC card	
	Re-setting backup current	
	Forced off of fan	
	Checks whether off-process for resume is needed	

Table 2-5 Debug port (Suspend mode) error status (3/3)

LED Status	Test item	Contents
(F13Ah)	Power LED control during suspending	
	Isolates built-in LAN	
	Makes the power of sound off	
	Makes the power of Dock off (for models supporting Dock)	
F13Bh	Model-unique processing just before suspending	
	Waiting for completion of dividing for suspending	
	Stops dividing of extension command for power off.	
F13Ch	Measure for USB over current	
	Serial interrupt control (for model supporting YEBISU)	
	Calculation of check sum of PnP RAM area (Not work in suspending for boot)	
	Acquires how to turn the power off.	
	Resets by EC. (when required)	
	Makes not to send Eject Power Off command when turn the power off by the date check of alarm power on.	
	Prohibition of all SMIs	
	Initializing of special register in suspending	
	Calculates the check sum of SMRAM and stores it in SMRAM.	
F13Dh	Calculates the checksum of system BIOS in the IRT side.(Checksum does not match during IRT)	
	Setting status of suspend completion	
	Prohibition of L1&L2	
	Power off (Completion of BIOS process)	

Table 2-6 Debug port (Resume mode) error status (1/4)

LED Status	Test item	Contents
F100h	Refer to IRT	
F101h	Refer to IRT	
F102h	Refer to IRT	
F103h	Refer to IRT	
	Clears flag for SMI control.	
	Update of Resume counter	
F121h	Checks the WakeUp factors.	
	Rewriting of SMRAM BASE	
	I/O LOCK processing (for models supporting I/O LOCK)	
F122h	Initializing devices necessary for	Initializing of PIT
	initialization before initializing PCI bus	Initializing of PIT channel 0 (Sets the interval of timer interruption to 55ms) Initializing of PIT channel 2 (Sets the sound generator frequency to 664Hz)
		Measuring CPU clock
		Check of parameter block A
		Permission of SMI other than auto-off function
		Control of excess of rated input power
		Control of battery discharging current (1CmA)
		Control of excess of rated current of AC adapter
		Dividing of process for measuring of IRT time
		Setting to clock generator
		Initializing of CPU
		Updating micro-code Judging of CPU type
		Check of Geyserville support
		Sets the CPU clock to High.
	Decovery of DIC register	Setting of Graphics Aperture Size
	Recovery of PIC register	

Table 2-6 Debug port (Resume mode) error status (2/4)

LED Status	Test item	Contents
(F122h)	Initialization of devices necessary for initialization before initializing PCI bus 2	AC'97 control
		Initializing of temperature control information
		Initializing of KBC
		VGA display-off and Reset control
		Starting recovery of VGA
		Initializing of sound
		Acquires the multi-box status.
		Initializing of HC, recognizing of devices
		Control of permission/prohibition for built-in LAN
	Check of the checksum of conventional memory	Resume error DPORT = F174H
F123h	Initializing of PCI devices	
	Check of WakeUp factors after initializing PCI bus	
F124h	Waiting for initializing of devices which have to be initialized before setting HW by PnP resource	Waiting for completion of MultiBox status check (for models supporting Selectable bay)
	Recovery of each device (1)	Processing of RESUME for PnP
		Tentative initialization of printer port (for models supporting printer)
		Serial interrupt control (for models supporting YEBISU)
		Waiting for the completion of VGApower-down control (because the VGA configuration can not be seen)
		Processing of RESUME for PCI
		Recovery of FDC (for models supporting built-in FDD)
		Checks slots that were in ON status during suspending (for models supporting fingerprint authentication)
		Recovery of PCMCIA card
		Error when an ATA card is pulled out (for models supporting ATA boot) Resume error DPORT = F17Bh
		Executing of dividing process of device detection of PC card
		Initializing COM (for models supporting SIO)
		Initializing FIR (for models supporting FIR)
	Check of HDD pack connection	Resume error when HDD is mounted DPORT=F172h
	Start of IDE device resume sequence	

Table 2-6 Debug port (Resume mode) error status s (3/4)

LED status	Test item	Contents
F125h	Recovery of user alarm setting and cancel of alarm power-on function (only one time)	
	Enable of power-off switch	
	Initializing EC and start of reading battery information	
	Recovery of each device(2)	Setting of setup items
		Initializing of DMAC
		Initializing of printer mode (for models supporting printer)
	Initializing of VGA BIOS in resume	Waiting for VGA power on
F126h	Call of VGA BIOS	
F127h/F128h	Processing of password for RESUME	
F129h	Recovery of each device(3)	Recovery of COM register (for models supporting SIO)
		Recovery of DMAC register
		PnP Resume processing (2 nd)
	Motor-off of disabled HDD	
F12Ah	Waiting for completion of KBC initializing (not in ACPI mode) Waiting for completion of USB initializing	
	Recovery of USB register	
	Recovery of CPU register	
	Processing of SIO dummy-reading (for models supporting SIO)	
	Resetting NDP interruption	
	Recovery of system, status, command and port	
	Wakeup check	Notifies the device change status to the upper program
		Setting WAKEUP status data for ACPI
	Initializing HW just before booting or waiting for the completion	Notifies the DVI connection status to VGA BIOS (for models supporting VDI)
		Setting battery saving mode
		Setting of date
		Waiting for the completion of Bluetooth initializing (for models supporting Bluetooth) Renewal of Wakeup factor of DMI and SM-BIOS
		structure table
		Closing PCI device configuration area
		Cache control

Table 2-6 Debug port (Resume mode) error status (4/4)

LED status	Test item	Contents
(F12Ah)		Process related to CPU
		Setting of CPU clock to SETUP designation
		Waiting for motor-off of disabled HDD
		Final decision of USB FDD information
		Post-process of PRE_BOOT_SETUP
		Clears PWRBTN_STS.
		Enables Power Button.
		Measures against chip set defective
	Waiting for the completion of recovery of VGA register	
	Recovery of PIT register	
	Recovery of PCI configuration register	
	Recovery of PIC MASK	
	Executing of driver for RESUME	
	Waiting for the completion of recovery of FDD	(models supporting built-in FDD)
F12Bh	Checks if the power-off switch is pressed or not during resume processing (Suspends if pressed.)	
	Executes HOTKEY F1process when booting in instant security	
F12Ch	(Not in ACPI mode)	Clears key buffer
F12Dh	(In ACPI mode)	Clears IRT status.
F12Eh	(In ACPI mode)	Clears flag in Resume process
		Acquires Wake Up Vector address.
		Clears key buffer.
		Renewal of date/time
		ACPI mode on
		Recovery of write-protected status before.
FFFFh	(In ACPI mode / not in ACPI mode)	Initializing printer port
		Returning to the main process

Procedure 3 Diagnostic Test Program Execution Check

Execute the following tests from the Diagnostic Test Menu. These tests check the system board. Refer to Chapter 3, *Tests and Diagnostic*, for more information on how to perform these tests.

- 1. System test
- 2. Memory test
- 3. Keyboard test
- 4. Display test
- 5. Floppy Disk test
- 6. Printer test
- 7. Async test
- 8. Hard Disk test
- 9. Real Timer test
- 10. NDP test
- 11. Expansion test
- 12. CD-ROM/DVD-ROM test
- 13. Wireless LAN test
- 14. LAN/Modem/Bluetooth/IEEE1394 test
- 15. Sound test
- 16. Only one test

If an error is detected during these tests, go to Procedure 4.

Procedure 4 Replacement Check

The system board may be damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and replace the system board with a new one.

2.5 USB 3.5" FDD Troubleshooting

This section describes how to determine if the USB 3.5" FDD is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: FDD Head Cleaning Check

Procedure 2: Diagnostic Test Program Execution Check Procedure 3: Connector Check and Replacement Check

Procedure 1 FDD Head Cleaning Check

FDD head cleaning is one option available in the Diagnostic Program.

Insert the Diagnostics Disk in the floppy disk drive of the computer, turn on the computer and run the test. And then clean the FDD heads using the cleaning kit. If the FDD still does not function properly after cleaning, go to Procedure 2.

Detailed operation is given in Chapter 3, Tests and Diagnostics.

If the test program cannot be executed on the computer, go to Procedure 3.

Procedure 2 Diagnostic Test Program Execution Check

Insert the Diagnostics Disk in the FDD connected to the computer, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the diagnostics test procedures.

Make sure the floppy disk is formatted correctly and that the write protect tab is disabled. Floppy disk drive test error codes and their status names are listed in Table 2-7. If any other errors occur while executing the FDD diagnostics test, go to Check 1.

Code Status 01h Bad command Address mark not found 02h 03h Write protected 04h Record not found 06h Media replaced 08h DMA overrun error 09h DMA boundary error 10h CRC error FDC error 20h 40h Seek error 60h FDD not drive 80h Time out error (Not ready) EEh Write buffer error FFh Data compare error

Table 2-7 FDD error code and status

Check 1 If the following message is displayed, disable the write protect tab on the floppy disk by sliding the write protect tab to "write enable". If any other message appears, perform Check 2.

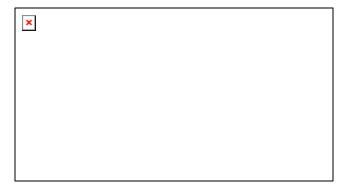
Write protected

Check 2 Make sure the floppy disk is formatted correctly. If it is, go to Procedure 3.

Procedure 3 Connector Check and Replacement Check

The USB FDD connector may be disconnected from the system board or SD board. Check visually that the connector is connected to one of them firmly.

Check 1 Make sure the following cables and connectors are firmly connected to the system board or SD board. The USB FDD can be connected to any of four USB ports. (Three ports are installed on the system board and one is on SD board.)



Also make sure the following points:

- ? There is no loose connection.
- ? There is no slantwise connection.
- ? Connectors are fully inserted.
- ? There is no damage on the cable.

If any of the connections are loose, reconnect firmly and repeat Procedure 2.

If any of connectors is broken, replace it with new one and repeat Procedure 2.

If there is still an error, go to Check 2.

- Check 2 The USB FDD may be defective or damaged. Replace it with a new one. If the USB FDD is still not functioning properly, perform Check 3.
- Check 3 Replace the system board with a new one following the steps in Chapter 4, *Replacement Procedures*.

2.6 2.5" HDD Troubleshooting

This section describes how to determine if the 2.5" HDD is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Partition Check Procedure 2: Message Check Procedure 3: Format Check

Procedure 4: Diagnostic Test Program Execution Check Procedure 5: Connector Check and Replacement Check

CAUTION: The contents of the hard disk will be erased when the 2.5" HDD troubleshooting procedures are executed. Copy the contents of the hard disk to floppy disks or other storage drive(s) for backup the data. For the backup, refer to the User's Manual.

Procedure 1 Partition Check

Insert the Toshiba MS-DOS system disk and start the computer. Perform the following checks:

- Check 1 Type **C:** and press **Enter**. If you cannot change to drive C, go to Check 2. If you can change to drive C, go to Procedure 2.
- Check 2 Type **FDISK** and press **Enter**. Choose Display Partition Information from the FDISK menu. If drive C is listed in the Display Partition Information, go to Check 3. If drive C is not listed, return to the FDISK menu and choose the option to create a DOS partition or a logical DOS drive on drive C. If the problem still exists, go to Procedure 2.
- Check 3 If drive C is listed as active in the FDISK menu, go to Check 4. If drive C is not listed as active, return to the FDISK menu and choose the option to set the active partition for drive C. Then go to Procedure 2.
- Check 4 Remove the system disk from the FDD and reboot the computer. If the problem still exists, go to Procedure 2. Otherwise, the 2.5" HDD is operating normally.

Procedure 2 Message Check

When the power is turned on, the system performs the Initial Reliability Test (IRT) installed in the BIOS ROM. When the test detects an error, an error message is displayed on the screen.

Turn on the computer and check the message on the screen. When an OS starts from the 2.5" HDD, go to Procedure 3. Otherwise, start with Check 1 below and perform the other checks as instructed.

Check 1 If any of the following messages appear, go to Procedure 3. If the following messages do not appear, perform Check 2.

HDC ERROR

or

HDD #X ERROR (After 5 seconds this message will disappear.)

Check 2 If either of the following messages appears, go to Check 3. If the following messages do not appear, perform Check 4.

```
Insert system disk in drive Press any key when ready .....
```

or

Non-System disk or disk error Replace and press any key when ready

Check 3 Using the SYS command of the MS-DOS, transfer the system to the 2.5" HDD. If the system is not transferred, go to Procedure 3. Refer to the MS-DOS Manual for detailed operation.

If the following message appears on the display, the system program has been transferred to the HDD.

```
System Transferred
```

If an error message still appears on the display, perform Check 4.

Check 4 The 2.5" HDD and the connector of the system board may be disconnected. Insert the connectors firmly. (Refer to the steps described in Chapter 4, *Replacement Procedures* for disassembling.) If they are firmly connected, go to Procedure 3.

Procedure 3 Format Check

The computer's HDD is formatted using the MS-DOS FORMAT program or the physical format program of the test program. To format the HDD, start with Check 1 below and perform the other steps as required.

Refer to the MS-DOS Manual for the operation of MS-DOS. For the format by the test program, refer to the Chapter 3.

- Check 1 Format the 2.5" HDD using MS-DOS FORMAT command. Type as **FORMAT** C:/S/U.
 - If the 2.5" HDD can not be formatted, perform Check 2.
- Check 2 Using the MS-DOS FDISK command, set the 2.5" HDD partition. If the partition is not set, go to Check 3. If it is set, format the 2.5" HDD using MS-DOS FORMAT command.
- Check 3 Using the Diagnostic Disk, format the 2.5" HDD with a format option (physical format). If the HDD is formatted, set the 2.5" HDD partition using MS-DOS FDISK command.

If you cannot format the 2.5" HDD using the test program, go to Procedure 4.

Procedure 4 Diagnostic Test Program Execution Check

The HDD test program is stored in the Diagnostics Disk. Perform all of the HDD tests in the Hard Disk Drive Test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the HDD test program.

If an error is detected during the HDD test, an error code and status will be displayed. The error codes and statuses are described in Table 2-8. If an error code is not displayed but the problem still exists, go to Procedure 5.

Table 2-8 2.5" Hard disk drive error code and status

Code	Status
05	HDD - HDC NOT RESET ERROR
07	HDD - DRIVE NOT INITIALIZE
09	HDD - DMA BOUNDARY ERROR
0B	HDD - BAD TRACK ERROR
BB	HDD - UNDEFINED ERROR
08	HDD - OVERRUN ERROR (DRQ ON)
01	HDD - BAD COMMAND ERROR
02	HDD - ADDRESS MARK NOT FOUND
04	HDD - RECORD NOT FOUND ERROR
10	HDD - ECC ERROR
20	HDD - HDC ERROR
40	HDD - SEEK ERROR
80	HDD - TIME OUT ERROR
11	HDD - ECC RECOVER ENABLE
AA	HDD - DRIVE NOT READY
CC	HDD - WRITE FAULT
E0	HDD - STATUS ERROR
0A	HDD - BAD SECTOR
EE	HDD - ACCESS TIME ERROR
DA	HDD - NO HDD
12	HDD - DMA CRC ERROR

Procedure 5 Connector Check and Replacement Check

The HDD is connected to the connector of the system board. The connecting portion may be disconnected. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks to check the connecting portion:

Check 1 Make sure the HDD and system board is firmly connected.



If their connection is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The 2.5" HDD may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures* and check the operation. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.7 Keyboard Troubleshooting

To determine if the computer's keyboard is functioning properly, perform the following procedures. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

Execute the test for keyboard of ONLY ONE test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, the keyboard is functioning properly.

Procedure 2 Connector Check and Replacement Check

The keyboard may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the keyboard cable is securely connected to the system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The keyboard or its cable may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.8 Touch Pad Troubleshooting

To determine if the computer's touch pad is functioning properly, perform the following procedures. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

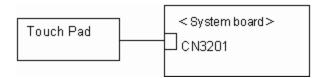
Execute the test for touch pad of ONLY ONE test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, the touch pad keyboard is functioning properly.

Procedure 2 Connector Check and Replacement Check

The touch pad or touch pad flexible cable may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the touch pad flexible cable is firmly connected to the touch pad and the system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The touch pad or touch pad flexible cable may be damaged. Replace the touch pad with a new one first following the instructions in Chapter 4, *Replacement Procedures*. If the problem still exists, replace the touch pad flexible cable with a new one. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.9 Display Troubleshooting

This section describes how to determine if the computer's display is functioning properly. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: External Monitor Check

Procedure 2: Diagnostic Test Program Execution Check

Procedure 3: Connector Check and Cable Check

Procedure 4: Replacement Check

Procedure 1 External Monitor Check

Connect an external monitor to the computer's external monitor port, and then boot the computer. The computer automatically detects the external monitor.

If the external monitor works correctly, the internal LCD may be damaged. Go to Procedure 3.

If the same problem as the internal monitor appears on the external monitor, the system board may be damaged. Go to Procedure 2.

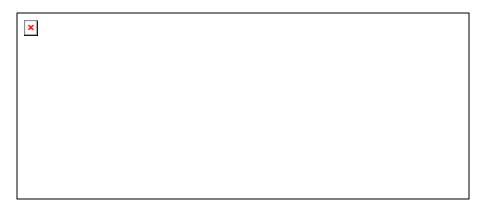
Procedure 2 Diagnostic Test Program Execution Check

The Display Test program is stored on the computer's Diagnostics disk. This program checks the display controller on the system board. Refer to Chapter 3, *Tests and Diagnostics* for details. If an error is detected, go to Procedure 3.

Procedure 3 Connector Check and Cable Check

The LCD module is connected to the system board by an LCD/FL cable. The FL inverter board is also connected to the system board by an LCD/FL cable. And the FL is connected to the FL inverter board by the HV cable. The connectors may be disconnected from the system board or the FL inverter, or they may be damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*.

If the connection is loose, reconnect firmly and restart the computer. If there is still an error, go to Procedure 4.



Procedure 4 Replacement Check

The FL lamp, FL inverter, LCD module, system board and LCD/FL cable are connected to display circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

If the FL lamp does not light, perform Check 1.

If characters or graphics on the internal display are not displayed clearly, perform Check 4.

If some screen functions do not work properly, perform Check 4.

If the FL lamp remains lit when the display is closed, perform Check 5.

- Check 1 Replace the FL lamp with a new one following the instructions in Chapter 4, Replacement Procedures and test the display again. If the problem still exists, perform Check 2.
- Check 2 The LCD/FL cable may be defective or damaged. Replace the FL/LCD cable with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still exists, perform Check 3.
- Check 3 The FL inverter may be defective or damaged. Replace the FL inverter board with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still exists, perform Check 4.
- Check 4 The LCD module may be defective or damaged. Replace the LCD module with a new one following the instructions in Chapter 4, *Replacement Procedure* and test the display again. If the problem still exists, perform Check 5.
- Check 5 The system board may be defective or damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedure*.

2.10 Optical Drive Troubleshooting

To check if the optical drive is defective or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

Prepare the tools before the test. (Refer to tools for implementing the Diagnostics procedures on page 2-1.)

Execute the CD-ROM/DVD-ROM Test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2.

Procedure 2 Connector Check and Replacement Check

The optical drive may be disconnected from the system board or faulty. Disassemble the computer following the steps described in Chapter 4 and perform the following checks:

Check 1 Make sure the optical drive and the system board are firmly connected.



If the connection is loose, reconnect it firmly and return to Procedure 1. If there is still an error, perform Check 2.

- Check 2 The optical drive may be faulty. Replace the optical drive with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 3.
- Check 3 The system board may be faulty. Replace it with new one following the instructions in Chapter 4.

2.11 Modem Troubleshooting

To check if the modem is defective or malfunctioning, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

Execute the Modem Test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected, perform Procedure 2.

Procedure 2 Connector Check and Replacement Check

An MDC (Modem Daughter Card) is used as the modem for this computer. The MDC is connected to the SD board which is connected to the system board. If the modem malfunctions, these connections or boards may be bad or the MDC might be faulty.

Disassemble the computer following the steps described in Chapter 4 and perform the following checks:

Check 1 Make sure the following connections are firmly connected.



If any connector is disconnected, connect it firmly and return to Procedure 1. If there is still an error, perform Check 2.

- Check 2 The Modem jack (RJ11) may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 The MDC may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 4.
- Check 4 The SD board may be faulty. Replace it with a new one following the instructions in Chapter 4. If the problem still occurs, perform Check 5.

- Check 5 The cable between the SD board and system board may be faulty. Replace it with a new one following the instructions in Chapter 4. If the problem still occurs, perform Check 6.
- Check 6 The system board may be faulty. Replace it with a new one following the instruction in Chapter 4.

2.12 LAN Troubleshooting

To check if the computer's LAN is defective or malfunctioning, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

Execute the LAN/Modem/Bluettoth/IEEE1394 Test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2

Procedure 2 Connector Check and Replacement Check

The LAN jack (RJ45 jack) is mounted on the system board. If the LAN malfunctions, the LAN cable or the system board might be faulty.

Disassemble the computer following the steps described in Chapter 4.



- Check 1 Make sure the LAN cable is firmly connected to the LAN jack.
 - If the connection is good but there is still an error, perform Check 2.
- Check 2 The LAN cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 The system board may be faulty. Replace it with a new one following the steps in Chapter 4.

2.13 Wireless LAN Troubleshooting

This section describes how to determine if the computer's Wireless LAN is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Transmitting-Receiving Check

Procedure 2: Antennas' Connection Check

Procedure 3: Replacement Check

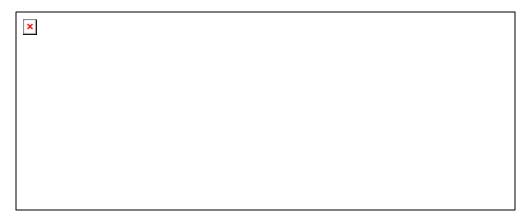
Procedure 1 Transmitting-Receiving Check

Check 1 Execute Wireless LAN test program to check the transmitting-receiving function of the wireless LAN. You will need a second computer that can communicate by the wireless LAN. Perform the test following the instructions described in Chapter 3.

If the computer passes the test, the function is correctly working. If the computer does not pass the test, perform Procedure 2.

Procedure 2 Antennas' Connection Check

The wireless LAN function-wiring diagram is shown below:



Any of the connections may be disconnected. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and check the followings:

- Check 1 Make sure the wireless communication switch is "On".

 If the switch is "Off", turn it "On". If there is still an error, perform Check 2.
- Check 2 Make sure the wireless LAN board is firmly connected to the CN2200 on the system board.
 If the wireless LAN board is disconnected, connect it firmly and perform Procedure 1. If the problem still occurs, perform Check 3.
- Check 3 Make sure that the wireless LAN antenna cables (black and white) are firmly connected to the connector on the wireless LAN board.

 If the wireless LAN antenna cables are disconnected, connect them firmly and perform Procedure 1. If the problem still occurs, go to the procedure 3..

Procedure 3 Replacement Check

The wireless LAN board, wireless LAN antennas or the system board may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then check the followings:

- Check 1 The wireless LAN board may be defective or damaged. Replace the wireless LAN board with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 2.
- Check 2 The wireless LAN antennas may be defective or damaged. Replace them with new ones following the instructions in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 3.
- Check3 Replace the system board with a new one following the instructions in Chapter 4, *Replacement Procedures* and test the display again.

2.14 Sound Troubleshooting

To check if the sound function is defective or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check
Procedure 3: Replacement Check

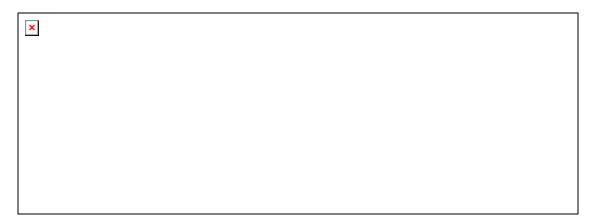
Procedure 1 Diagnostic Test Program Execution Check

Execute the Sound Test in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2.

Procedure 2 Connector Check

The connection of sound system is shown in the following figure.



As the connection may be bad, disassemble the PC and check each connection.

If each component and board is firmly connected but the sound function does not work properly, go to Procedure 3.

Procedure 3 Replacement Check

- Check 1 When the headphone does not work properly, it may be faulty. Replace it with a new one. If the problem still occurs, perform Check 5.
- Check 2 When the external microphone does not work properly, it may be faulty. Replace it with a new one. If the problem still occurs, perform Check 5.
- Check 3 When the internal microphone does not work properly, it may be faulty. Replace it with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 5.
- Check 4 When the speakers do not work properly, they may be faulty. Replace them with a new one following the steps in Chapter 4. If the problem still occurs perform Check 6.
- Check 5 The SJ board or the cable between the SJ board and SD board may be faulty. Replace them with new ones following the instructions in Chapter 4. If the problem still occurs, perform Check 6.
- Check 6 The SD board or the cable between the SD board and system board may be faulty. Replace them with new ones following the instructions in Chapter 4. If the problem still occurs, perform Check 7.
- Check 7 The system board may be faulty. Replace it with a new one following the instructions in Chapter 4.

2.15 TV Tuner Troubleshooting

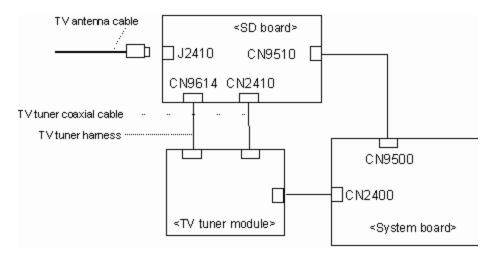
To check if the TV tuner is defective or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Connector Check and Replacement Check

Procedure 1 Connector Check and Replacement Check

The TV antenna, TV tuner module, SD board or System board may be disconnected or faulty. Disassemble the computer following the steps described in Chapter 4 if necessary and perform the following checks:

Check 1 Make sure the following connector has been firmly connected.



If any connection is loose, reconnect it firmly and return to Procedure 2. If there is still an error, perform Check 2.

- Check 2 The antenna cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 The TV tuner module may be faulty. Replace the TV tuner module with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 4.
- Check 4 The SD board may be faulty. Replace the SD board with a new one following the steps in Chapter 4. If the problem still occurs, perform Check 5.
- Check 5 Cables in the computer (TV tuner coaxial cable, TV tuner harness and the cable between the SD board and system board) may be faulty. Replace the m with new ones following the steps in Chapter 4. If the problem still occurs, perform Check 6.
- Check 6 The system board may be faulty. Replace it with new one following the instructions in Chapter 4.

Chapter 3 Tests and Diagnostics

Chapter 3 Contents

3.1 The Diagnostic Test			3-1
	3.1.1	Diagnostics menu	3-1
	3.1.2	H/W(Hardware) initial information setting tool	3-3
	3.1.3	Heatrun test program	3-3
3.2	Executing th	ne Diagnostic Test	3-4
	3.2.1	Diagnostics menu (T&D)	3-4
	3.2.2	H/W initial information setting tool	3-7
	3.2.3	Heatrun test program	3-7
3.3	Setting of the	e hardware configuration	3-8
3.4	Heatrun Tes	it	3-11
3.5	Subtest Nan	nes	3-12
3.6	System Test		3-14
3.7	Memory Te	st	3-16
3.8	Keyboard Test3-		
3.9	Display Test		
3.10	Floppy Disk	Test	3-21
3.11	Printer Test		3-23
3.12	Async Test.		3-25
3.13	Hard Disk T	Test	3-26
3.14	Real Timer	Test	3-29
3.15	NDP Test		3-31
3.16	Expansion Test		
3.17	CD-ROM/DVD-ROM Test		
3.18	Error Code and Error Status Names		
3.19	Hard Disk Test Detail Status		
3.20	Only One To	est	3-40
	3.20.1	Program Description	3-40
	3.20.2	Operations	3-40

3.21	Head Cleani	ng	. 3-47
	3.21.1	Function Description	. 3-47
	3.21.2	Operations	. 3-47
3.22	Log Utilities.		. 3-48
	3.22.1	Function Description	. 3-48
	3.22.2	Operations	. 3-49
3.23	Running Tes	st	. 3-50
	3.23.1	Function Description	. 3-50
	3.23.2	Operations	. 3-50
3.24	Floppy Disk	Drive Utilities	. 3-51
	3.24.1	Function Description	.3-51
	3.24.2	Operations	. 3-52
3.25	System Conf	figuration	. 3-56
	3.25.1	Function Description	. 3-56
	3.25.2	Operations	. 3-57
3.26	Wireless LA	AN Test Program (Intel-made b/g)	. 3-58
3.27	Wireless LA	AN Test Program (Intel-made a/b/g)	. 3-62
3.28	Wireless LA	AN Test Program (Askey-made)	. 3-67
3.29	LAN/Mode	m/Bluetooth/IEEE1394 Test Program	.3-71
	3.29.1	LAN test	. 3-71
	3.29.2	Modem test	. 3-74
	3.29.3	Bluetooth test	. 3-75
	3.29.4	IEEE1394 test	. 3-84
3.30	Sound Test	Program	. 3-85
	3.30.1	Sound (Standard) test	. 3-85
	3.30.2	Sound (Legacy) test	. 3-87
	3.30.3	CD Sound (Standard) test	. 3-88
	3.30.4	CD Sound (Legacy) test	. 3-90
3.31	SETUP		. 3-91
	3.31.1	Function Description	. 3-91

3.31.2	Accessing the SETUP	Program	.3-9	9	2

Tables

Table 3-1	Subtest names	3-12
Table 3-2	Error codes and error status names	3-35
Table 3-3	Hard disk controller status register contents	3-38
Table 3-4	Error register contents	3-39
Table 3-5	Error message	3-77
Table 3-6	Error code for Bluetooth test (BD_ADDR)	3-78
Table 3-7	Error code for Bluetooth test (BD ADDR of the DUT)	3-82

3.1 The Diagnostic Test

This chapter explains how to use the Diagnostic Test programs to test the functions of the computer's hardware modules. The Diagnostics Programs are stored on some Diagnostic Disks. There are Service Program Modules (DIAGNOSTIC MENU) and the Test Program Modules (DIAGNOSTIC TEST MENU) on the Diagnostic Disk.

The Hardware Initial information Setting Tool consists of some programs which write the hardware information or displays the current information of the computer. It is also included in one of Diagnostic Disks.

The heatrun test is automatic test program which executes the some tests successively.

NOTE: Before starting the diagnostics, be sure to follow these steps:

- 1. Check all cables are connected firmly.
- 2. Exit any application and close Windows.
- 3. Check if [All Devices] is selected in the "Device Config." in SETUP menu.

3.1.1 Diagnostics menu

The DIAGNOSTIC MENU consists of the following functions.

- ONLY ONE TEST
- **∠** LOG UTILITIES
- RUNNING TEST

- **EXIT TO MS-DOS**

The DIAGNOSTIC TEST MENU contains the following functional tests:

- SYSTEM TEST
- MEMORY TEST

- PRINTER TEST
- ASYNC TEST

- HARD DISK TEST
- **REAL TIMER TEST**
- NDP TEST
- **∠** EXPANSION TEST
- ∠ CD-ROM/DVD-ROM TEST

Other tests are:

- Wireless LAN TEST (Wireless LAN TEST disk)
- ∠ LAN/Modem/Bluetooth/IEEE1394 TEST (LAN/Modem/Bluetooth/IEEE1394 TEST disk)
- ✓ Sound TEST (Sound TEST disk)

You will need the following equipment to perform some of the Diagnostic test programs.

- The Diagnostic Disks (T&D for maintenance for Main, LAN/Modem/Bluetooth/IEEE1394, wireless LAN and Sound)
- ∠ USB FDD (for all tests)
- A USB cable (USB test)

- A microphone (Sound test)
- Headphones (Sound test)
- A cleaning kit to clean the floppy disk drive heads (Head Cleaning)
- An exclusive modem test jig (Nitto Electric Manufacture Co.,Ltd-made QE2000P01) (Modem test)
- ∠ A LAN wraparound connector (LAN test)
- PC card wraparound connector (Expansion test)
- RS232C wraparound connector (Async test)

3.1.2 H/W (Hardware) initial information setting tool

The H/W initial information setting tool consists of the following programs.

- Region write

You will need the following equipment to perform some of the programs.

3.1.3 Heatrun test program

The heatrun test starts automatically after the selection.

You will need the following equipment to perform this program.

3.2 Executing the Diagnostic Test

To start the DIAGNOSTIC PROGRAM, follow these steps:

- 1. Insert the Diagnostics disk in the floppy disk drive.
- 2. Release the lock of the power switch and turn on the computer with pressing the **F12**. Select the FDD in the display for selecting booting unit. Then, press **Enter** and the following menu appears.

```
Microsoft Windows XX Startup Menu

1. Repair Main (T&D)

2. Repair initial config set

3. Repair Heatrun (T&D)

Enter a choice: 1
```

To start the Diagnostics menu (T&D), press **1** and **Enter**. To start the H/W initial information setting tool, press **2** and **Enter**.

To start the Heatrun test, press **3** and **Enter**.

NOTE: After replacing the system board or CPU, it is necessary to execute the subtest 01 Initial configuration in 3.3 Setting of the hardware configuration.

3.2.1 Diagnostics menu (T&D)

9 - EXIT TO MS-DOS

After pressing 1 and **Enter** in the startup menu, the following menu appears.

```
TOSHIBA personal computer XXXXXX DIAGNOSTICS version X.XX (c) copyright TOSHIBA Corp. 20XX

DIAGNOSTICS MENU:

1 - DIAGNOSTIC TEST
2 - ONLY ONE TEST
3 -
4 - HEAD CLEANING
5 - LOG UTILITIES
6 - RUNNING TEST
7 - FDD UTILITIES
8 - SYSTEM CONFIGURATION
```

NOTE: To exit the DIAGNOSTIC TEST MENU, press **Esc**. If a test program is in progress, press **Ctrl** + **Break** to exit the test program. If a test program is in progress, press **Ctrl** + **C** to stop the test program.

Set the highlight bar to 1, and press **Enter**. The following DIAGNOSTIC TEST MENU will appear:

```
TOSHIBA personal computer XXXXXX DIAGNOSTICS
version X.XX (c) copyright TOSHIBA Corp. 20XX
DIAGNOSTIC TEST MENU:
 1 - SYSTEM TEST
 2 - MEMORY TEST
 3 - KEYBOARD TEST
 4 - DISPLAY TEST
 5 - FLOPPY DISK TEST
 6 - PRINTER TEST
                        [It is not supported]
 7 - ASYNC TEST
                        [It is not supported]
 8 - HARD DISK TEST
9 - REAL TIMER TEST
10 - NDP TEST
11 - EXPANSION TEST
12 - CD-ROM/DVD-ROM TEST
```

88 - ERROR RETRY COUNT SET [FDD & HDD]

99 - EXIT TO DIAGNOSTICS MENU

↑↓→← : Selectitems Enter : Specify Esc : Exit

Functions 1 through 12 are the Diagnostic Tests. Function 88 sets the floppy disk drive and hard disk drive error retry count (0-255).

To exit the submenu of the Diagnostic Test and returns to the Diagnostics Menu, set the highlight bar to function 99 and press **Enter**.

Select the option you want to execute and press **Enter**. When you select 1- SYSTEM TEST, the following message will appear:

03 - Geyserville 04 - Quick charge 05 - DMI read

99 - Exit to DIAGNOSTIC TEST MENU

NOTE: The menu displayed by your computer may be slightly different from the one shown above.

Select the desired subtest number from the subtest menu and press **Enter**. The following message will appear:

```
TEST LOOP : YES (or NO) ERROR STOP : YES (or NO)
```

Use the right and left arrow keys to move the cursor to the desired option.

Selecting **YES** of TEST LOOP increases the pass counter by one, each time the test cycle ends and restarts the test cycle.

Selecting **NO** returns the process to the subtest menu after the test is complete.

Use the up and down arrow keys to move the cursor to "ERROR STOP".

Use the right and left arrow keys to move the cursor to the desired option and press **Enter**.

Selecting **YES** of ERROR STOP stops the test program when an error is found and displays the operation guide on the right side of the display screen as shown below:

```
ERROR STATUS NAME [[ HALT OPERATION ]]

1: Test end
2: Continue
3: Retry
```

These three selections have the following functions respectively:

- 1. Terminates the test program and exits to the subtest menu.
- 2. Continues the test.
- 3. Restarts the test from the error.

Selecting **NO** keeps the test running even if an error is found. When an error occurred, the error status is displayed and one error is added to the error counter.

Table 3-1 in section 3.5 describes the function of each test on the subtest menu. Table 3-2 in section 3.18 describes the error codes and error status for each error.

Details of tests in DIAGNOSTIC TEST MENU are described on and after section 3.6. As for other service programs, refer to section 3.20 to 3.25.

3.2.2 H/W initial information setting tool

After selecting this test, the following menu appears in the display.

For more details on this test, refer to the section 3.3.

3.2.3 Heatrun test program

Heatrun test starts executing the same subtests as RUNNING TEST.

For more details on this test, refer to the section 3.4.

3.3 Setting of the hardware configuration

To execute this program, select 2-Repair initial config set in the startup menu, press **Enter** and follow the directions on the screen. The H/W initial information setting tool consists of following subtests. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Initial configuration

This subtest executes the following items and shows their contents in the display. When an item ends normally, the program proceeds automatically to the next one. When an error is found, the program stops and waits for key input. (After solving the problem, the program executes the item again.)

- ? Setting of the CPU set table
- ? Setting of the micro code
- ? Setting of the EHSS
- ? Inputting and writing of DMI information

When the DMI information is displayed, the following messages appear in order. Input each information. (If you do not replace the PCB, the DMI information should not be changed.)

- 1. "Enter Model Name?" is displayed. Input the computer's model name and press **Enter**. (e.g. Satellite)
- 2. "Enter Version Number?" is displayed. Input the computer's version number and press **Enter**. (e.g. PC18070C313S)
- 3. "Enter Serial Number?" is displayed. Input the computer's serial number and press **Enter**. (e.g. 12345678)
- 4. "Enter Model Number?" is displayed. Input the computer's sales model number and press **Enter**. (e.g. PP200-AAAA)
- 5. "Enter Bundle Number?" is displayed. Input the computer's PCN/Bundle number and press **Enter**. (e.g. PMSREQ3Q34H/S0123456789)
- 6. "Write data OK (Y/N)?" is displayed. To write the DMI information to the Flash ROM, press **Y**, and then **Enter**.
- 7. "Create DMIINFO TXT (Y/N)?" is displayed. Press **Y**, then the DMI information (text data) is written to the Floppy disk, etc.

- ? Setting of the HWSC
- ? Setting of the UUID
- ? Display of the DMI information (including UUID)
- ? Setting of DVD region code (Yes/No)

After completion of the above settings, H/W configuration & DMI information are appeared in order. Check the contents and press **Enter**.

Subtest 02 Region write

This subtest sets the region code for DVD drive based on the destination of the machine.

When the region code has been already written, test ends without setting.

The following message appears in the display after setting the region code. Press any key to return to the H/W initial information setting tool menu.

```
******

It completed *****

******

******

******

******

Press any key to continue...
```

Subtest 03 DMI information save

This is one of tools to copy the DMI information to a new PCB after replacing.

This subtest saves all the DMI data in a floppy disk.

Subtest 04 DMI information recovery

This is one of tools to copy the DMI information to a new PCB after replacing.

This subtest writes all the DMI data in the floppy disk into the new PCB.

NOTE: Since the data of UUID is updated every time when this subtest, DMI information recovery, is done, the saved UUID data is not written.

Subtest 08 System configuration display

This subtest displays the information of the system configuration.

When the following message appears, confirm the contents and press **Enter**.

For more details on the system configuration information, refer to "3.25 System configuration".

Subtest 09 E2PROM test (MAC/GUID/DMI)

It checks automatically whether the MAC address, GUID of IEEE1394 and DMI information are written.

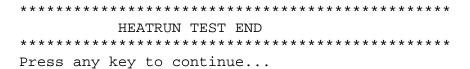
3.4 Heatrun Test

To execute this program, select 3-Repair heatrun in the startup menu and press **Enter**.

After selecting this test, the same subtests as 3.23 Running Test are executed successively.

For more details on the procedure and test content, refer to Running Test.

When the heatrun test ends, following message appears in the display.



Press any key to return to the startup menu.

NOTE: The test result (Errorlog.txt) is stored in the floppy disk. The result is displayed in the same format as Log Utilities. For more details of the format, refer to 3.22 Log Utilities.

3.5 Subtest Names

Table 3-1 lists the subtest names for each test program in the DIAGNOSTIC TEST MENU.

Table 3-1 Subtest names (1/2)

No.	Test Name	Subtest No.	Subtest Name
1	SYSTEM	01	ROM checksum
		02	Fan ON/OFF
		03	Geyserville
		04	Quick charge
		05	DMI read
2	MEMORY	01	Conventional memory
		02	Protected Mode
		03	Protected Mode (cache off)
		04	Cache memory (on/off)
		05	Stress
3	KEYBOARD	01	Pressed key code display
4	DISPLAY	01	VRAM read/write for VGA
		02	Gradation for VGA
		03	Gradation for LCD
		04	Gradation & Mode test for VGA
		05	All dot on/off for LCD
		06	"H" pattern display
		07	LCD Brightness
5	FLOPPY DISK	01	Sequential read
		02	Sequential read/write
		03	Random address/data
		04	Write specified address
		05	Read specified address

Table 3-1 Subtest names (2/2)

No.	Test Name	Subtest No.	Subtest Name
6	PRINTER	01	Ripple pattern
	[Not supported]	02	Function
		03	Wrap around
7	ASYNC	01	FIR/SIR Point to point (send)
	[Not supported]	02	FIR/SIR Point to point (receive)
		03	Wrap around (board)
8	HARD DISK	01	Sequential read
		02	Address uniqueness
		03	Random address/data
		04	Cross talk & peak shift
		05	Partial Read
		06	Write specified address
		07	Read specified address
		08	Sequential write
		09	W-R-C specified address
9	REAL TIMER	01	Real time
		02	Backup memory
		03	Real time carry
10	NDP	01	NDP test
11	EXPANSION	01	PCMCIA wrap around [Not supported]
		03	RGB monitor ID
13	CD-ROM	01	Sequential read
	/DVD-ROM	02	Read specified address
		03	Random address/data
		04	RW 1point W/R/C

3.6 System Test

To execute the System Test, select **1** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 ROM Checksum

This subtest executes a checksum test of the BIOS ROM (range: F0000h to FFFFFh, 64KB) on the System Board.

Subtest 02 Fan ON/OFF

This subtest turns on/off the fan motor by force with Fan ON/OFF commands.

The following message will appear.

```
Fan number select (1;FAN#1, 2;FAN#2, 0; FAN#1&#2) ?
```

To check the CPU fan, press 1 and Enter.

To check the VGA fan, press **2** and **Enter**.

To check both CPU fan and VGA fan, press **0** and **Enter**.

The following message will appear.

```
Fan test execute now ... (CPU:xxxxRpm / GPU:xxxxRpm)
*** Test Fan Revolution 0000RPM start
```

Make sure the special fan does not rotate and the message of fan revolution for it is '0000Rpm'. Then press **Enter**.

The following message will appear.

```
*** Test Fan Revolution Low speed Start
```

Make sure the fan rotates at low speed and the message of fan revolution for it changes. Then press **Enter**.

The following message will appear.

```
*** Test Fan Revolution High speed Start
```

Make sure the fan rotates at high speed and the message of fan revolution for it changes. Then press **Enter**

After a while, the fan rotating will stop.

Subtest 03 Geyserville

If the CPU supports Gerserville (SpeedStep), this Subtest checks that the CPU operating clock speed can be changed.

Subtest 04 Quick Charge

This subtest checks the status for the quick charge.

Subtest 05 DMI read

This subtest displays the information in the Flash-ROM in the following format.

```
*** DMI Data Display Ver X.XX ***
```

UUID Number : XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX

Press [Enter] to EXIT

To exit this subtest and return to the SYSTEM test menu, press **Enter**.

3.7 Memory Test

To execute the Memory Test, select **2** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Conventional memory

This subtest writes a constant data to conventional memory (0 to 640 KB), then reads the new data and compares the result with the original data.

Subtest 02 Protected Mode

NOTE: The CONFIG.SYS file must be configured without expanded memory manager programs such as EMM386.EXE, EMM386.SYS or QEMM386.SYS. Also, the HIMEM.SYS must be deleted from the CONFIG.SYS file.

This subtest writes constant data and address data (from 1MB to maximum MB), and reads the new data and compares the result with the original data.

Subtest 03 Protected Mode (Cache off)

This subtest executes the same test as the subtest 02 with the cache off.

Subtest 04 Cache Memory (on/off)

To test the cache memory, a pass-through write-read comparison of '5Ah' data is run repeatedly to the test area ('7000':'Program' size to '7000':'7FFF' (32 KB)) to check the hit-miss ratio (on/off status) for CPU cache memory. One test takes 3 seconds.

Number of misses? Number of hits? OK Number of misses? Number of hits? Fail

Subtest 05 Stress

Data (from 1MB to the maximum MB) is written from the 16KB write buffer to the 16KB read buffer and compared the data in the buffers. The read buffer starts from 0001 and the comparison is continued with the following read buffer addresses: 0001, 0003, 0005, 0007, 0009, 000b, 000d and 000f.

3.8 Keyboard Test

To execute the Keyboard Test, select **3** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Pressed key code display

When a key is pressed, the scan code, character code, and key top name are displayed on the screen in the format shown below. The **Ins Lock**, **Caps Lock**, **Num Lock**, **Scroll Lock**, **Alt**, **Ctrl**, **Left Shift**, and **Right Shift** keys are displayed in reverse screen mode when pressed. The scan codes, character codes, and key top names are shown in Appendix D.

```
KEYBOARD TEST IN PROGRESS 302000

Scan code =
Character code =
Keytop =

Ins Lock Caps Lock Num Lock Scroll Lock
Alt Ctrl Left Shift Right Shift
PRESS [Enter] KEY
```

3.9 Display Test

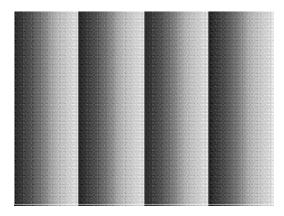
To execute the Display Test, select **4** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 VRAM read/write for VGA

This subtest writes the constant data (AAh and 55h) to the video RAM. The data is read and compared to the original data.

Subtest 02 Gradation for VGA

This subtest displays four colors: red, green, blue and white from left to right across the screen from black to maximum brightness. The display below appears on the screen, when this subtest is executed.



To exit this subtest and return to the DISPLAY TEST menu, press **Enter**.

Subtest 03 Gradation for LCD

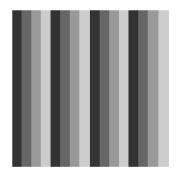
This subtest displays bands of gradations for mixed colors, then for red, green, and blue. Next, it displays eight solid colors full screen: red, semi-red, green, semi-green, blue, semi-blue, white, and semi-white. Each color displays for three seconds.

Subtest 04 Gradation & Mode test for VGA

This subtest displays gradations for following modes. To change the mode, press **Enter**.

```
[Mode 12]
[Mode 13]
[Mode 3]
[Mode 111
            640*480
                       64K]
[Mode 112
            640*480
                       16M]
[Mode 114
            800*600
                       64K]
[Mode 115
            800*600
                       16M]
[Mode 117
           1024*768
                       64K]
[Mode 118
           1024*768 16M]
```

The display below appears on the screen when this subtest is executed.



[Mode 12]

(Display example: Mode 12)

To exit this subtest and return to the DISPLAY TEST menu, press **Enter** after displaying the Mode 118.

Subtest 05 All dot on/off for LCD

This subtest displays an all-white screen then an all-black screen. The display changes automatically every three seconds and the screen returns to the DISPLAY TEST menu.

Subtest 06 "H" Pattern Display

This subtest displays a full screen of "H" patterns.

To exit this subtest and return to the DISPLAY TEST menu, press Enter.

NOTE: The last row may not be completely filled. This condition does not indicate an error.

Subtest 07 LCD Brightness

The LCD brightness changes in the following order:

Super-Bright -> Bright -> Semi-Bright -> Bright -> Super-Bright

After displaying with Super-Bright of LCD brightness, the screen returns to the DISPLAY TEST menu.

3.10 Floppy Disk Test

CAUTION: Before running the floppy disk test, prepare a formatted work disk. Remove the Diagnostics Disk and insert the work disk into the FDD because the contents of the floppy disk will be erased.

To execute the Floppy Disk Test, select **5** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions displayed on the screen.

1. The following message will appear. Select the media mode and start track to be tested and press **Enter.**

```
Test start track (Enter:0/dd:00-79) ?
```

2. The Floppy Disk test contains five subtests that test the FDD.

The floppy disk test menu will appear after you select FDD test parameters.

FLOPPY DISK XXXXXXX XXX DIAGNOSTIC TEST VX.XX [Ctrl]+[Break]: test end [Ctrl]+[C] : key stop

SUB-TEST : XX

PASS COUNT : XXXXX ERROR COUNT : XXXXX
WRITE DATA : XX READ DATA : XX
ADDRESS : XXXXXX STATUS : XXX

SUB-TEST MENU:

01 - Sequential read

02 - Sequential read/write

03 - Random address/data

04 - Write specified address

05 - Read specified address

99 - Exit to DIAGNOSTIC TEST MENU

↑↓→← : Select items
Enter : Specify
Esc : Exit

Select the number of the subtest you want to execute and press **Enter**. The following message will appear during the floppy disk test.

SUB-TEST : XX

PASS COUNT : XXXXX ERROR COUNT : XXXXX
WRITE DATA : XX READ DATA : XX
ADDRESS : XXXXXX STATUS : XXX

When the subtest 04 or 05 is selected, the following messages will appear on the screen. Select the test data (subtest 04 only), track number and head number you want to test.

```
Test data ?? (subtest 04 only)
Track No. ??
Head No. ?
```

Subtest 01 Sequential read

This subtest performs a Cyclic Redundancy Check (CRC) that continuously reads all the tracks (track: 0 to 39/0 to 79) on a floppy disk.

Subtest 02 Sequential read/write

This subtest continuously writes data pattern B5ADADh to all the tracks (track: 0 to 39/0 to 79) on a floppy disk. The data is then read and compared to the original data.

Subtest 03 Random address/data

This subtest writes random data to random addresses on all tracks (track: 0 to 39/0 to 79) on a floppy disk. The data is then read and compared to the original data.

Subtest 04 Write specified address

This subtest writes the data specified by an operator to a specified track, head, and address.

Subtest 05 Read specified address

This subtest reads data from a track, head, and address specified by an operator.

3.11 Printer Test

CAUTION: Printer Test is not supported for this model.

To execute the Printer Test, select **6** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen.

NOTE: An IBM compatible printer must be connected to the system to execute this test. Also, printer port wraparound connector must be connected.

The following message will appear, after selecting the subtest 01 to 03 of the printer test:

```
channel#1 = XXXXh
  channel#2 = XXXXh
  channel#3 = XXXXh

Select the channel number (1-3) ?
```

The printer I/O port address is specified by the XXXXh number. The computer supports three printer channels. Select the printer channel number, and press **Enter** to execute the selected subtest.

Subtest 01 Ripple Pattern

This subtest prints characters for codes 20h through 7Eh line-by-line while shifting one character to the left at the beginning of each new line.

Subtest 02 Function

This subtest is for IBM compatible printers, and tests the following functions:

Normal print
Double-width print
Compressed print
Emphasized print
Double-strike print
All characters print

This subtest prints the various print types shown below:

```
PRINTER TEST

1. THIS LINE SHOWS NORMAL PRINT.

2. THIS LINE SHOWS DOUBLE-WIDTH PRINT.

3. THIS LINE SHOWS COMPRESSED PRINT.

4. THIS LINE SHOWS EMPHASIZED PRINT.

5. THIS LINE SHOWS DOUBLE-STRIKE PRINT.

6. ALL CHARACTERS PRINT

1."#$$&'()*+,./0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopqrstuvwxyz[\]~
```

Subtest 03 Wraparound

NOTE: To execute this subtest, a printer wraparound connector must be connected to the computer's printer port.

This subtest checks the output and bi-directional modes of the data control and status lines through the parallel port wraparound connector (34M741986G01). (Both output and bi-directional modes are tested.)

3.12 Async Test

CAUTION: Async Test is not supported for this model.

To execute the Async Test, select **7** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions displayed on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtests 01 and 02 require the following data format:

Method: Asynchronous Speed: 38400BPS

Data: 8 bits and one parity bit (EVEN)

Data pattern: 20h to 7Eh

Subtest 01 FIR/SIR Point to point (send)

NOTE: To execute subtests 01 and 02, each computer must have access to the other computer's infrared port.

This subtest sends 20h through 7Eh data to the receive side, then receives the sent data and compares it to the original data through the FIR/SIR port.

Subtest 02 FIR/SIR Point to point (receive)

This subtest is used with subtest 01 described above. This subtest receives the data from the send side, then sends the received data through the FIR/SIR port.

Subtest 03 Wraparound (on board)

NOTE: To execute this subtest, a RS-232C wraparound connector must be connected to the RS-232C port.

This subtest checks the data send/receive function through the wraparound connector.

3.13 Hard Disk Test

To execute the Hard Disk Test, select **8** from the DIAGNOSTIC TEST MENU, press **Enter**, and follow the directions on the screen.

CAUTION: The contents of the hard disk will be erased when subtest 02, 03, 04, 06, 08 or 09 is executed. Before running the test, the customer should transfer the contents of the hard disk to floppy disk or another hard disk. If the customer has not or cannot perform the back-up, create back-up disks as described below.

Check to see if the Microsoft Create System Disks Tools (MSCSD.EXE) still exists in the System Tools Folder. (This tool can be used only once.) If it exists, use it to back up the pre-installed software, then use the Backup utility in the System Tools folder to back up the entire disk, including the user's files.

Refer to the operating system instructions.

1. The following message appears for the error dump operation when a data compare error is detected. Select 1 or 2.

```
Data compare error dump (1:no, 2:yes)
```

2. The following message appears for whether or not the HDD status is displayed on the screen. The HDC status is described in section 3.19. Select **1** or **2**.

```
Detail status display (1:no, 2:yes)
```

3. The Hard Disk Test message will appear after you respond to the Detail Status prompt. Select the number of the subtest you want to execute and press Enter. The following message will appear during each subtest.

The first three digits of the ADDRESS indicate which cylinder is being tested, the fourth digit indicates the head number and the last two digits indicate the sector number.

The first digit of the STATUS indicates the drive being tested and the last two digits indicate the error status code as explained in the table 3-2 of the section 3.18.

Subtest 01 Sequential read

This subtest is a sequential reading of all the tracks on the HDD starting at track 0. When all the tracks on the HDD have been read, the test starts at the maximum track and reads the tracks on the HDD sequentially back to track 0.

Subtest 02 Address uniqueness

This subtest writes unique address data to each sector of the HDD track-by-track. The data written to each sector is then read and compared with the original data. There are three ways the HDD can be read:

- 1. Forward sequential
- 2. Reverse sequential
- 3. Random

Subtest 03 Random address/data

This subtest writes random data in a random length to random addresses. This data is then read and compared to the original data.

Subtest 04 Cross talk & peak shift

This subtest writes eight types of worst pattern data (listed below) to a cylinder and then reads the data while moving from cylinder to cylinder. (Test the data interference in the neighbor track)

Worst pattern data	Cylinder
'B5ADAD'	0 cylinder
'4A5252'	1 cylinder
'EB6DB6'	2 cylinder
'149749'	3 cylinder
'63B63B'	4 cylinder
'9C49C4'	5 cylinder
'2DB6DB'	6 cylinder
'D24974'	7 cylinder

Subtest 05 Partial Read

This subtest reads 1GB data which is in minimum, middle and maximum address of the HDD area.

Subtest 06 Write specified address

This subtest writes specified data to a specified cylinder and head on the HDD.

Subtest 07 Read specified address

This subtest reads data, which has been written to a specified cylinder and head on the HDD.

Subtest 08 Sequential write

This subtest writes specified 2-byte data to all of the cylinders on the HDD.

Subtest 09 W-R-C specified address

This subtest writes data to a specified cylinder and head on the HDD, then reads the data and compares it to the original data.

3.14 Real Timer Test

To execute the Real Timer Test, select **9** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Real time

A new date and time can be input during this subtest. To execute the real time subtest, follow these steps:

1. Select subtest 01 and the following messages will appear:

```
Current date : XX-XX-XXXX
Current time : XX:XX:XX
Enter new date:
PRESS [ENTER] KEY TO EXIT TEST
```

- 2. If the current date is not correct, input the correct date at the "Enter new date" prompt and press **Enter**.
- 3. The date is updated and the following messages will appear:

```
Current date : XX-XX-XXXX
Current time : XX:XX:XX
Enter new time:
PRESS [ENTER] KEY TO EXIT TEST
```

4. If the current time is not correct, input the correct time in 24-hour format. To enter ":", press **Shift +**;. The time is updated.

To exit the test, press **Enter**.

Subtest 02 Backup memory

This subtest checks the following backup memories:

Writes 1-bit of "on" data (01h through 80h) to address 0Eh through 7Fh

Writes 1-bit of "off" data (FEh through 7Fh) to address 0Eh through 7Fh

Writes the data pattern AAh and 55h to the address 0Eh to 7Fh

Then the subtest reads and compares this data with the original data.

Subtest 03 Real time carry

CAUTION: When this subtest is executed, the current date and time are erased.

This subtest checks the real time clock increments. Make sure the date and time are displayed in the following format:

Current date : 12-31-1999 Current time : 23:59:58

The real time increments are automatically executed and the following is displayed:

Current date : 01-01-2000
Current time : 00:00:00

PRESS [Enter] KEY TO EXIT TEST

To exit the test, press **Enter**.

3.15 NDP Test

To execute the NDP test, select **10** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

Subtest 01 NDP

This test checks the following functions of NDP:

- Bus

3.16 Expansion Test

To execute the expansion test, select **11** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

Subtest 01 PCMCIA wraparound

NOTE: PCMCIA wraparound test is not supported for this model.

NOTE: To execute this subtest, the PC card wraparound connector is required.

This subtest checks the following signal line of the PC card slot:

- Data line

- BSY#, BVD1 line

This subtest is executed in the following order:

Sub#	Address	Good	Bad	Contents
01	00001 00001	nn nn	xx xx	Address line REG#, CE#1, CE#2 nn=A0, 90, 80, 00
02	00002	ww	rr	Data line ww=write data, rr=read data
03	00003	_	_	Speaker line
04	00004	40,80	xx	Wait line (40 <xx<80)< td=""></xx<80)<>
05	00005	nn	xx	Other lines (BSY#, BVD1) NN=21, 00

NOTE: When selecting the subtest number01, the following message will appear: Test slot number select (1:slot0, 2:slot1, 0:slot0&1)?

Subtest 02 RGB monitor ID

NOTE: To execute this subtest, an external monitor with monitor ID function is required.

Connect the external monitor to the PC for the test of ID acquisition.

The judgment of acquisition is based on the panel data. In simultaneous display mode or internal display mode, in which the panel data is acquired, this subtest will fail. Therefore, make sure only the external display is selected when executing this subtest.

3.17 CD-ROM/DVD-ROM Test

To execute the CD-ROM/DVD-ROM test, select **13** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

NOTE: For the subtest 01, 02 and 03, use the TOSHIBA CD-ROM TEST DISK TDY-01 or ABEX TEST CD-ROM TCDR-702 and DVD-ROM TEST DISK TSD-1. For the subtest 04, use a CD-RW on the market.

Subtest 01 Sequential read

This subtest is a sequential reading of one-block units (2K bytes) of all the logical addresses.

Subtest 02 Read specified address

This subtest reads one-block data from a specified address.

Subtest 03 Random address/data

This subtest reads one-block data and multi-block data from random addresses 200 times.

Subtest 04 RW 1point W/R/C

This subtest writes, reads and compares data at one point on a CD/RW media.

3.18 Error Code and Error Status Names

Table 3-2 lists the error codes and error status names for the Diagnostic Test.

Table 3-2 Error codes and error status names (1/3)

Device name	Error code	Error status name
(Common)	FF	Data Compare Error
System	01 03 04 05 06 07 08 09 10	ROM - CHECKSUM ERROR ROM - SERIAL ID WRITE ERROR ROM - NOT SUPPORTED PS-SYSTEM ROM - SENSING ERROR(AC-ADAPT) ROM - SENSING ERROR(1st Batt) ROM - SENSING ERROR(2nd Batt) ROM - THORMISTOR ERROR(1) ROM - THORMISTOR ERROR(2) ROM - THORMISTOR ERROR(3)
Memory	01 02 DD	RAM - PARITY ERROR RAM - PROTECTED MODE NO CHANGE' RAM - CACHE MEMORY ERROR
Keyboard	FE FD F0 F1 F2 F3 F4 F5 F6 F7 F8 F9 FA EF ED	USB - GET DESCR.ERROR (FIRST) USB - SET ADDRESS ERROR HUB - GET DESCR.ERROR(Top 8B) HUB - GET DESCR.ERROR (Whole) HUB - SET CONFIGURATION ERROR HUB - GET DESCR.ERROR(DESCR.) HUB - SET FEATURE ERROR(P ON) HUB - GET STATUS ERROR HUB - SET FEATURE ERROR(RESET) HUB - CLEAR FEATURE ERROR HUB - CLEAR FEATURE 1 ERROR HUB - SET FEATURE ERROR(Enab.) HUB - CLEAR FEATURE2 ERROR USB - OVER CURRENT ERROR
Display	EE	VRAM SIZE NOT SUPPORT

Table 3-2 Error codes and error status names (2/3)

Device name	Error code	Error status name
FDD	01 02 03 04 08 09 10 20 40 80 60 06 EE	FDD - BAD COMMAND ERROR FDD - ADDRESS MARK NOT FOUND FDD - WRITE PROTECTED FDD - RECORD NOT FOUND FDD - DMA OVERRUN ERROR FDD - DMA BOUNDARY ERROR FDD - CRC ERROR FDD - FDC ERROR FDD - SEEK ERROR FDD - TIME OUT ERROR FDD - NOT DRIVE ERROR FDD - MEDIA REMOVED FDD - WRITE BUFFER ERROR
Printer	01 08 10 20 40 80	PRT - TIME OUT PRT - FAULT PRT - SELECT LINE PRT - OUT OF PAPER PRT - POWER OFF PRT - BUSY LINE
ASYNC	01 02 04 08 10 20 40 80 88 05 06	RS232C - [DTR ON] TIME OUT RS232C - [CTS ON] TIME OUT RS232C - [RX READY] TIME OUT RS232C - [TX FULL] TIME OUT RS232C - PARITY ERROR RS232C - FRAMING ERROR RS232C - OVERRUN ERROR RS232C - LINE STATUS ERROR RS232C - MODEM STATUS ERROR SIR - TIME OUT ERROR
HDD	05 07 09 0B BB 08 01 02 04 10 20 40 80 11 AA	HDD - HDC NOT RESET ERROR HDD - DRIVE NOT INITIALIZE HDD - DMA BOUNDARY ERROR HDD - BAD TRACK ERROR HDD - UNDEFINED ERROR HDD - OVERRUN ERROR (DRQ ON) HDD - BAD COMMAND ERROR HDD - ADDRESS MARK NOT FOUND HDD - RECORD NOT FOUND ERROR HDD - ECC ERROR HDD - HDC ERROR HDD - SEEK ERROR HDD - TIME OUT ERROR HDD - ECC RECOVER ENABLE HDD - DRIVE NOT READY

Table 3-2 Error codes and error status names (3/3)

Device name	Error code	Error status name
(HDD)	CC E0 0A EE DA 12	HDD - WRITE FAULT HDD - STATUS ERROR HDD - BAD SECTOR HDD - ACCESS TIME ERROR HDD - NO HDD HDD - DMA CRC ERROR
NDP	01 02 03 04 05 06	NDP - NO CO-PROCESSOR NDP - CONTROL WORD ERROR NDP - STATUS WORD ERROR NDP - BUS ERROR NDP - ADDITION ERROR NDP - MULTIPLAY ERROR
EXPANSION	C1 C3 C4 C5 C6 C7 C8 CB CC CE	ADDRESS LINE ERROR CE#1 LINE ERROR CE#2 LINE ERROR DATA LINE ERROR WAIT LINE ERROR BSY# LINE ERROR BVD1 LINE ERROR ZV-Port ERROR NO PCMCIA CARD TYPE ERROR ZV_CONT# ERROR
CD-ROM /DVD-ROM	01 02 03 04 05 06 09 11 20 40 80 90 B0	BAD COMMAND ILLEGAL LENGTH UNIT ATTENTION MEDIA CHANGE REQUEST MEDIA DETECTED ADDITIMAL SENSE BOUNDARY ERROR CORRECTED DATA ERROR DRIVE NOT READY SEEK ERROR TIME OUT RESET ERROR ADDRESS ERROR

3.19 Hard Disk Test Detail Status

When an error occurs in the hard disk test, the following message is displayed:

```
HDC status = XXXXXXXX
```

Detailed information about the hard disk test error is displayed on the screen by an eight-digit number. The first four digits represent the hard disk controller (HDC) error status number and the last four digits are not used.

The hard disk controller error status is composed of two bytes; the first byte displays the contents of the HDC status register in hexadecimal form and the second byte displays the HDC error register.

The contents of the HDC status register and error register are listed in Tables 3-3 and 3-4.

Bit Name Description **BSY** "0" ... HDC is ready. (Busy) "1" ... HDC is busy. DRY 6 "0" ... Hard disk drive is not ready to accept any command. (Drive ready) "1" ... Hard disk drive is ready. **DWF** "0" ... DWF error is not detected. "1" ... Write fault condition occurred. (Drive write fault) DSC 4 "0" ... The hard disk drive heads are not settled over a track. (Drive seek complete) "1" ... The hard disk drive heads are settled over a track. **DRQ** 3 "0" ... Drive is not ready for data transfer. "1" ... Drive is ready for data transfer. (Data request) 2 COR "0" ... Not used (Corrected data) "1" ... Correctable data error is corrected. 1 "0" ... Not used IDX "1" ... Index is sensed. (Index) 0 ERR "0" ... Normal "1" ... The previous command was terminated with an error.

Table 3-3 Hard disk controller status register contents

(Error)

Table 3-4 Error register contents

Bit	Name	Description
7	BBK (Bad block mark)	"0" Not used "1" A bad block mark is detected.
6	UNC (Uncorrectable)	"0" There is no uncorrectable data error. "1" Uncorrectable data error has been detected.
5		Not used
4	IDN (Identification)	"0" Not used "1" There is no ID field in the requested sector.
3		Not used
2	ABT (Abort)	"0" Not used "1" Illegal command error or command abort.
1	TK0 (Track 0)	"0" The hard disk found track 0 during a recalibrate command.
		"1" The hard disk could not find track 0 during a recalibrate command.
0		Not used

3.20 ONLY ONE TEST

3.20.1 Program Description

This program tests the unique functions of this model.

3.20.2 Operations

Select test **2** from the DIAGNOSTIC MENU and press **Enter**. The following menu appears in the display.

```
ONLY ONE TEST Menu (XXXXXXXXX)
#######
#######
*
                                 *
*
  1 ..... Pressed Key Display
  2 ..... Touch Pad
  3 ..... GP Button
  4 ..... Kill Switch
  5 ..... USB
  6 ..... Touch Pad ( Scroll Button )
  7 ..... LED
  8 ..... Remocon ( Sound, onsei/onta )
  9 ..... Common Test
.... Press test number[1-8, 9] ?
```

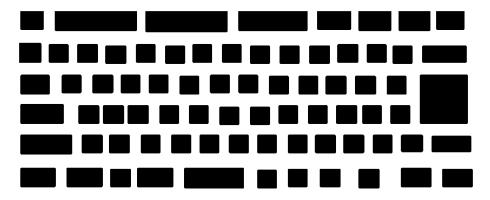
Select the subtest number you want to test and press **Enter**.

To return to the DIAGNOSTIC TEST menu, select **9** and press **Enter**.

Subtest 01 Pressed key display

When you execute this subtest, the keyboard layout is drawn on the display as shown below. When any key is pressed, the corresponding key on the screen changes to the key character that was pressed. Holding a key down enables the auto-repeat function which causes the key's display character to blink.

Press **Del + Enter** to end the test.



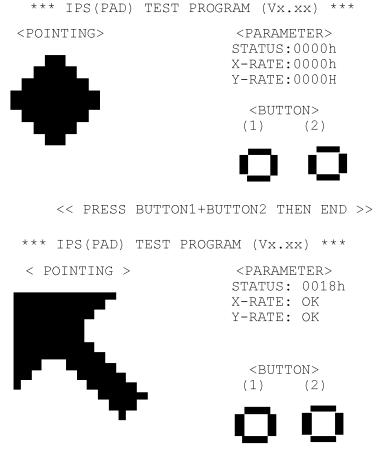
IF TEST OK, Press [Dell][Enter]key

Subtest 02 Touch Pad

This subtest checks the functions of the touch pad as shown below.

- A) Direction and parameter
- B) Switching function check.

This test displays the response from the touch pad and touch pad switch. When moving your finger on the touch pad towards the upper left, the <POINTING> display changes according to the following illustration. If a touch pad switch is pressed, the <BUTTONS> displays appear on the right side one by one. The parameters appear above the <BUTTONS> (1) or (2) corresponding to the pressed touch pad switch highlights. To end this subtest, press two touch pad switches at the same time.



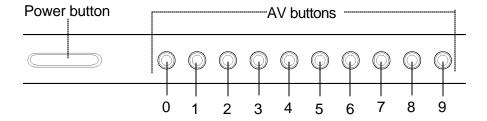
<< PRESS BUTTON1+BUTTON2 THEN END >>

Subtest 03 GP Button

This subtest checks if the AV buttons (10 buttons) work properly.

The following message appears in the display.

Press the AV button from the left (the AV button nearest to power button). The name of AV buttons in the message is described as number (0-9) from the left side. (Refer to the following picture.)



Press the AV button [0], and then the following message will appear in the display.

As the same way, press the specified AV button and carry on the AV button test.

If wrong key is pressed, following message will appear in the display.

When any key is pressed, message for pressing an AV button will appear in the display again. Unless the right AV button is pressed, this operation is repeated.

After checking all AV buttons, the screen returns to the ONLY ONE TEST menu automatically.

Subtest 04 Kill Switch

This subtest checks if the Wireless communication switch works properly.

If the test is started with the switch ON, the following message appears in the display.

Kill switch is set to a start position (OFF)

Slide the switch to OFF position. Then, the following message appears in the display.

```
KILL SWITCH ON !!
```

Slide the switch to ON position. Then, the following message appears in the display.

```
KILL SWITCH OFF !!
```

After Sliding the switch to OFF position, the screen returns to the ONLY ONE TEST menu automatically.

Subtest 05 USB

NOTE: When executing this subtest, USB test module and USB cable must be connected.

This subtest checks if USB ports work properly.

The following menu appears in the display.

Connect the USB test module and USB cable to the computer.

Input the test port number and press **Enter**.

OK message appears in the display if the test ends without a fail.

NG message appears in the display if an error is found during the test. Confirm the connection of cable, and then execute the test again.

Press **9** and **Enter** to return to ONLY ONE TESST menu.

Subtest 06 Touch Pad (Scroll Button)

This subtest checks if the scroll button of touch pad works properly.

The following message appears in the display.

```
****** Scroll button TEST (VX.XX) ******

Press Scroll button

Up Button xxx

Down Button xxx

Press [ESC] key to EXIT
```

Check the message "xxx" changes to ON while pressing UP or DOWN button of scroll button and changes to OFF when releasing the buttons.

Press **ESC** and return to ONLY ONE TESST menu.

Subtest 07 LED

This subtest checks if each LED lights properly.

The following message appears in the display in order. Follow the instructions in the display to execute the test.

```
[HDD Access LED test]
```

Confirm the LED of HDD status blinks properly.

Press any key and following message appears in the display.

```
[Caps/Num/Overlay BT/W-LAN LED test]
(1) Press [Caps Lock ] key ! ...Caps (on/off)
(2) Press [Fn + F10 ] key ! ...Arrow (on/off)
(3) Press [Fn + F11 ] key ! ...Num (on/off)
(4) Slide [BT/W-LAN switch L&R]! (on/off)
```

Confirm corresponding LED lights properly.

Press **Enter** and following message appears in the display.

```
Check [PowerSW-LED] = Green
```

Check if the Power Switch LED lights in the following order.

```
(Green -> Orange -> Blue -> OFF)
```

Press any key and the following message appears in the display.

```
Check [DC-IN]&[Power]&[Main Battery]LED= Green/Orange
```

Check if the each LED lights in the same color shown in the display (Message switches Green <-> Orange).

Press **Enter** to return to the ONLY ONE TEST menu.

Subtest 08 Remocon (Sound, onsei/onta)

This subtest checks if AUDIO button of supplied remote controller works properly.

The following message appears in the display.

```
Press [Sound, Onta/Onsei] button !
```

Press AUDIO button of the remote controller and return to the ONLY ONE TEST menu.

3.21 Head Cleaning

3.21.1 Function Description

This function cleans the heads in the FDD by executing a series of head load/seek and read operations. A cleaning kit is necessary to perform this program.

3.21.2 Operations

1. Selecting test **4** from the DIAGNOSTIC MENU and pressing **Enter** displays the following messages:

```
DIAGNOSTICS - FLOPPY DISK HEAD CLEANING : VX.XX Mount cleaning disk(s) on drive(s).

Press any key when ready.
```

- 2. Remove the Diagnostics Disk from the FDD, then insert the cleaning disk and press **Enter**.
- 3. When the "cleaning start" message appears, the FDD head cleaning has begun.
- 4. The display automatically returns to the DIAGNOSTIC MENU when the program is completed.

3.22 Log Utilities

3.22.1 Function Description

This function logs error information generated while a test is in progress and stores the results in RAM. This function can store data on a floppy disk, or output the data to a printer or the display.

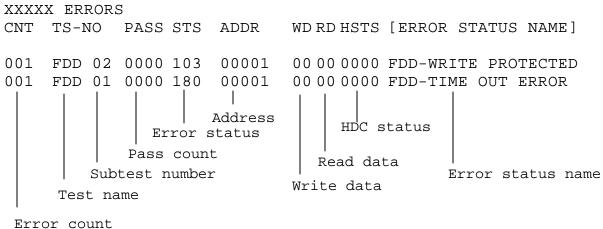
The error information is displayed in the following order:

- 1. Error count (CNT)
- 2. Test name, Subtest number (TS-No)
- 3. Pass count (PASS)
- 4. Error status (STS)
- 5. FDD/HDD or memory address (ADDR)
- 6. Write data (WD)
- 7. Read data (RD)
- 8. HDC status (HSTS)
- 9. Error status name (ERROR STATUS NAME)

If the power switch is turned off, the error information will be lost.

3.22.2 Operations

1. Select **5** and press **Enter** in the DIAGNOSTIC MENU, the error information is displayed in the following format:



Ellor Count

[[1:Next,2:Prev,3:Exit,4:Clear,5:Print,6:FD Log Read,7:FD Log Write]]

- 2. The error information displayed on the screen can be manipulated by the following number keys:
 - The **1** key scrolls the display to the next page.
 - The **2** key scrolls the display to the previous page.
 - The **3** key returns to the Diagnostic Menu.
 - The **4** key erases all error log information in RAM.
 - The **5** key outputs the error log information to a printer.
 - The **6** key reads the log information from a floppy disk.
 - The **7** key writes the log information to a floppy disk.
- 3. In the case of "error retry OK," a capital "R" will be placed at the beginning of the error status. However, it is not added to the error count.

3.23 Running Test

3.23.1 Function Description

This function automatically executes the following tests in sequence:

- 1. System test (subtest 01)
- 2. Memory test (subtests 01, 02, 06)
- 3. Display test (subtest 01)
- 4. Real timer test (subtest 02)
- 5. HDD test (subtests 01)

The system automatically detects the number of floppy disk drives connected to the computer for the FDD test.

3.23.2 Operations

1. Select **6** from the Diagnostic Menu and press **Enter**, the following messages for selectable tests will appear in the display in order.

```
FDD write/read test (Y/N) ?
Printer wrap around test (Y/N) ?
Serial wrap around test (Y/N) ?
CD-ROM/DVD-ROM test (Y/N) ?
```

- 2. To execute the test, press **Y** and **Enter**. To cancel the test, press **N** and **Enter**. If you select the selectable tests, follow the instruction message in the display.
- 3. After selecting the selectable tests, the running test starts automatically. To terminate the program, press **Ctrl + Break**.

3.24 Floppy Disk Drive Utilities

3.24.1 Function Description

This function formats the FDD, copies the floppy disk and displays the dump list for both the FDD and HDD.

1. FORMAT

NOTE: This program is only for testing a floppy disk drive. It is different from the Toshiba MS-DOS FORMAT command.

This program can format a floppy disk in the following formats:

- (a) 2DD: Double-sided, double-density, double-track, 96/135 TPI, MFM mode, 512 bytes, 9 sectors/track.
- (b) 2HD: Double-sided, high-density, double-track, 96/135 TPI, MFM mode, 512 bytes, 18 sectors/track.

2. COPY

This program copies data from a source floppy disk to a target floppy disk.

3. DUMP

This program displays the contents of the floppy disk and the designated sectors of the hard disk on the display.

4. HDD ID READ

This program reads the hard disk ID and displays hard disk information.

3.24.2 Operations

1. Selecting **7** from the DIAGNOSTIC MENU and pressing **Enter** displays the following message:

```
[ FDD UTILITIES ]

1 - FORMAT

2 - COPY

3 - DUMP

4 - HDD-ID READ

9 - EXIT TO DIAGNOSTICS MENU
```

- 2. FORMAT program
 - (a) Selecting FORMAT displays the following message:

```
DIAGNOSTICS - FLOPPY DISK FORMAT : VX.XX Drive number select (1:A, 2:B) ?
```

(b) Select a drive number to display the following message:

```
Type select (0:2DD, 3:2HD) ?
```

(c) Select a media/drive type number and press **Enter**. A message similar to the one below will be displayed:

```
Warning: Disk data will be destroyed. Insert work disk into drive A: Press any key when ready.
```

(d) Remove the Diagnostics Disk from the FDD, insert the work disk and press any key.

The following message will be displayed when the FDD format is executed:

After the floppy disk is formatted, the following message will appear:

```
Format complete
Another format (1:Yes/2:No) ?
```

(e) Typing **1** displays the message from step (c) above. Typing **2** returns the test to the DIAGNOSTIC MENU.

3. COPY program

(a) When COPY is selected, the following message appears:

```
FLOPPY DISK FORMAT & COPY : VX.XX Type select (0:2DD,3:2HD) ?
```

(b) Selecting a media/drive type number will display a message similar to the one below:

```
Insert source disk into drive A: Press any key when ready.
```

(c) Remove the Diagnostics Disk from the FDD, insert the source disk and press any key. The following message will appear, indicating the program has started.

(d) The following message will appear.

```
Insert target disk into drive A: Press any key when ready.
```

(e) Remove the source disk from the FDD, then insert a formatted work disk and press any key. The following message will appear and start copying to the target disk.

```
[[ track,head = XXX X ]]
```

(f) When the amount of data is too large to be copied in one operation, the message from step (b) is displayed again. After the floppy disk has been copied, the following message will appear:

```
Copy complete
Another copy (1:Yes/2:No) ?
```

(g) To copy another disk, type **1** and the message from step (a) is displayed again. Entering **2** returns the test program to the DIAGNOSTIC MENU.

4. DUMP program

(a) When DUMP is selected, the following message appears:

```
DIAGNOSTICS-HARD DISK & FLOPPY DISK DUMP : VX.XX Drive type select (1:FDD, 2:HDD) ?
```

(b) Select a drive type. If 2:HDD is selected, the display will go to step (h). If 1:FDD is selected, the following message will appear:

```
Select drive number (1:A, 2:B) ?
```

(c) Select a drive number and the following message will be displayed.

```
Format type select (1:2DD, 3:2HD) ?
```

(d) If 3:2HD is selected, the following message will appear. Select a media mode.

```
2HD media mode (1:1.20MB, 2:1.44MB, 3:1.23MB)?
```

(e) The following message will appear:

```
Insert source disk into drive A: Press any key when ready.
```

(f) Insert a source disk and press any key and the following message will appear:

```
Max. address —
[Track ] = XXXX
[Head ] = XX
[Sector] = XX
Track number ????
```

- (g) Set the track number, head number and sector number you want to dump. The system will access the disk and dump a list. Then the message shown in (k) will appear.
- (h) The following message will appear when selecting 2: HDD in (a).

```
Select drive number (1:C, 2:D) ?
```

(i) Select a drive number and the following message will be displayed.

```
---Max. address ---
[LBA ] = XXXXXXXXX

LBA number ???????
```

(j) Set the LBA number you want to dump. The system will access the disk and dump a list.

(k) The following message will appear. To finish the dump, select **3**.

```
Press number key (1:up,2:down,3:end) ?
```

(l) The following message will appear. Selecting **2** returns to the FDD UTILITIES MENU.

```
Another dump (1:Yes,2:No) ?
```

5. HDD ID READ program

Selecting HDD ID displays the following HDD ID configuration:

Press **Enter** to return to the FDD UTILITIES MENU.

3.25 System Configuration

3.25.1 Function Description

NOTE: To display the system configuration, the write protect tab should be OFF position. If the tab is ON position, move the tab to OFF position and restart the test. Otherwise the correct information cannot be acquired.

The System Configuration program contains the following configuration information for the computer:

- 1. Processor Type [Code/L2 cache]
- 2. Chip set [VRAM]
- 3. BIOS ROM version [1st ID, 2nd ID]
- 4. Boot ROM version
- 5. EC total version
- 6. PS Microprocessor version
- 7. SVP parameter version [Panel/Manufacture code/Product code]
- 8. Micro code revision [Processor number]
- 9. Total Memory Size [Conventional memory]
- 10. Battery code
- 11. HWSC
- 12. FSB [Voltage]
- 13. The number of printer ports
- 14. The number of ASYNC ports
- 15. Math co-processors
- 16. Floppy Disk Drive [Track/Head/Sector]
- 17. Hard Disk Drive [Sector/Drive size/Manufacture code]
- 18. Optical Disk Drive [Maker/Drive type/Manufacture code/Product code]
- 19. T&D total version
- 20. Date/Time

3.25.2 Operations

Select **8** from the DIAGNOSTIC MENU and press **Enter.** Then, the following system configuration appears in the display.

```
System Configuration Display: Ver X.XX [Machine Name ???]
* - Processor Type
                      = XXXXXX-XXXXMHz
                                                          L2 Cache = XXXXXKB
                                             Code = XX
* - Chip set
                      = XXXXXX
                                             VRAM = XXXXMB
* - BIOS-ROM Version = VX.XX 1st ID = XXH, 2nd ID = XXH
* - BOOT-ROM Version = VX.XX
* - EC Total Version = VX.XX
  - PS Micon Version = VX.XX
  - SVP Par. Version = VX.XX (Panel=XXXXXXXXX, Manu=XXXX, Prod=XXXX)
  - Micro code Revision = VX.XX (Processor=XXXh)
* - Total Memory Size = XXXXXXMB (Conventional Memory = XXXKB)
* - Battery Code = XXXXXXXXXXX
* - HWSC
                      = XXXXXXX
* - FSB
                      = XXXXXMHz (Voltage = XEh)
* - X Printer Adapter LPT1 = XXXX LPT2 = XXXX LPT3 = XXXX  
* - X ASYNC Adapter COM1 = XXXX COM2 = XXXX COM3 = XXXX
* - X Math CO-Processor
* - X Floppy Disk Drive(s) Track = XX Head = XX, Sector = XX
* - X Hard Disk Drive(s) #1 Sectors = XXXXX, (XXXXX GB) [XXXXXXXXXXXXXXXX]
                             #2 Sectors = XXXXX, (XXXXX GB) [XXXXXXXXXXXXXXX]
                      = XXXX XXXXXXXX XXXXXXXXX [XXXXXXXXXX]
* - ODD
* - T&D Total Version = VX.XX
Press [Enter] Key
                     [Date = XXXX-YY-ZZ, XX:YY:ZZ]
```

Press **Enter** to return to the DIAGNOSTIC MENU.

3.26 Wireless LAN Test Program (Intel-made b/g)

This section describes how to perform the wireless LAN transmitting-receiving test (Intel-made Calexico 802.11b/g). To execute the wireless LAN test, use the Diagnostics disk for wireless LAN test. Finish the tests of the Main test program by selecting 99 - EXIT TO DIAGNOSTICS MENU in the DIAGNOSTIC TEST MENU. Then in the DIAGNOSTICS MENU, select 9 - EXIT TO MS-DOS.

Insert the Diagnostics disk for wireless LAN test into the Floppy Disk Drive. Turn on the power while pressing **U**.

The following menu appears in the display.

To execute the subtest, input the subtest number and press **Enter**.

Subtest01 SKU check of module

This subtest displays SKU information on the wireless LAN card installed. When selecting this subtest, following message will appear in the display. Confirm if the right information on the wireless LAN card is described.

If a defective is found during the test, NG message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Using a wrong wireless LAN card (Using unspecified card)
- ? Defective wireless LAN card

Check the connection and execute the subtest again.

Subtest02 MAC Address Check

This subtest displays the MAC address. When selecting this subtest, following message will appear in the display.

Press any key to return to the test menu.

If a defective is found during the test, following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad of wireless LAN card
- ? Defective wireless LAN card
- ? Disappearance of MAC address data

Check the connection and execute the subtest again.

Subtest03 Antenna check & communication test of 11b mode

Caution: To execute subtest 03-05, use another computer (with Calexico wireless LAN card) that can communicate by the wireless LAN as a responder machine.

Access points are also required. (Access point for 802.11b and 802.11g)

Be sure to turn the wireless communication switch ON before executing wireless LAN communication test. (The wireless communication LED lights orange.)

Release the write-protection of floppy disk for the test.

Turn on the responder machine before selecting subtest 03-05.

Setting the responder machine

Connect the responder machine to the access points (for 802.11b and 802.11g) with a cross cable and turn on the access points.

Insert the floppy disk containing the wireless LAN test program into the FDD of the responder machine and turn on the responder machine.

This subtest checks the connection and communication of wireless LAN antenna of Calexico 802.11b mode.

After finishing the test, **OK** message will appear in the display. Press any key to return to the test menu.

When a defective is found during the test, **NG** message will appear in the display. Press any key and following message will appear in the display. Check which antenna (Main/Aux) is defective.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Bad connection of wireless LAN antenna cable (Main/Aux)
- ? Bad environment for wireless LAN communication (Interference/ obstruction)

? Defective wireless LAN card

Check the connection and condition, and execute the subtest again.

Subtest04 Communication test of 11g mode

This subtest checks the communication of wireless LAN antenna of Calexico 802.11g mode.

After finishing the test, **OK** message will appear in the display. Press any key to return to the test menu.

When a defective is found during the test, **NG** message will appear in the display. Press any key and following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Bad connection of wireless LAN antenna cable (Main)
- ? Bad environment for wireless LAN communication (Interference/ obstruction)
- ? Defective wireless LAN card

Check the connection and condition, and execute the subtest again.

Subtest05 All the tests of Calexico 11b/g Card

This subtest checks SKU information, MAC address, connection and communication of wireless LAN antenna of Calexico 802.11b/g card. The test stops at when a defective is found. For more details, refer to each subtest.

3.27 Wireless LAN Test Program (Intel-made a/b/g)

This section describes how to perform the wireless LAN transmitting-receiving test (Intel-made Calexico 802.11a/b/g). To execute the wireless LAN test, use the Diagnostics disk for wireless LAN test. Finish the tests of the Main test program by selecting 99 - EXIT TO DIAGNOSTICS MENU in the DIAGNOSTIC TEST MENU. Then in the DIAGNOSTICS MENU, select 9 - EXIT TO MS-DOS.

Insert the Diagnostics disk for wireless LAN test into the Floppy Disk Drive. Turn on the power while pressing **U**.

The following menu appears in the display.

To execute the subtest, input the subtest number and press **Enter**.

Subtest01 SKU check of module

This subtest displays SKU information on the wireless LAN card installed. When selecting this subtest, following message will appear in the display. Confirm if the right information on the wireless LAN card is described.

Press any key to return to the test menu.

If a defective is found during the test, **NG** message will appear in the display.

Press any key and following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Using a wrong wireless LAN card (Using unspecified card)
- ? Defective wireless LAN card

Check the connection and execute the subtest again.

Subtest02 MAC Address Check

This subtest displays the MAC address. When selecting this subtest, following message will appear in the display.

Press any key to return to the test menu.

If a defective is found during the test, following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Defective wireless LAN card
- ? Disappearance of MAC address data

Check the connection and execute the subtest again.

Subtest03 Antenna check & communication test of 11b mode

Caution: To execute subtest 03-06, use another computer (with Calexico wireless LAN card) that can communicate by the wireless LAN as a responder machine.

Access points are also required. (Access point for 802.11a, 802.11b and 802.11g)

Be sure to turn the wireless communication switch ON before executing wireless LAN communication test. (The wireless communication LED lights orange.)

Release the write-protection of floppy disk for the test.

Turn on the responder machine before selecting subtest 03-05.

Setting the responder machine

Connect the responder machine to the access points (for 802.11a, 802.11b and 802.11g) with a cross cable and turn on the access points.

Insert the floppy disk containing the wireless LAN test program into the FDD of the responder machine and turn on the responder machine.

This subtest checks the connection and communication of wireless LAN antenna of Calexico 802.11b mode.

After finishing the test, **OK** message will appear in the display. Press any key and return to the test menu.

When a defective is found during the test, **NG** message will appear in the display. Press any key and following message will appear in the display. Check which antenna (Main/Aux) is defective.

* *************************

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Bad connection of wireless LAN antenna cable (Main/Aux)
- ? Bad environment for wireless LAN communication (Interference/ obstruction)
- ? Defective wireless LAN card

Check the connection and condition, and execute the subtest again.

Subtest04 Communication test of 11a mode

This subtest checks the communication of wireless LAN antenna of Calexico 802.11a mode.

After finishing the test, **OK** message will appear in the display. Press any key to return to the test menu.

When a defective is found during the test, **NG** message will appear in the display. Press any key and following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Bad connection of wireless LAN antenna cable (Main)
- ? Bad environment for wireless LAN communication (Interference/ obstruction)
- ? Defective wireless LAN card

Check the connection and condition, and execute the subtest again.

Subtest05 Communication test of 11g mode

This subtest checks the communication of wireless LAN antenna of Calexico 802.11g mode.

For more details on procedure and contents of this subtest, refer to Subtest04 Communication test of 11a mode.

Subtest06 All the tests of Calexico 11a/b/g Card

This subtest checks SKU information, MAC address of Calexico 802.11a/b/g card, antenna connection and communication test of Calexico 802.11b card and communication test of Calexico 802.11a and Calexico 802.11g. The test stops at when a defective is found. For more details, refer to each subtest.

3.28 Wireless LAN Test Program (Askey-made)

This section describes how to perform the wireless LAN transmitting-receiving test (Askey-made Atheros b/g, a/b/g).

Caution: To execute subtest 03-07, use another computer (with Atheros wireless LAN card) that can communicate by the wireless LAN as a responder machine to perform those tests.

Another wireless communication tool with 2.4GHz like Bluetooth is interfering with the test. Execute this test in the condition with no interference around the computer.

Be sure to turn the wireless communication switch ON before executing wireless LAN communication test. (The wireless communication LED lights orange.)

Release the write-protection of floppy disk for the test.

Setting the responder machine

To execute subtest 03-07, responder machine with wireless LAN communication function (Atheros-made) is required. To set the responder machine, follow the procedures below.

- 1. Insert the test program disk to the FDD of responder machine and turn on the power.
- 2. The program for responder machine starts automatically.
- 3. The program for responder machine is set.

Setting the tester (DUT) machine

- 1. Insert the test program disk 1 for DUT to the FDD of tester machine and turn on the power.
- 2. The program disk 1 is executed and following message will appear in the display.

3. Take out the program disk 1 and insert program disk 2. Then, press **S** and **Enter**.

4. When the program disk 2 starts, following menu will appear in the display. To execute the subtest, press test number and **Enter**.

Subtest01 SKU check of module

This subtest displays SKU information on the wireless LAN card installed. When selecting this subtest, following message will appear in the display. Confirm if the right information on the wireless LAN card is described.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Using a wrong wireless LAN card (Using unspecified card)
- ? Defective wireless LAN card

Check the connection and execute the subtest again.

Subtest02 MAC Address Check

This subtest reads out the MAC address of the card installed and confirms if it is valid. When the MAC address is valid one, following message will appear in the display.

Press any key to return to the test menu.

When a defective is detected in the test, following typical cause is considered.

- ? Connection of wireless LAN card
- ? Defective wireless LAN card
- ? Disappearance of MAC address data

Check the connection and execute the subtest again.

Subtest03 Communication test of 11a mode (MB44ag)

This subtest checks the connection and communication of wireless LAN antenna of Atheros 802.11a mode. Check the number of packets, throughput and RSSI and compare them with the standard.

After finishing the test, **OK** message will appear in the display. Press any key to return to the test menu.

When a defective is found during the test, **NG** message will appear in the display. Press any key and following message will appear in the display.

Press any key to return to the test menu.

When a defective is found, open the log file (log.txt) and check the result.

Moreover, following typical cause is considered.

- ? Bad connection of wireless LAN card
- ? Bad connection of wireless LAN antenna cable (Main/Aux)
- ? Environment for wireless LAN communication (Interference/ obstruction)
- ? Defective wireless LAN card

Check the connection and condition, and execute the subtest again.

Subtest04 Communication test of 11b mode (MB44ag/MB43g)

This subtest checks the connection and communication of wireless LAN antenna of Atheros 802.11b mode.

For more details on the contents, refer to subtest 03.

Subtest05 Communication test of 11g mode (MB44ag/MB43g)

This subtest checks the connection and communication of wireless LAN antenna of Atheros 802.11g mode.

For more details on the contents, refer to subtest 03.

Subtest06 All the tests of MB43g Module

This subtest checks SKU information, MAC address, connection and communication of wireless LAN antenna of Atheros 802.11b mode and Atheros 802.11g mode. The test stops at when a defective is found. For more details, refer to each subtest.

Subtest07 All the tests of MB44ag Module

This subtest checks SKU information, MAC address, connection and communication of wireless LAN antenna of Atheros 802.11a mode, Atheros 802.11b mode and Atheros 802.11g mode. The test stops at when a defective is found. For more details, refer to each subtest.

3.29 LAN/Modem/Bluetooth/IEEE1394 Test Program

This section describes how to perform the LAN/Modem/Bluetooth/IEEE1394 test with the test program.

Insert the test program disk for LAN/Modem/Bluetooth/IEEE1394 test in FDD and turn on the power. The following message will appear:

Microsoft Windows XX Startup Menu

- 1. LAN
- 2. Modem
- 3. Bluetooth
- 4. IEEE1394

Enter a choice:

Press the number you want to test and press **Enter**.

NOTE: It is impossible to go back to startup menu once you choose the test. Therefore, LAN/Modem/Bluetooth/IEEE1394 test can not be executed successively.

3.29.1 LAN test

To execute LAN test, press 1 and **Enter**. The following message will appear:

Press the number you want to test and press **Enter**.

Subtest01 (i82562 + ICHx)

This subtest checks the operation of mini-PCI I/F by the loopback test in the chip.

The following message will appear:

```
[LAN transmit & receive test !]

COMPLETED Repeat count = 00000
Error count = 00000

LOOPBACK TEST

100Mbps Auto-negotiation TxRx Test
Destination Address = xxxxxxxxxxx

Source Address = xxxxxxxxxxx

** 100Base-TX Full-Duplex **

< TRANSMIT >

< RECEIVE >
```



NOTE: The menu displayed on your computer may be slightly different from the one shown above.

If a defective is found, **NG** message will appear in the display.

Subtest02 (GbE)

CAUTION: Gigabit Ethernet (GbE) test is not supported for this model.

This subtest checks the operation of mini-PCI I/F by the loopback test in the chip. Select **2** to execute and press **Enter**.

The following message will appear:

```
Testing adaptor...hit <ESC> to abort.

*
External Loopback Test...PASSED
Testing completed.

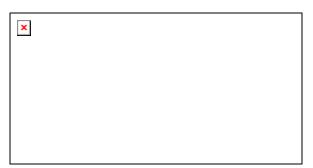
*
*
Loopback Test Complete

*

*
*
1000Base Auto-negotiation TxRx Test

*

* CE Test Complete
```



NOTE: The menu displayed on your computer may be slightly different from the one shown above.

If a defective is found, **NG** message will appear in the display.

3.29.2 Modem test

For this subtest, connect the modem PCB and RJ11 connector with a harness. Use the dedicated "FAT-MODE inspection device (product code: QE2000P01 made by Nitto Electric Manufacture Co.,Ltd)" for the tests.

To execute Modem test, press **2** and **Enter**. Following message will appear:

```
[Modem loopback test !]
ICHx MDC Test Program with Modem Sound (Line Test)
Version X.X
* Scorpio Modem Initialize :OK
* Digital Loopback Test :OK
* RJ11 Connector Check (LED) :(Operator's Check!!)
```

NOTE: The menu displayed on your computer may be slightly different from the one shown above.

RJ11 Connection Check (LED) (Operator's Check LED) test will be executed, and the following message will appear:

```
...Press Key (Y = OK , N = NG)
```

If the color of the LED of the connection checker is orange, press **Y**. Otherwise, press **N**.

3.29.3 Bluetooth test

CAUTION: Bluetooth test is not supported for this model.

To execute this test, input **3** and press **Enter**.

Note: Use another computer that can communicate by the Bluetooth as a reference machine to perform this test.

Insert a floppy disk containing the test program into the target machine and turn on the target machine. The following Bluetooth test menu will appear:

Press **1** or **3** key to perform the corresponding subtest. To quit the Bluetooth test program, eject the floppy disk and turn the computer off while the menu above is displayed.

Subtest01 BD_ADDR check

This subtest checks the BD_ADDR functions. When the Bluetooth test menu is displayed, press **1** to select the test and press **Enter**. The following message will appear:

```
Bluetooth Subsystem T&D for PCSE(BD_ADDR) VerX.XX Copyright (C) by TOSHIBA Co.

-
Initializing ...
```

When the machine has passed the test, it displays BD_ADDR. If BD_ADDR has no problem, the following message is displayed.

If the target machine has any problem, it displays Error message. The following message is displayed.

```
Bluetooth Subsystem T&D for PCSE(BD_ADDR) VerX.XX Copyright (C) by TOSHIBA
Co.

My BD_ADDR = XXXXXXXXXXX [h]

FFFFFF A III L
F A A I L
F F A A I L
FFFFFF A A I L
FFFFFF A A I L
F AAAAAAA I L
F AAAAAAAA I L
F A A I L
F A A I L
F A A I L
F A A I L
F A A I L
F A A I L
F A A I L
F A A I L
```

Table 3-5 Error message

Message	Contents
Invalid BD_ADDR (all 00)	0x00000000000
Invalid BD_ADDR (all FF)	0xFFFFFFFFFF
Invalid BD_ADDR (bit0=1)	bit40=1b
Invalid BD_ADDR (bit1=1)	bit41=1b
Invalid BD_ADDR (define in the file)	Defined BD_ADDR

If the machine detects a malfunction, it indicates the error code as shown below.

The error code begins with the least significant digit.

Error code

Table 3-6 Error code for Bluetooth test (BD_ADDR) (1/2)

Error code	Meaning
0x01	Unknown HCI Command.
0x02	No Connection.
0x03	Hardware Failure.
0x04	Page Timeout.
0x05	Authentication Failure.
0x06	Key Missing.
0x07	Memory Full.
0x08	Connection Timeout.
0x09	Max Number Of Connections.
0x0a	Max Number Of SCO Connections To A Device.
0x0b	ACL Connection already exists.
0x0c	Command Disallowed.
0x0d	Host Rejected due to limited resources.
0x0e	Host Rejected due to security reasons.
0x0f	Host Rejected due to remote device is only a personal device.
0x10	Host Timeout.
0x11	Unsupported Feature or Parameter Value.
0x12	Invalid HCI Command Parameters.
0x13	Other End Terminated Connection: Used Ended Connection.
0x14	Other End Terminated Connection: Low Resources.
0x15	Other End Terminated Connection: About to Power Off.
0x16	Connection Terminated by Local Host.
0x17	Repeated Attempts.
0x18	Paring Not Allowed.
0x19	Unknown LMP PDU.
0x1a	Unsupported Remote Feature.
0x1b	SCO Offset Rejected.
0x1c	SCO Interval Rejected.
0x1d	SCO Air Mode Rejected.
0x1e	Invalid LMP Parameters.
0x1f	Unspecified Error.

^{**} See the Specification of the Bluetooth System for details.

Error code Meaning 0x20 Unsupported LMP Parameter Value. 0x21 Role Change Not Allowed. 0x22 LMP Response Timeout. 0x23 LMP Error Transaction Collision. 0x24 LMP PDU Not Allowed. 0x25 Not Exist 0x26 Not Exist 0x27 Not Exist 0x28 Not Exist 0x29 Not Exist 0x2a Not Exist 0x2b Not Exist 0x2c Not Exist 0x2d Not Exist 0x2e Not Exist Not Exist 0x2f

Table 3-6 Error code for Bluetooth test (BD_ADDR) (2/2)

Subtest03 Communication test (DUT mode)

Subtest T Communication test (TEST mode)

This subtest checks the Bluetooth communication functions. Set the responder machine to DUT mode and tester machine to TEST mode.

Insert a floppy disk containing the test program into the responder machine and turn on the power. The Bluetooth test menu will appear.

Press **3** to select the test and press **Enter** of the responder machine. The following message will appear:

When the test begins, the machine displays BD_ADDR of the DUT. The progress bar appears when the preparation is completed. The following message is displayed.

^{**} See the Specification of the Bluetooth System in detail.

Insert a floppy disk containing the test program into the tester machine and turn on the power. When the Bluetooth test menu is displayed on the tester machine, press **T** and **Enter** to select the subtest. The following message will appear:

Then press **Space** to start the Bluetooth communication test.

When the communication test has been completed without fail, the DUT machine displays BD_ADDR. If the connection with the tester is completed, the progress bar stops. The following message is shown.

```
Bluetooth Subsystem T&D for PCSE(CS-Air) VerX.XX Copyright (C) by TOSHIBA
______
  DUT | BD_ADDR of the DUT = XXXXXXXXXXXXX [h]
             M PPPPPP L EEEEEE TTTTTTT EEEEEEE DDDDD
  CCCC 000 M
                       E T E
  C C O O MM MM P P L
                       E T E D D
        OMMMMPPL
     0
        O M M M PPPPPP L EEEEEE T EEEEEEE D
             M P L
     0
                       E T E D
        O M
                  L E T E D D
 C C O O M M P
  CCCC OOO M M P LLLLLL EEEEEE T EEEEEE DDDDD
                 Testing is finished
A>_
```

If the DUT machine has any problem or **S** of the DUT machine is pressed before connection to tester machine, the following message "INCOMPLETE" is displayed.

```
______
Bluetooth Subsystem T&D for PCSE(CS-Air) VerX.XX Copyright (C) by TOSHIBA
______
+----+
    DUT | BD_ADDR of the DUT = XXXXXXXXXXXXX [h]
+----+
                 M PPPPPP L EEEEEE TTTTTTT EEEEEEE
III N
    N CCCC 000 M
     N C C O O MM MM P P L
                          E T E
I NN NC
          O OMMMMP PL
             O M M M PPPPPP L
I N N N C
          0
                          EEEEEE T EEEEEEE
I N NNC
          0
             O M M P
                      L
                          E T E
    NN C C O O M
                  ΜP
                      LLLLLL EEEEEE T EEEEEEE
                 MР
III N N CCCC 000 M
                Testing is finished
```

A>

If any problem is detected during the test, the massage **FAIL** is displayed on the tester machine with the error code as shown below.

The error code begins with the least significant digit.

Error code

Table 3-7 Error code for Bluetooth test (BD_ADDR of the DUT) (1/2)

Error code	Meaning
0x01	Unknown HCI Command.
0x02	No Connection.
0x03	Hardware Failure.
0x04	Page Timeout.
0x05	Authentication Failure.
0x06	Key Missing.
0x07	Memory Full.
0x08	Connection Timeout.
0x09	Max Number Of Connections.
0x0a	Max Number Of SCO Connections To A Device.
0x0b	ACL Connection already exists.
0x0c	Command Disallowed.
0x0d	Host Rejected due to limited resources.
0x0e	Host Rejected due to security reasons.
0x0f	Host Rejected due to remote device is only a personal device.
0x10	Host Timeout.
0x11	Unsupported Feature or Parameter Value.
0x12	Invalid HCI Command Parameters.
0x13	Other End Terminated Connection: Used Ended Connection.
0x14	Other End Terminated Connection: Low Resources.
0x15	Other End Terminated Connection: About to Power Off.
0x16	Connection Terminated by Local Host.
0x17	Repeated Attempts.
0x18	Paring Not Allowed.
0x19	Unknown LMP PDU.
0x1a	Unsupported Remote Feature.
0x1b	SCO Offset Rejected.
0x1c	SCO Interval Rejected.
0x1d	SCO Air Mode Rejected.
0x1e	Invalid LMP Parameters.
0x1f	Unspecified Error.

^{**} See the Specification of the Bluetooth System in detail.

Table 3-7 Error code for Bluetooth test (BD_ADDR of the DUT) (2/2)

Error code	Meaning
0x20	Unsupported LMP Parameter Value.
0x21	Role Change Not Allowed.
0x22	LMP Response Timeout.
0x23	LMP Error Transaction Collision.
0x24	LMP PDU Not Allowed.
0x25	Not Exist
0x26	Not Exist
0x27	Not Exist
0x28	Not Exist
0x29	Not Exist
0x2a	Not Exist
0x2b	Not Exist
0x2c	Not Exist
0x2d	Not Exist
0x2e	Not Exist
0x2f	Not Exist

^{**} See the Specification of the Bluetooth System in detail.

3.29.4 IEEE1394 test

To execute this test, input **4** and press **Enter**.

NOTE: Use another computer that can communicate by IEEE1394 (i. Link) cable as a responder machine to perform this test.

The following menu will appear:

To execute the TEST, select the test number you want to execute and press **Enter**.

Subtest01 Transmit & Receive test

NOTE: Before executing subtest 01, be sure to execute subtest 02 in the responder machine.

This program checks the data transporting between responder machine and tester machine and compare them with the original data through the IEEE1394 cable.

Subtest02 Responder set

This program is executed in the responder machine to initialize the responder machine with the IEEE1394 cable connected to the tester machine before executing subtest 01.

Subtest03 IEEE1394 GUID Display

This program checks the GUID of IEEE1394.

3.30 Sound Test program

This section describes how to perform the Sound test. To execute the sound test, refer to the following description.

Insert the test program disk for Sound test in the floppy disk drive and turn on the power. The following message will appear:

Input the test number and press **Enter**.

3.30.1 Sound (Standard) test

To execute the Sound (Standard) test, press **1** and **Enter**. The following menu will appear in the display.

To return to the Sound test menu, Press **9** and **Enter**. Then following message will appear in the display.

After pressing any key, the machine starts rebooting and sound test menu will appear in the display.

Subtest01 Microphone recording & play

This subtest checks the function of the CODEC A/D, D/A converter.

When this subtest is selected, the following message will appear.

```
[Recording & play test !]
```

And the following message will appear.

```
DOS/4GW Protected Mode Run-time Version X.XX Copyright (c) Tenberry Software, Inc. XXXX
```

After this message appears, display stops briefly. In this timing, sound is recorded from internal microphone.

After the recording is completed, the computer plays back the sound recorded after the following message.

```
STACWAVE Version X.XX
Build data: XXX XX XXXX at XX:XX
Loading "mic.wav".
```

NOTE: The message in the display might have slight difference from those above.

The display returns to the Sound (Standard) test menu after the test ends.

Subtest02 Sine Wave

This subtest is executed by loading the COM file (ADSIN.COM). The program expands sine wave data table from 16KB to 64KB, and creates the play data. Then it transfers the data between the DMA and the CODEC to play the sine wave. (It sounds like a continuous beep). By using wave measurable devices such as an oscilloscope, the data can be measured as a sine wave.

When the subtest is executed, the sine wave is played while expanding sine wave from 16KB to 64KB.

The display returns to the Sound (Standard) test menu after the test ends.

Subtest03 Line IN recording & play

This subtest executes the same test as the subtest01 by recorded sound from the different port (Line-in port).

For more details on the subtest, refer to the subtest01 Microphone recording & play.

The display returns to the Sound (Standard) test menu after the test ends.

3.30.2 Sound (Legacy) test

To execute the Sound (Legacy) test, select **2** and press **Enter**.

CAUTION: Sound (Legacy) test is not supported in this model.

3.30.3 CD Sound (Standard) test

To execute the CD Sound (Standard) test, press **3** and **Enter**. Insert the test media (TOSHIBA TEST CD-ROM or ABEX TEST CD-ROM) or music CD on the market (if the test media can not be prepared). The menu appears in the display.

For details on use of test media, refer to (1) Test media (Toshiba-made test media). For details on use of audio CD on the market, refer to (2) Audio CD.

(1) Test media (Toshiba-made test media)

```
CD/DVD TEST IN PROGRESS XXXXXXXX
                                   XXXXXXX DIAGNOSTIC TEST VX.XX
                                   [Ctrl]+[Break] ; test end
                                   [Ctrl]+[C]
                                              ; key stop
SUB-TEST
          : XX
PASS COUNT : XXXXX
                      ERROR COUNT: XXXXX
WRITE DATA : XX
                         READ DATA : XX
        : XXXXXX
                              : XXX
ADDRESS
                      STATUS
01 - Japanese Narration
02 - English Narration
03 - Test Tone A (100Hz - 20Hz)
04 - Test Tone B (400Hz - 3KHz L-R)
                           Drive # = 0, ATAPI status =00
                              Command = XX
                            [[Block address = XXXXXXXX]]
                            [[Block length = XXXXXXXX]]
```

Subtest01 Japanese Narration

When selecting this subtest, narration in Japanese starts and following message appears in the display.

```
Play start CD sound !
Press any key <Play stop>.
```

Final : Block address = XXXXXXXXX

Press any key to stop the narration. Then the test returns to the CD Sound (Standard) test menu.

Subtest02 English Narration

When selecting this subtest, narration in English starts.

For more details on the procedure, refer to the subtest01.

Subtest03 Test Tone A

Caution: Before starting subtest03, be sure to set the sound at proper volume.

This subtest plays sine wave while changing its table from 100Hz to 20Hz.

The test returns to the CD Sound (Standard) menu after the test ends.

Subtest 04 Test Tone B

This subtest plays sine wave while changing its table from 400Hz to 3KHz and also changing the channel from left speaker to right speaker.

The test returns to the CD Sound (Standard) menu after the test ends.

(2) Audio CD

Insert an audio CD and the following menu appears in the display.

```
CD/DVD TEST IN PROGRESS XXXXXXXX
                                  xxxxxxx DIAGNOSTIC TEST VX.XX
                                  [Ctrl]+[Break] ; test end
                                  [Ctrl]+[C] ; key stop
SUB-TEST : XX
PASS COUNT : XXXXX
                     ERROR COUNT: XXXXX
WRITE DATA : XX
                        READ DATA : XX
ADDRESS : XXXXXX STATUS : XXX
CD Sound track number (01-98 : Track) ?
                             Drive # = 0, ATAPI status =00
                             Command = XX
                             [[Block address = XXXXXXXX]]
                             [[Block length = XXXXXXXX]]
                             Final : Block address =
XXXXXXXX
```

Select the track number you want to test and press **Enter** twice.

The following message appears in the display and selected track is played.

```
Play start CD sound !
Press any key <play stop>
```

After pressing any key, the music stops and the display returns to the selection menu of the track number.

```
NOTE: When the CD-ROM test is executed, [All Devices] must be selected in the "Device Config.=" of the BIOS SETUP. If the "All Devices" is not selected, music can not be played.
```

3.30.4 CD Sound (Legacy) test

To execute the CD Sound (Legacy) test, select **4** and press **Enter**.

CAUTION: Sound (Legacy) test is not supported in this model.

3.31 SETUP

3.31.1 Function Description

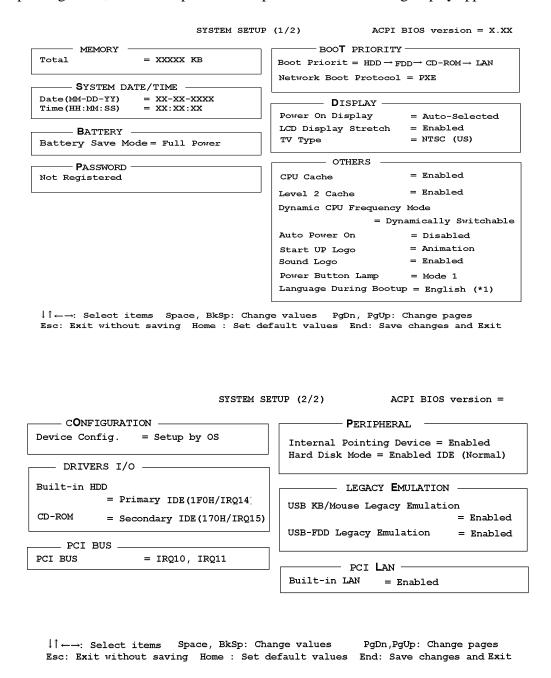
This program displays the current system setup information as listed below:

- 1. Memory
- 2. System Date/Time
- 3. Battery
- 4. Password
- 5. Boot Priority
 - (a) Boot Priority
 - (b) Network Boot Protocol
- 6. Display
 - (a) Power On Display
 - (b) LCD Display Stretch
 - (c) TV Type
- 7. Others
 - (a) CPU Cache
 - (b) Level 2 Cache
 - (c) Dynamic CPU Frequency Mode
 - (d) Auto Power On
 - (e) Start Up Logo
 - (f) Sound Logo
 - (g) Power Button Lamp
 - (h) Language During Bootup
- 8. Configuration
- 9. Drives I/O
 - (a) Built-in HDD
 - (b) CD-ROM
- 10. PCI Bus
- 11. Peripheral
 - (a) Internal Pointing Device

- (b) Hard Disk Mode
- 12. LEGACY EMULATION
 - (a) USB KB/Mouse Legacy Emulation
 - (b) USB-FDD Legacy Emulation
- 13. PCI LAN

3.31.2 Accessing the SETUP Program

While pressing **ESC**, turn on the power. Then press **F1**. The following display appears.



NOTE: *1 This message appears only on the model for TCL (Canada).

Moving Within the SETUP Menu and Changing Values

- 1. Press ∠ and ∠ to move between the two columns. Press? and? to move between items in a column. Press Fn+? ??PgUp) and Fn +? ??PgDn) to move between the two pages.
- 2. Press either the **Space bar** or **Back Space** to change the value.

Accepting Changes and Exiting the SETUP Window

1. Press **End** to accept the changes you made.

If the changed item does not require the system to reboot, the following message is displayed:

```
Are you sure? (Y/N)
```

If the changed item requires the system to reboot, the following message is displayed:

```
Are you sure? (Y/N) The changes you made will cause the system to reboot.
```

- 2. To make other changes, press **N**. Repeat the steps above.
- 3. To accept the changes, press **Y**.

NOTE: You can press **Esc** to quit at any time without saving changes. SETUP asks you to confirm that you do not want to save your changes. When SETUP is displayed at the next time, the current configuration appears.

The Factory Preset Configuration

When you access SETUP, the current configuration is displayed.

- 1. To show the factory preset configuration, press **Home**.
- 2. To accept the default settings, press **End** and then press **Y**.

NOTE: When you execute the default setting, the following settings are not changed:

- (1) HDD Mode
- (2) Password
- (3) Write Policy

SETUP Options

The SETUP screen is divided into 13 functionally related groups. This section describes each group and its options.

1. Memory

This group of options displays the computer's memory.

This field displays the total amount of memory installed and is automatically calculated by the computer. You cannot change this value.

2. System Date/Time

You can set the date and time. To set the date and time, press **Space bar** or **Back Space**. To switch System Date and System Time, press? or??

System Date Sets date.

System Time Sets time.

3. Battery

This option is used to select **Full Power**, **Low Power** or **User Setting** of the battery save mode. When you select the battery save mode, the followings will appear.

Full Power The following shows full power settings.

```
BATTERY SAVE OPTIONS

Processing Speed = High

CPU Sleep Mode = Enabled

Display Auto off = 30Min.

HDD Auto off = 30Min.

LCD Brightness = Bright (*1)

= Super-Bright (*2)

Cooling Method = Maximum Performance
```

Low Power The following shows low power settings.

```
BATTERY SAVE OPTIONS

Processing Speed = Low

CPU Sleep Mode = Enabled

Display Auto off = 03Min.

HDD Auto off = 03Min.

LCD Brightness = Semi-Bright (*1)

= Bright (*2)

Cooling Method = Battery Optimized
```

NOTE: Display of the LCD Brightness will be changed in the condition below:

(*1) Operating the battery

(*2) *Using the AC adapter*

User Setting Use this option to set the battery save parameters on

the sub-window, **BATTERY SAVE OPTIONS**.

Battery Save Options

Processing Speed

This feature changes the CPU processing speed.

High CPU operates at 1.50/1.60/1.70/1.80/2.00/2.10GHz

(Default in Full Power Mode)

Low CPU operates at half processing speed.

(Default in Low Power Mode)

CPU Sleep Mode

Use this option to enable or disable the CPU sleep function. When the CPU sleep function is enabled, the machine saves power consumption while waiting the next processing.

Enabled Enables sleep mode. (Default)

Disabled Disables sleep mode.

Display Auto Off

Use this option to disable or set the duration of the display automatic power off function. This function causes the computer to turn the LCD panel's illumination off if you make no entry (including no operation of a mouse or touch pad) for the set period of time.

Disabled Disables display automatic power off.

xx Min. Automatically turns off the power to the LCD panel's

illumination if the panel is not used for the duration set. The duration xx can be set to 1, 3, 5, 10, 15, 20 or 30

minutes.

HDD Auto Off

Use this option to set the duration of the HDD automatic power off function.

xx Min. Automatically turns off the power to the hard disk drive

> if it is not used for the duration set. The duration xx can be set to 1, 3, 5, 10, 15, 20 or 30 minutes.

LCD Brightness

Use this option to set the level of LCD brightness.

Super-Bright Full brightness for maximum visibility.

Bright Full brightness for high visibility.

Semi-Bright Less than full brightness for saving power.

CPU Cooling Method

Maximum Performance If the CPU becomes too hot, the fan turns on

automatically in a high speed to cool down the

CPU.

Performance If the CPU becomes too hot, the fan turns on

automatically. When the CPU temperature falls to

a normal range, the fan turns off.

Battery optimized If the CPU becomes too hot, the processing speed is

> lowered. If the temperature is still too high, the fan turns on. When the CPU temperature falls to a normal range, the fan is turned off and the

processing speed is increased.

NOTE: Too hot condition may cause defect on the CPU. When the hot condition continues, the power is automatically turned off in hibernation mode.

4. Password

This option sets or resets the user password for power on and instant security (**Fn+F1**).

Registered The user password has been registered.

Not registered The user password has not been registered.

For details on setting the user password, refer to the User's Manual.

5. Boot Priority

(a) Boot Priority

Use this option to set the priority for booting of the computer and the priority for the HDD for booting.

FDD? HDD? CD-ROM? LAN: The computer looks for bootable files in the

following order: FDD, HDD, CD-ROM

(*1) and LAN

HDD? CD-ROM? LAN? FDD: The computer looks for bootable files in the

following order: HDD, CD-ROM, LAN

and FDD.

FDD? CD-ROM? LAN? HDD: The computer looks for bootable files in the

following order: FDD, CD-ROM, LAN

and HDD.

CD-ROM? LAN? HDD? FDD: The computer looks for bootable files in the

following order: CD-ROM, LAN, HDD

and FDD.

CD-ROM? LAN? FDD? HDD: The computer looks for bootable files in the

following order: CD-ROM, LAN, FDD

and HDD.

HDD? FDD? CD-ROM? LAN: The computer looks for bootable files in the

following order: HDD, FDD, CD-ROM

and LAN. (Default)

(*1) CD-ROM refers to an Optical Disk Drive.

(b) Network Boot Protocol

Use this option to set the starting method via a network.

PXE Sets to PXE protocol. (Default)

RPL Sets to RPL protocol.

6. Display

This group of options configures the computer's display.

(a) Power On Display

This option is used to select the display when booting up.

Auto-Selected Selects an external monitor if one is connected. Otherwise it

selects the internal LCD. (Default)

LCD+**AnalogRGB** Selects both the internal LCD and the external monitor for

simultaneous display.

NOTE: When starting the computer in Standby or hibernation mode, the last configuration is remembered. If data does not appear on the display you are using after starting in Standby or hibernation mode, pressing **Fn+F5**.

Pressing **Fn+F5** changes the display setting as follows in order: the internal LCD, the external monitor, both the internal LCD and the external monitor and TV display.

You cannot select TV display in HW Setup. To display on a TV screen, use **Fn+F5**.

When an external monitor, which does not support SVGA mode is connected and "LCD+AnalogRGB" is selected, the external display is not displayed.

(b) LCD Display Stretch

When LCD Display Stretch is enabled, it is possible to stretch the picture in small resolution mode.

Enabled Enables the LCD display stretch feature. (Default)

Disabled Disables the LCD display stretch feature.

(c) TV Type

This option allows you to select the type of TV.

NTSC (Japan)	TV in Japanese system
NTSC (US)	TV in the U.S. system
PAL (S-Video)	TV in Europe and China system
525p (480p,D2)	High Definition Television with 480 progressive scan
750p (720p,D4)	High Definition Television with 720 progressive scan
1125i (1080i,D3)	High Definition Television with 1080 interlace
525i (480i,D1)	High Definition Television with 480 interlace
PAL (SCART)	TV in Europe system

7. Others

Whether or not you need to configure the computer with these options depends primarily on the kind of software or peripherals you use.

(a) CPU Cache

Use this option to enable or disable the CPU cache.

Enabled Enables the CPU cache. (Default)

Disabled Disables the CPU cache.

(b) Level 2 Cache

Use this option to enable or disable the level 2 cache. When "CPU Cache" is set to "Disabled", this option is not displayed.

Enabled Enables the level 2 cache. (Default)

Disabled Disables the level 2 cache.

(c) Dynamic CPU Frequency mode

Use this option to choose a setting from the followings.

Dynamically Switchable

Enables Pentium-M processor featuring Intel SpeedStep

technology. (Default)

Always High Disables Pentium-M processor featuring Intel SpeedStep

technology and always runs the processor at its maximum

speed.

Always Low Disables Pentium-M processor featuring Intel SpeedStep

technology and always runs the processor at its default

speed.

(d) Auto Power On

This option displays setting for Auto Power On.

Disabled Indicates auto power on is not set.

Enabled Indicates auto power on is set.

When "Enabled" is selected, the following sub-window appears.

- OPTIONS -		
Alarm Time	= 00:00:00	
Alarm Date Option	= Disabled	

Set the parameters for the Auto Power On (automatic power on) function in the "OPTIONS" window. To set the time, use **Space bar** or **BackSpace**. Press? to move the cursor to the right and? to move the cursor to the left when you set the date and time.

For the **Alarm Time**, set the time to turn on the power automatically. The "second" cannot be set. When it is set to "Disabled", the time to turn on automatically is not set.

For the **Alarm Date Option**, set the date to turn on the power automatically. When it is set to "Disabled", the time to turn on automatically is not set.

NOTE: 1. Do not remove the AC adaptor and battery pack at the same time when you use this feature. If you do so, data saved by the resume function will be lost. You must also reset this option.

- 2. If you have set a password and the computer boots by the Auto Power On function and hibernation is on, the computer will start with the instant security function enabled. When the **password** = message is displayed, enter the password to use the computer.
- 3. This option is enabled only once, the setting is reset, after booting up.
- (e) Start Up Logo

This option enables or disables an animation logo function.

Animation Enables the animation logo function. (Default)

Picture Disables the animation logo function

(f) Sound Logo

This option enables or disables sound logo function. When the sound logo function is enabled, the sound is output at startup of the computer.

Enabled Enables the sound logo function. (Default)

Disabled Disables the sound logo function

(g) Power Button Lamp

This option sets the power button lamp.

Off Always off.

Mode 1 Sets to Mode 1. (Default)

Glows blue (Power ON) / Glows yellow (Standby) / Glows

orange (Power OFF/Hibernation)

Mode 2 Sets to Mode 2.

Glows blue (Power ON) / Alternately flashes green and orange

(Standby) / Alternately flashes green and blue (Power

OFF/Hibernation)

Mode 3 Sets to Mode 3.

Flashes in order of green, orange and blue (Power ON) / Glows yellow (Standby) / Glows orange (Power OFF

/Hibernation)

(h) Language During Bootup

This option selects the language during bootup. This message appears only on the model for TCL (Canada).

English The message is displayed in English. (Default)

French The message is displayed in French.

8. Configuration

This option lets you set the device configuration.

All Devices BIOS sets all devices.

Setup by OS Initializes devices, which is needed to load an operating

system. Operating system initializes other devices.

NOTE: When using installed OS, selecting "Set by OS" is recommended. But when executing test programs, select "ALL Devices".

9. Drives I/O

This option displays the address and interrupt level for hard disk drive and optical disk drive. It is for information only and cannot be changed.

Built-in HDD This cannot be changed.

CD-ROM This cannot be changed. This is not displayed when a drive

is not built-in.

10. PCI Bus

This option displays the interrupt level for the Card Bus in the computer. It is for information only and cannot be changed.

PCI BUS = IRQ10, IRQ11

11. Peripheral

Use this option to select the peripheral's mode.

(a) Internal Pointing Device

This option enables or disables the touch pad

Enabled Enables the touch pad. (Default)

Disabled Disables the touch pad.

(b) Hard Disk Mode

Use this option to select the hard disk mode.

Enhanced IDE (normal)

Select this mode when the HDD is used for MS-DOS?, Windows 95/98/2000/XP, or OS/2?. (Default)

Standard IDE Select this mode when using an OS which does not support the Enhanced IDE. When this mode is selected, up to 528MB is logically available and the rest of the capacity is not usable.

NOTE: Formats for Enhanced IDE and Standard IDE are different, so if you change the setting, you will have to reformat the hard disk for the appropriate setting.

12. LEGACY EMULATION

(a) USB KB/Mouse Legacy Emulation

This option sets the Legacy support condition of the USB keyboard and the USB mouse.

Enabled Enables LEGACY support. (Default)

USB keyboard/USB mouse are available without the driver.

Disabled Disables LEGACY support

(b) USB-FDD Legacy Emulation

This option sets the Legacy support condition of the USB floppy disk drive. When a computer is FDD built-in model, this option is not displayed.

Enabled Enables LEGACY support. (Default)

USB floppy disk is available without the driver.

Disabled Disables LEGACY support

13. PCI LAN

This option sets the Enable / Disable of the built-in LAN functions.

Enabled Enables built-in LAN functions. (Default)

Disabled Disables built-in LAN functions.

Chapter 4 Replacement Procedures

Chapter 4 Contents

4.1	Overview		4-1
	Safety	Precautions	4-2
	Before	e You Begin	4-3
	Disass	sembly Procedure	4-4
	Assen	nbly Procedure	4-5
	Tools	and Equipment	4-5
	Screw	Tightening Torque	4-6
	Grip C	Color	4-6
	Screw	Notation	4-7
4.2	Battery pa	ack/PC card/Bridge Media	4-8
	4.2.1	Battery pack	4-8
	4.2.2	PC card	4-10
	4.2.3	Bridge media	4-11
4.3	HDD		4-12
4.4	Memory r	nodule	4-15
4.5	Keyboard	/Bluetooth	4-17
	4.5.1	Keyboard	4-17
	4.5.2	Bluetooth	4-21
4.6	Switch me	embrane	4-22
4.7	Optical dr	ive	4-24
4.8	Display as	ssembly	4-26
4.9	SD board/	/MDC	4-32
	4.9.1	SD board	4-32
	4.9.2	MDC	4-34
4.10	Fan		4-35
4.11	Wireless I	LAN board	4-36
4.12	System bo	oard	4-37
4.13	•	ery	
4.14	TV tuner	module/Guide	4-41
	A 1A 1	TV tuner module	4-41

4 Replacement Procedures

	4.14.2 Guide	4-42
4.15	Heat sink/CPU	4-44
4.16	VGA Heat sink	4-47
4.17	PC card cover	4-48
4.18	Speaker/VGA fan	4-49
4.19	Battery latch	4-51
4.20	Touch pad	4-53
4.21	SJ board	4-55
4.22	Microphone	4-57
4.23	LCD unit/FL inverter	4-58
4.24	Wireless antennas/ LCD harness	4-63
	4.24.1 Wireless antennas	4-63
	4.24.2 LCD harness	4-65
4.25	Hinge	4-67
4.26	Fluorescent lamp	4-70
	4.26 1 Replacing the 15.4-inch (W-XGA) Samsung fluorescent lamp	4-71

Figures

Figure 4-1	Removing the battery pack	4-8
Figure 4-2	Removing the PC card	4-10
Figure 4-3	Removing the bridge media	4-11
Figure 4-4	Removing the HDD assembly	4-12
Figure 4-5	Removing the HDD	4-13
Figure 4-6	Removing the memory module	4-15
Figure 4-7	Removing the speaker cover assembly	4-17
Figure 4-8	Removing the keyboard	4-18
Figure 4-9	Removing the keyboard support plate	4-19
Figure 4-10	Removing the bluetooth module	4-21
Figure 4-11	Removing the switch membrane	4-22
Figure 4-12	Removing the optical drive assembly	4-24
Figure 4-13	Disassembling the side bracket	4-25
Figure 4-14	Removing the screws (back)	4-26
Figure 4-15	Removing the screws (front)	4-27
Figure 4-16	Removing the cables	4-28
Figure 4-17	Removing the display assembly	4-29
Figure 4-18	Removing the wireless LAN antenna cables	4-30
Figure 4-19	Removing the SD board	4-33
Figure 4-20	Removing the MDC	4-34
Figure 4-21	Removing the fan	4-35
Figure 4-22	Removing the wireless LAN board	4-36
Figure 4-23	Removing the VGA fan cable	4-37
Figure 4-24	Removing the system board	4-38
Figure 4-25	Removing the RTC battery	4-40
Figure 4-26	Removing the TV tuner module	4-41
Figure 4-27	Removing the guide	4-43
Figure 4-28	Removing the heat sink	4-44
Figure 4-29	Removing the CPU	4-45

4 Replacement Procedures

Figure 4-30 Applying silicon grease	4-46
Figure 4-31 Removing the VGA heat sink	4-47
Figure 4-32 Removing the PC card cover	4-48
Figure 4-33 Removing the speakers	4-49
Figure 4-34 Removing the battery latch assembly	4-51
Figure 4-35 Removing the battery latch	4-51
Figure 4-36 Removing the touch pad	4-53
Figure 4-37 Removing the SJ board	4-55
Figure 4-38 Removing the microphone	4-57
Figure 4-39 Removing the display mask	4-58
Figure 4-40 Removing the FL inverter	4-59
Figure 4-41 Removing the LCD unit	4-60
Figure 4-42 Removing the LCD supports	4-61
Figure 4-43 Removing the bluetooth antenna cables	4-63
Figure 4-44 Removing the wireless antennas	4-64
Figure 4-45 Removing the LCD harness holder (display cover side)	4-65
Figure 4-46 Removing the LCD harness holder (middle frame side)	4-66
Figure 4-47 Removing the display cover	4-67
Figure 4-48 Removing the hinge (display cover side)	4-68
Figure 4-49 Removing the hinge (middle frame side)	4-68
Figure 4-50 to 4-54 Replacing Samsung fluorescent lamp (W-XGA)	4-71 to 4-74

4.1 Overview

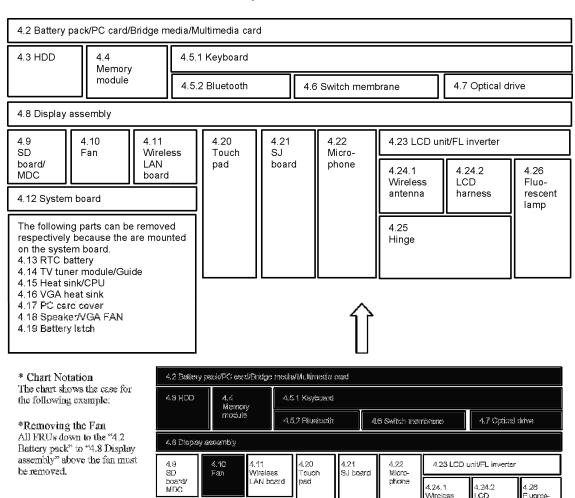
This chapter describes the procedure for removing and replacing the field replaceable units (FRUs) in the PC. It may not be necessary to remove all the FRUs in order to replace one. The chart below provides a guide as to which other FRUs must be removed before a particular FRU can be removed. The numbers in the chart indicate the relevant section numbers in this manual.

In all cases when removing an FRU, the battery pack must also be removed. When repairing an FRU that is the potential cause of a computer fault, use the chart to determine the order in which FRUs need to be removed.

The tilt stand can be removed without any other FRUs removed.

4.12 System board
4.13 RTC battery
4.14 TV tuner module/Guide

15 heat sink/CPU 16 VGA heat sink 17 PC card cover 18 Speaker/VGA FAN 19 Battery (atch



ent lamp

antenna

Hinge

Safety Precautions

Please read the following safety instructions before disassembling the computer and always follow the instructions while working on the computer.

DANGER:

- 1. In the case of the battery, always use authentic parts or equivalent parts approved by Toshiba. Other batteries may have different specifications that are incompatible with the computer and may result in fire or explosion.
 - Due to the risk of alkali fluid leaks, never attempt to heat or disassemble the battery. Similarly, due to the risk of explosion, never expose the battery to flame.
- 2. Some parts including the power supply and FL inverter generate high voltages. If you need to turn on the power while disassembling the computer, do not touch any connectors or other components due to the risk of electric shock. Also, do not disassemble individual parts when performing routine maintenance.

- **WARNING:** 1. To prevent electric shock, turn off the power unplug the AC adapter from the power source.
 - 2. As the battery installed to the computer is typically already charged, the risk of electric shock remains even when the AC adapter is unplugged from the socket. To prevent electric shock, always take off any metal jewelry or accessories such as necklaces, bracelets or rings before working on the computer. Never work with wet or moist hands.
 - 3. Take care not to injury yourself on any edges or corners.

CAUTION:

- 1. Confirm that replacement parts have compatible specifications before replacing on the computer. Never use incorrect parts as these may cause faults on the computer.
- 2. To prevent internal damage such as short circuits or burning, do not allow any screws, paper clips, or other metal objects to fall into the computer. When removing screws, always replace with the same size screw. Ensure that all screws are fully tightened. Loose screws may result in short circuits leading to overheating, smoke or flame.
- 3. To prevent electric shock, check that you have disconnected all cables from a part before removing the part.
- 4. When connecting to the AC power supply, use only an AC adapter and cable approved by Toshiba.
- 5. To prevent electric shock, ensure that all replacement parts are compatible with the computer and that all cables and connectors are securely connected.

Before You Begin

Take note of the following points before starting work. Always remove the AC adapter and battery pack before commencing any of the procedures. The procedure for removing the battery pack is described in section "4.2.1 Battery Pack".

- 1. Do not disassemble the computer unless it is operating abnormally.
- 2. Use the designated tools.
- 3. Ensure that the environment for working on and storing parts does not contain any of the following.
 - ? Dust or dirt
 - ? Static electricity
 - ? Extremely hot, cold or humid conditions
- 4. Perform the diagnostic tests described in Chapter 2 to determine which FRU is the cause of the fault.
- 5. Do not perform any unnecessary work. Always work in accordance with the disassembly and reassembly procedures in this manual.
- 6. Keep parts removed from the computer in a safe place away from the computer where they will not be damaged or interfere with your work.
- 7. Disassembling requires the removal of a large number of screws. Keep removed screws in a safe place such that you can determine which screws belong to which part.
- 8. When reassembling, ensure that you use the correct screws and fit parts in the correct position. Screw sizes are noted in the text and figures.
- 9. As all parts have sharp edges and corners, take care not to cut yourself.
- 10. After replacing an FRU, check that the computer and replaced part operate correctly.

Disassembly Procedure

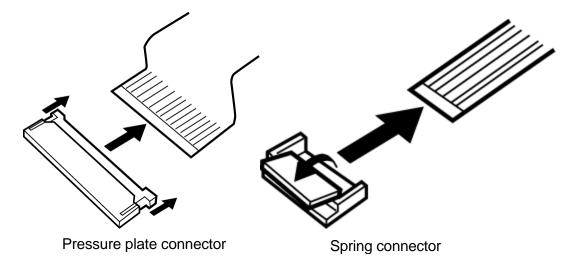
Three main types of cable connector are used.

- ? Pressure plate connector
- ? Spring connector
- ? Normal pin connector

When disconnecting a pressure plate connector, lift up the tag on one side of the plastic pressure plate on the connector and pull the cable out from the connector. When reconnecting a cable to a pressure plate connector, lift up the pressure plate to a suitable height and insert the cable into the connector. Press down on both sides of the pressure plate such that both sides of the plate and connector are at the same height and that the cable is fixed in the correct position. Pull the cable to ensure that it is securely connected. If the cable is disconnected from the connector, reconnect it making sure that you lift the pressure plate high enough to insert fully the cable.

For spring connectors, lifting up the stopper frees the cable and allows it to be pulled out. To reconnect, hold the stopper in the up position and insert the cable, then lower the stopper to secure the cable.

Normal pin connectors are used for all other cables. Simply pull out or push in these connectors to disconnect or reconnect.



Assembly Procedure

After the computer has been disassembled and the part that caused the fault has been repaired or replaced, the computer must be reassembled.

Take note of the following general points when assembling the computer.

- ? Take your time and follow the instructions carefully. Hurrying the assembly work will only introduce new problems.
- ? Check that all cables and connectors are securely connected.
- ? Before fastening FRUs or other parts in place, ensure that no cables are caught on screws or the FRU.
- ? Check that all latches are securely closed.
- ? Ensure that you have installed all FRUs correctly and do not have any screws left over. Using an incorrect screw may damage the thread or screw head and result in the FRU not being securely fastened in place.

After installing FRUs, check that the computer operates correctly.

Tools and Equipment

For your safety and the safety of the people around you, it is important that you use Electrostatic Discharge (ESD) equipment. Correctly utilizing of the equipment increases the percentage of successful repairs and saves on the cost of damaged or destroyed parts. The following equipment is required for disassembly and assembly.

- ? One Philips screwdriver with type 0 bit (for THIN HEAD screws)
- ? One Philips screwdriver with type 1 bit (for screws other than above)
- ? Tweezers (for lifting screws)
- ? Wireless LAN cable remover
- ? ESD mats (lay on work table or floor)
- ? An ESD wrist strap and heel grounder
- ? Anti-static carpet or flooring

Screw Tightening Torque

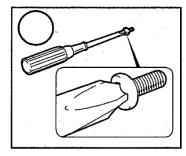
Use the following torque when tightening screws.

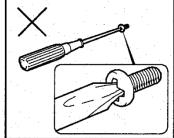
CAUTION: Overtightening may damage screws or parts. Undertightening may allow screws to loosen (and possibly fall out) causing a short circuit or other damage.

NOTE: To tighten screws quickly and accurately, an electric screwdriver is recommended.

? M2 (2mm) 0.167 N·m (1.7 kgf·cm)
 ? M2.5 (2.5mm) 0.294 N·m(3.0 kgf·cm)
 ? M3.0 (3mm) 0.549 N?m (5.6 kgf?cm)

NOTE: To prevent damage to THIN HEAD screws, press along the axis of the screwdriver while turning the screw. This is because the contact area between the screw and driver is less than for a pan head screw (standard pan-shaped screw head).





Grip Color

Some screws have a colored grip area to help you determine the length of the screw.

? Even numbered length screws: Brown

? Odd numbered length screws: White

? Special length screw: Blue



"Special length screw" means screws whose length is indicated in an integral number to the first decimal places such as 2.5 mm, 2.8 mm and so on.

Screw Notation

To make maintenance of the computer easier, markings of the kinds of the screws including the types and lengths of the screws are indicated on the computer body.

Format:

Screw shape + Screw length (mm)

Screw shape

B: Bind screw

F: Thin head screw

S: Super thin head screw

T: Tapping screw

U: Other screws (Unique screws: pan head, stud, etc.)

Example: B6 ... 6mm bind screw

4.2 Battery pack/PC card/Bridge Media

4.2.1 Battery pack

Removing the battery pack

The following describes the procedure for removing the battery pack (See Figure 4-1).

CAUTION: Take care not to short circuit the terminals when removing the battery pack. Similarly, do not drop, knock, scratch, disassemble, twist, or bend the battery pack.

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and all other external devices from the computer.
- 3. Turn the computer upside down.
- 4. Release the **battery lock** by moving it to the arrow direction.
- 5. Slide the **battery latch** to the arrow direction and raise the **battery**.
- 6. Release the **hooks** of the battery cover and remove the **battery pack** from the **battery cover**.

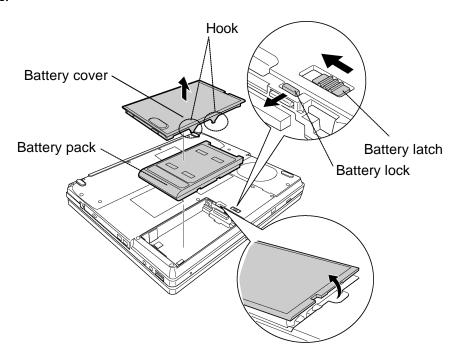


Figure 4-1 Removing the battery pack

NOTE: Dispose of the used battery pack in accordance with the laws and ordinances of your local authority.

Installing the battery pack

The following describes the procedure for reinstalling the battery pack (See Figure 4-1).

CAUTION: The lithium ion battery pack may explode if not fitted, operated, handled, or disposed correctly. Dispose always the used battery pack in accordance with the laws and ordinances of your local authority. Use only the batteries approved by Toshiba.

NOTE: Check visually the battery terminals and clean off any dirt with a dry cloth.

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and all other external devices from the computer.
- 3. Attach the **battery cover** to the **battery pack**.
- 4. Place the **battery pack** into the slot and insert it carefully.
- 5. Slide the **battery lock** to the lock position.

4.2.2 PC card

Removing the PC card

The following describes the procedure for removing the PC card (See Figure 4-2).

CAUTION: Insert or remove the PC card in accordance with any instructions in the PC card manual or the manuals of the computer system you are using.

- 1. Push the **eject button** It will pop out when you release it. Then press once more the eject button to eject the PC card.
- 2. Grasp the **PC card** and remove it.

NOTE: If the PC card is not inserted all the way, the eject button may not pop out. Be sure to push the PC card firmly and press the eject button again.

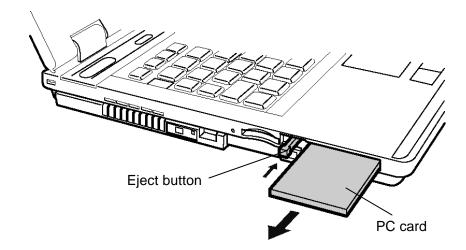


Figure 4-2 Removing the PC card

Installing the PC card

The following describes the procedure for inserting a PC card (See Figure 4-2).

- 1. Make sure the **eject button** does not stick out.
- 2. Insert the **PC card** and press it until it is securely connected.

4.2.3 Bridge Media (SD Card / Memory Stick / xDPicture Card/Multi Media Card)

Removing the Bridge media

The following describes the procedure for removing the bridge media (See Figure 4-3).

CAUTION: Insert or remove the Bridge Media in accordance with any instructions in the each Bridge Media manual or the manuals of the computer system you are using.

1. Push a **Bridge media**. It will pop out partly when you release, so pull out the card.

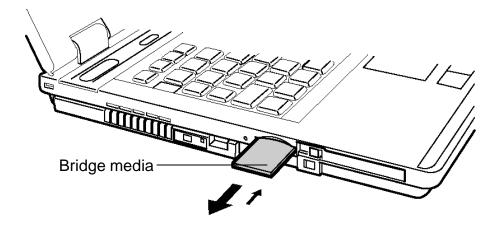


Figure 4-3 Removing the bridge media

Installing the Bridge media

The following describes the procedure for inserting a bridge media (See Figure 4-3).

1. Insert a **bridge media** and press it until it is securely connected.

4.3 HDD

Removing the HDD

The following describes the procedure for removing the HDD (See Figure 4-4 and 4-5).

CAUTION: Be careful not to drop or leave screws in the PC.

Take care not to press on the top or bottom of the HDD. Pressure may cause data loss or damage to the device.

- 1. Turn the computer upside down.
- 2. Remove the following **screw** fixing the HDD slot cover and remove the **HDD slot cover**.
 - ? M2.5? 10B FLAT BIND screw x1
- 3. Hold the tab and pull out the **HDD assembly** from the connector **CN1800** on the system board.

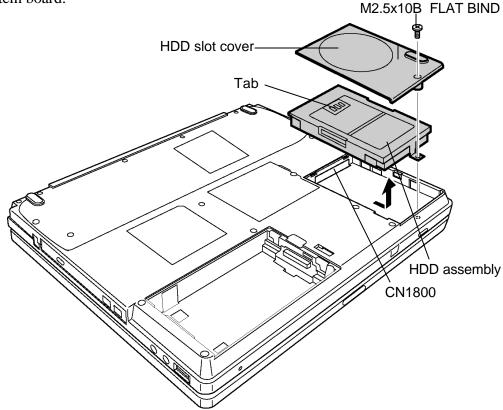


Figure 4-4 Removing the HDD assembly

- 4. Remove the following screws fixing the HDD assembly.
 - ? F3?4S FLAT BIND screw x4
- 5. Detach the **HDD** holder from the **HDD**.
- 6. Pull out the **laminate cover** to the arrow direction and detach it from the HDD.

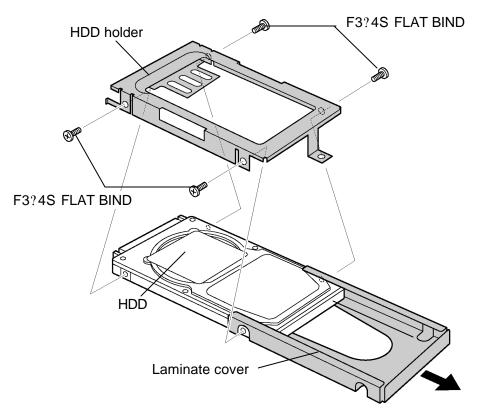


Figure 4-5 Removing the HDD

Installing the HDD

The following describes the procedure for installing an HDD (See Figure 4-4 and 4-5).

- 1. Attach the **laminate cover** to the HDD.
- 2. Install the **HDD** to the **HDD holder** and secure them with the following **screws**.

? F3?4S FLAT BIND screw x4

NOTE: Although they are 3mm head screws, screw torque must be set in 0.294 N·m (3.0kgf·cm) for four screws securing the HDD holder.

- 3. Insert the **HDD assembly** into the HDD slot from the screw hole side first and connect it carefully to the **CN1800** on the system board.
- 4. Install the **HDD slot cover** and secure it with the following **screw**.
 - ? M2.5?10B FLAT BIND screw x1

4.4 Memory module

CAUTION: The power of the computer must be turned off when you remove the memory module. Removing a memory module with the power on risks damaging the module or the computer itself.

Do not touch the memory module terminals. Any dirt on the terminals may cause memory access problems.

Never press hard or bend the memory module.

Removing the memory module

To remove a memory module, confirm that the computer is in boot mode. Then perform the following procedure (See Figure 4-6).

- 1. Loose the **screw** fixing the **memory slot cover**.
- 2. Remove the **memory slot cover**.
- 3. Open the left and right **latches** and remove the **memory module**.

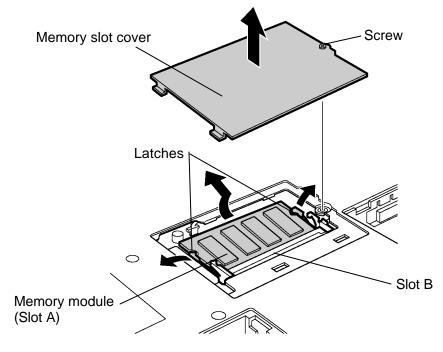


Figure 4-6 Removing the memory module

Installing the memory module

To install the memory module, confirm that the computer is in boot mode. Then perform the following procedure (See Figure 4-6).

1. Insert the **memory module** into the connector of the computer slantwise (terminal side first) and press it to connect firmly.

CAUTION: The power must be turned off when you insert the memory module. Inserting a memory module with the power on might damage the module or the computer itself.

Never press hard or bend the memory module.

When installing a memory module, always install it to Slot A first.

- 2. Install the **memory slot cover** and secure it with the **screw**.
- 3. When the power of the computer is turned on, the computer checks automatically the memory size. Confirm that the new memory is detected correctly.
- 4. If the memory is not detected, check that it is connected correctly.

4.5 Keyboard/Bluetooth

4.5.1 Keyboard

Removing the keyboard

The following describes the procedure for removing the keyboard (See Figure 4-7 to 4-9).

CAUTION: As the keytop may fall out, when handling the keyboard always hold it by the frame and do not touch the keytop.

- 1. Open the display.
- 2. Insert your finger into the spaces between the keyboard brace and the computer. Then, lift up the **keyboard brace** to unlatch and remove it.
- 3. Remove the following **screw** fixing the speaker cover assembly.
 - ? M2.5?4B FLAT BIND screw x1
- 4. Slide the **speaker cover assembly** to the arrow direction and pull up to remove.

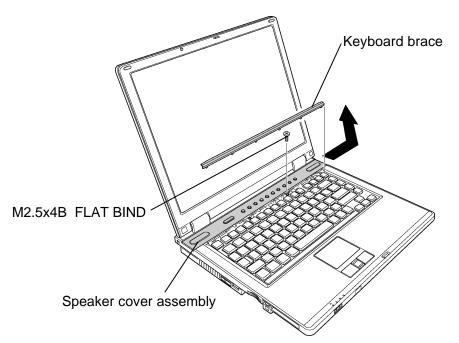


Figure 4-7 Removing the speaker cover assembly

5. Remove the following screws fixing the keyboard

? M2.5?2.8B FLAT BIND screw x2

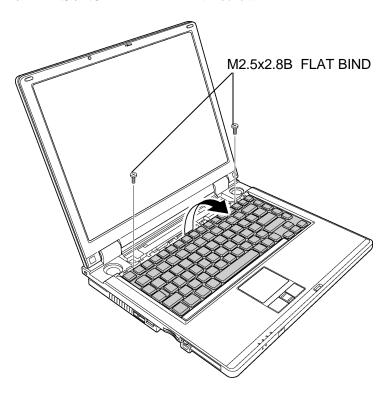


Figure 4-8 Removing the keyboard

6. Lift the upper side of the **keyboard** and turn it face down on the palm rest.

7. Remove the following screws fixing the keyboard support plate.

? M2.5?2.8B FLAT BIND screw x2

8. Remove the **keyboard support plate**.

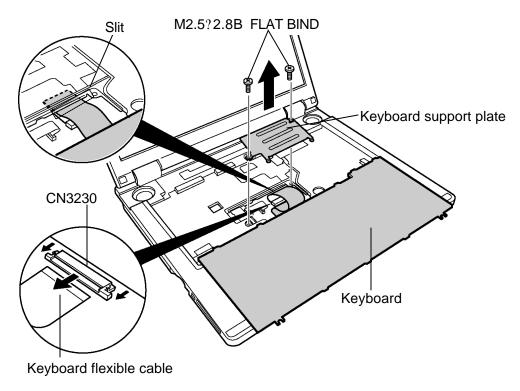


Figure 4-9 Removing the keyboard support plate

- 9. Pull out the **keyboard flexible cable** from the **slit** and disconnect it from the connector **CN3230** on the system board.
- 10. Remove the **keyboard**.

Installing the keyboard

The following describes the procedure for installing the keyboard (See Figure 4-7 to 4-9).

1. Turn the **keyboard** upside down and place it on the palm rest as its face down. Connect the **keyboard flexible cable** to the connector **CN3230** on the system board.

NOTE: After connecting the keyboard flexible cable, put the cable into the slit of the computer.

- 2. Install the **keyboard support plate** from the palm rest side edge and secure it with the following **screws**.
 - ? M2.5?2.8B FLAT BIND screw x2
- 3. Turn the **keyboard** face up and put it on the computer. Make sure that there is no space between the keyboard and the computer.
- 4. Secure the **keyboard** with the following **screws**.
 - ? M2.5?2.8B FLAT BIND screw x2
- 5. Slide to set the **speaker cover assembly** and secure it with the following **screw**.
 - ? M2.5?4B FLAT BIND screw x1
- 6. Install the **keyboard brace** by pressing it.

4.5.2 Bluetooth

Removing the Bluetooth

The following describes the procedure for removing the bluetooth (See Figure 4-10).

- 1. Disconnect the **bluetooth flat cable** from the connector **CN4400** on the system board.
- 2. Turn up the insulator to take out the **bluetooth module** from the **guide** of the display assembly.
- 3. Disconnect the **bluetooth antenna cable (black cable with marking)** from the bluetooth module.
- 4. Disconnect the **bluetooth flat cable** from the connector on the bluetooth module.

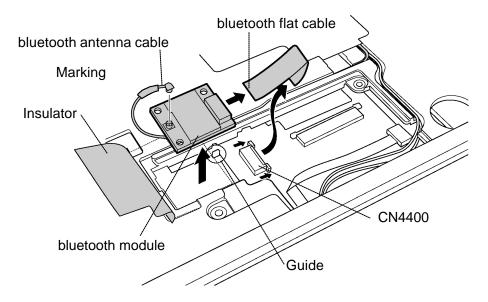


Figure 4-10 Removing the bluetooth module

Installing the Bluetooth

The following describes the procedure for installing the bluetooth (See Figure 4-10).

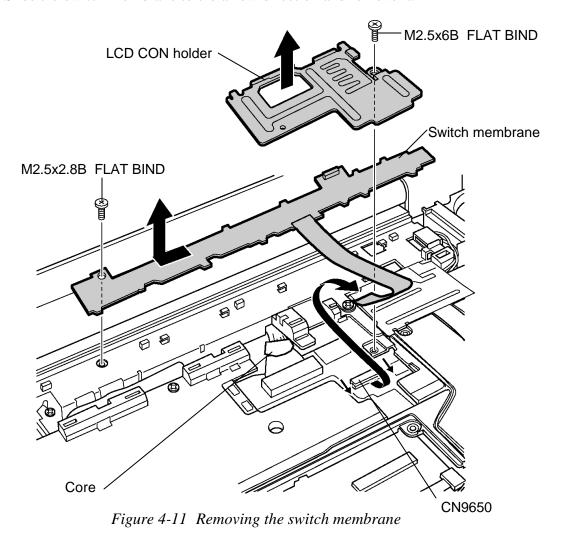
- 1. Connect the **bluetooth flat cable** to the connector on the bluetooth module.
- 2. Connect the **bluetooth flat cable** to the connector **CN4400** on the system board.
- 3. Turn up the insulator to fit the **bluetooth module** to the **guide** of the display assembly.
- 4. Connect the bluetooth antenna cable (black cable with marking) to the bluetooth module.

4.6 Switch membrane

Removing the switch membrane

The following describes the procedure for removing the switch membrane (See Figure 4-11).

- 1. Remove the following **screw** and remove the **LCD CON holder**.
 - ? M2.5?6B FLAT BIND screw x1
- 2. Disconnect the switch membrane from the connector CN9650 on the system board.
- 3. Remove the following screw fixing the membrane switch.
 - ? M2.5?2.8B FLAT BIND screw x1
- 4. Slide the switch membrane to the arrow direction and remove it.



Installing the switch membrane

The following describes the procedure for installing the switch membrane (See Figure 4-11).

- 1. Connect the **switch membrane** to the connector **CN9650** on the system board.
- 2. Slide the switch membrane to install and secure it with the following **screw**.
 - ? M2.5?2.8B FLAT BIND screw x1
- 3. Install the **LCD CON holder** and secure it with the following **screw**.
 - ? M2.5?6B FLAT BIND screw x1

NOTE: When installing the LCD CON holder, be careful not to catch harnesses, cables and the core of the LCD harness.

4.7 Optical drive

NOTE: Do not apply excessive force to the top of an optical drive.

Do not touch the shaded portion of the figure below, when you remove or install the drive.

Removing the optical drive

The following describes the procedure for removing the optical drive (See Figure 4-12 and 4-13).

- 1. Turn over the computer and remove the following **screws** securing the optical drive assembly.
 - ? M2.5?4B FLAT BIND screw x2
- 2. Pull out the **optical drive assembly** towards the arrow direction to disconnect it from the **CN1820** on the system board.

NOTE: When it is difficult to pull out the optical drive assembly, insert your finger into the slot and push out the optical drive assembly.

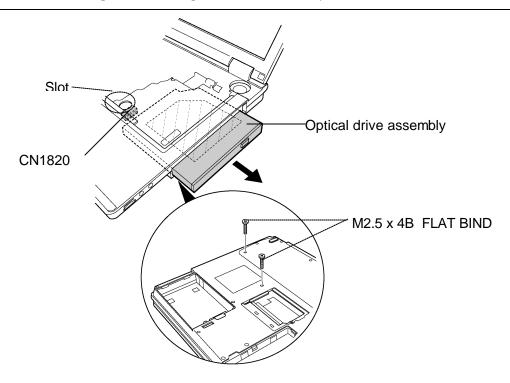


Figure 4-12 Removing the optical drive assembly

3. Remove the following **screws** to remove the **side bracket** from the optical drive.

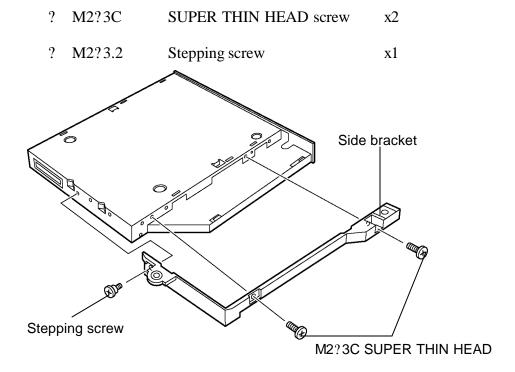


Figure 4-13 Disassembling the side bracket

Installing the optical drive

The following describes the procedure for installing the optical drive (See Figure 4-12 and 4-13).

1. Attach the **side bracket** to the optical drive and secure it with the following **screws**.

?	M2?3C	SUPER THIN HEAD screw	x2
?	M2?3.2	Stepping screw	x1

- 2. Insert the **optical drive assembly** into the slot for the drive and connect it to the connector **CN1820** on the system board.
- 3. Secure the optical drive assembly from the bottom of the computer with the following screws.
 - ? M2.5?4B FLAT BIND screw x2

4.8 Display assembly

Removing the display assembly

The following describes the procedure for removing the display assembly (See Figure 4-14 to 4-18).

- 1. Close the display and turn the computer upside down.
- 2. Remove the following **screws** from the bottom of the computer.

? M2.5? 10B	FLAT BIND screw	x12 ("10" in the figure)
? M2.5?10B	FLAT BIND screw (Locktight)	x2 ("10+L" in the figure)
? M2.5?4B	FLAT BIND screw	x1 ("4" in the figure)

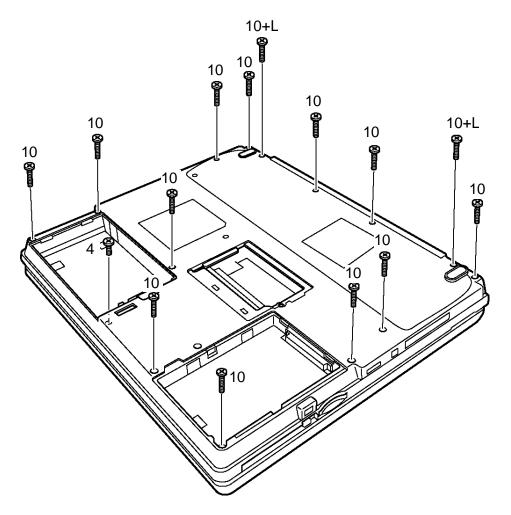


Figure 4-14 Removing the screws (back)

- 3. Tun over the computer and open the display.
- 4. Remove the following **screws** and remove the **harness cover**.

? M2.5?6B FLAT BIND screw x2 ? M2.5?10B FLAT BIND screw x1

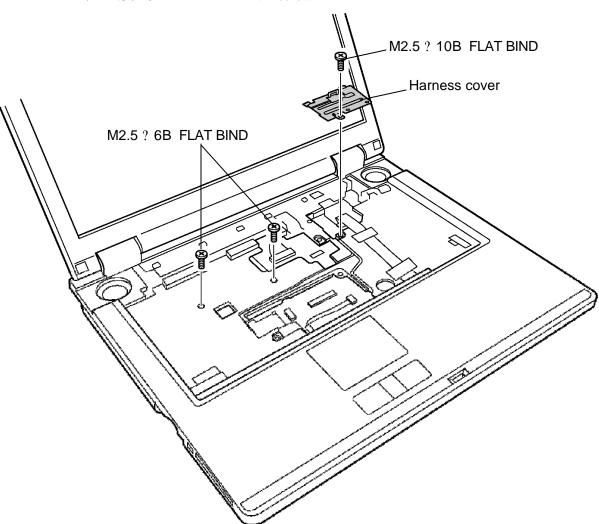


Figure 4-15 Removing the screws (front)

- 5. Disconnect the **LCD harness** from the connector **PJ5600** on the system board.
- 6. Unlock the connector **CN3201** and disconnect the **touch pad cable** from the connector on the system board.
- 7. Unlock the connector **CN9550** and disconnect the **SJ board flat cable** from the connector on the sound board.
- 8. Take out the **wireless LAN antenna cables** under the insulators and pull out it from the upper side of the slot.

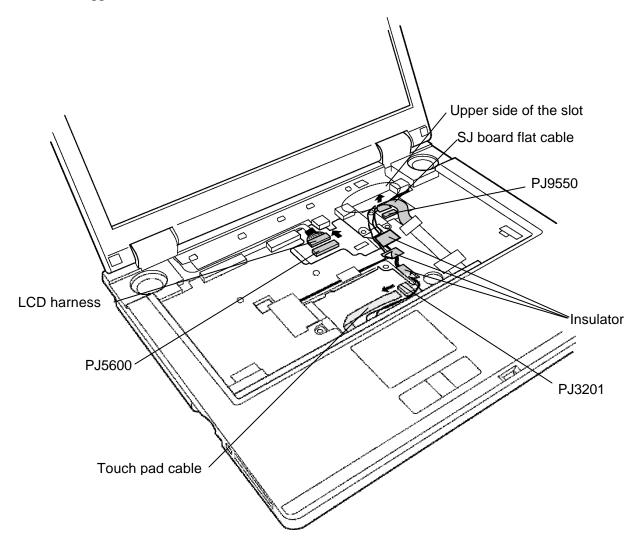


Figure 4-16 Removing the cables

- 9. Lift up the **display assembly** from the **Optical drive side** first to unhook the latches.
- 10. Remove the display assembly from the base assembly and place it next to the base assembly.
- 11. Remove the following **screws** and remove the **wireless LAN cover** on the base assembly.

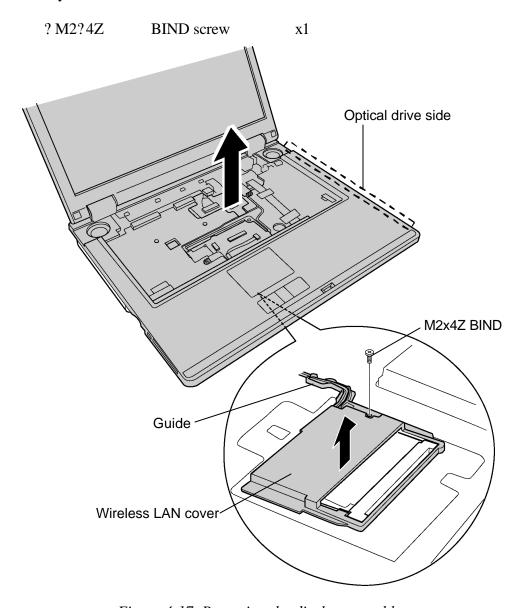


Figure 4-17 Removing the display assembly

12. Disconnect the wireless LAN antenna cables from the wireless LAN board.

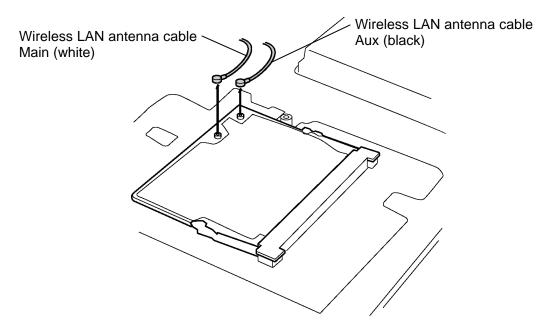


Figure 4-18 Removing the wireless LAN antenna cables

Installing the display assembly

The following describes the procedure for installing the display assembly (See Figure 4-14 to 4-18).

- 1. Connect the **wireless LAN antenna cables** (Main (white cable) and Aux (black cable)) to the connectors on the wireless LAN board.
- 2. Install the **wireless LAN cover** and fix it with the following **screw**. Pass the wireless LAN cables inside the guide of the wireless LAN cover.

? M2?4Z BIND screw x1

3. Install the **display assembly** on the base assembly.

NOTE: Make sure there is no cable caught between the display assembly and base assembly.

4. Secure the **display assembly** with the following **screws**.

? M2.5?6B FLAT BIND screw x2

- 5. Pass the wireless LAN antenna cables through the guide on the middle frame from the wireless LAN board side and fix them with the insulators. The excess part of the cables should be kept under the frame of upper side of the slot.
- 6. Connect the **SJ board flat cable** to the connector **CN9550** on the sound board.
- 7. Connect the **LCD harness** to the connector **PJ5600** on the system board.
- 8. Connect the **touch pad cable** to the **CN3201** on the system board.
- 9. Install the **harness cover** from the display side and secure it with the following screw.

? M2.5? 10B FLAT BIND screw x1

10. Secure the base assembly with the following **screws**.

NOTE: Be sure to apply the locktight to the screws with mark "+L" in the figure.

? M2.5? 10B FLAT BIND screw x12 ("10" in the figure)
? M2.5? 10B FLAT BIND screw x2 ("10+L" in the figure)
(Locktight)
? M2.5? 4B FLAT BIND screw x1 ("4" in the figure)

4.9 SD board/MDC

4.9.1 SD board

Removing the SD board

The following describes the procedure for removing the SD board (See Figure 4-19).

- 1. Disconnect the SD board flat cable from the connector CN9510 on the SD board.
- 2. Disconnect the **SVP harness** from the connector **CN9615** on the SD board.
- 3. Disconnect the **TV tuner cable** from the connector **CN9614** on the SD board.
- 4. Disconnect the **TV tuner coaxial cable** from the **CN2410** on the SD board.
- 5. Disconnect the **speaker cable L** (red cable) and **speaker cable R** (blue cable) from the connectors CN6002 and CN6003 on the SD board.
- 6. Disconnect the **USB harness** from the connector **CN4620** on the SD board.
- 7. Remove the following **screws** fixing the SD board.
 - ? M2.5?4B FLAT BIND screw x4
- 8. Remove the **SD board** and **RJ11 connector** altogether from the base assembly.

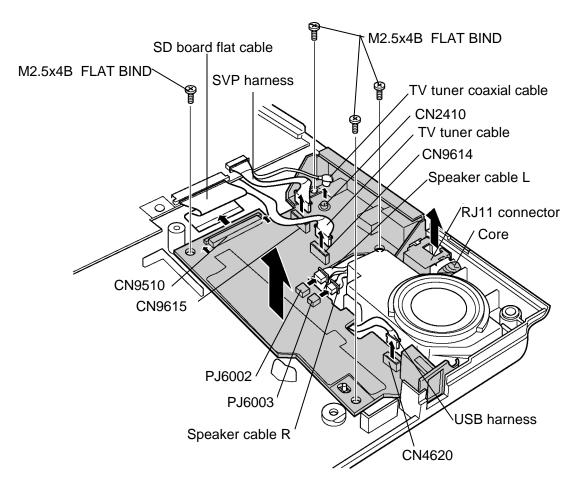


Figure 4-19 Removing the SD board

Installing the SD board

The following describes the procedure for installing the SD board (See Figure 4-19).

- 1. Install the **RJ11 connector** and its **core** to each slot of the base assembly.
- 2. Install the **SD board** and secure it with the following **screws**. When installing, pass the USB harness through the cut area of the SD board.
 - ? M2.5?4B FLAT BIND screw x4
- 3. Connect the USB harness to the connector CN4620 on the SD board.
- 4. Connect the **speaker cable L** (red cable) and **speaker cable R** (blue cable) to the connectors **CN6002** and **CN6003** on the SD board.
- 5. Connect the SD board flat cable, TV tuner coaxial cable, TV tuner cable and SVP harness to the connectors CN9510, CN2410, CN9614 and CN9615 on the SD board respectively.

4.9.2 MDC

Removing the MDC

The following describes the procedure for removing the MDC (See Figure 4-20).

- 1. Turn over the SD board.
- 2. Remove the following **screws** fixing the MDC and pull the **MDC** straight up from the connector **CN3000** on the SD board.
 - ? M2?4Z BIND screw x2
- 3. Remove the **RJ11 harness** from the MDC.

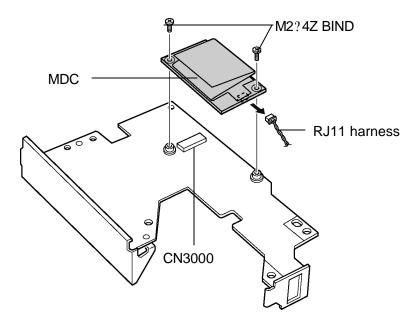


Figure 4-20 Removing the MDC

Installing the MDC

The following describes the procedure for installing an MDC (See Figure 4-20).

- 1. Connect the **RJ11 harness** to the **MDC**.
- 2. Connect the MDC to the connector CN3000 on the SD board.
- 3. Secure the MDC with the following **screws**.
 - ? M2?4Z BIND screw x2

4.10 Fan

Removing the fan

The following describes the procedure for removing the fan (See Figure 4-21).

- 1. Disconnect the **fan cable** from the **CN8770** on the system board.
- 2. Remove the following **screws** and remove the fan.

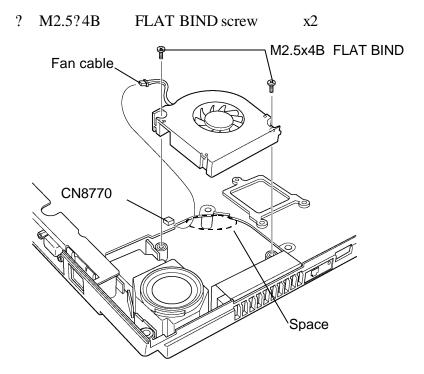


Figure 4-21 Removing the fan

Installing the fan

The following describes the procedure for installing the fan (See Figure 4-21).

- 1. Install the **fan** and secure it with the following **screws**.
 - ? M2.5?4B FLAT BIND screw x2
- 2. Connect the **fan cable** to the connector **CN8770** on the system board.

NOTE: After connecting the fan cable, put the cable into the space under the system board.

4.11 Wireless LAN board

Removing the wireless LAN board

The following describes the procedure for removing the wireless LAN board (See Figure 4-22).

1. Open the left and right latches holding the wireless LAN board and remove it.

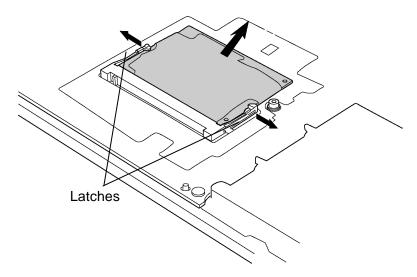


Figure 4-22 Removing the wireless LAN board

Installing the wireless LAN board

The following describes the procedure for installing the wireless LAN board (See Figure 4-22).

1. Insert the **wireless LAN board** terminals slantwise into the connector on the computer and press the wireless LAN board until it is securely in place.

4.12 System board

- **CAUTION:** 1. When handling the system board, always hold by the edges. Do not touch the printed circuit face.
 - 2. If replacing with a new system board, execute the subtest01 Initial configuration in section 3.3 "Setting of the hardware configuration". Also update with the latest BIOS as described in Appendix G "BIOS Rewrite Procedures".

Removing the system board

The following describes the procedure for removing the system board (See Figure 4-23 and 4-24).

1. Disconnect the **VGA fan cable** from the connector **CN8780** on the system board from the bottom side.

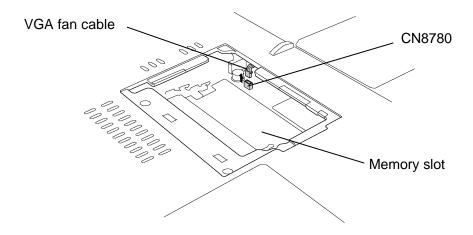


Figure 4-23 Removing the VGA fan cable

- 2. Turn over the PC and turn up the **insulator** to release the USB cable.
- 3. Remove the following **screws** securing the system board and remove the **system board** with the DC-IN jack. When removing the system board, be careful not to break the I/O ports on the system board.
 - ? M2.5?4B FLAT BIND screw x4
- 4. Remove the **BATT CONN cover**.
- 5. Disconnect **the DC-IN jack**, **SD board flat cable** and **SVP harness** from the system board.

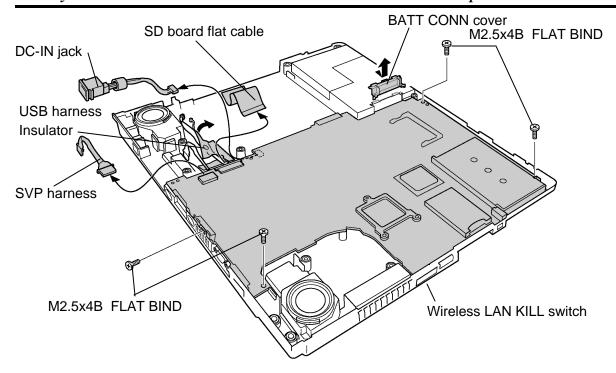


Figure 4-24 Removing the system board

Installing the system board

The following describes the procedure for installing the system board (See Figure 4-23 and 4-24).

- 1. Connect the **DC-IN jack**, **SD board flat cable** and **SVP harness** to the system board.
- 2. Install the **BATT CONN cover** with fitting to the slot of the base assembly.
- 3. Install the DC-IN jack to the base assembly.
- 4. Install the **system board.** When installing, insert the battery connector under the BATT CON cover and the set the opposite side of the system board. When setting the board, be careful not to break the I/O connectors on the system board. Then secure the system board with the following **screws**.
 - ? M2.5?4B FLAT BIND screw x4

NOTE: (for the model with the wireless LAN)
When installing the system board, make sure Wireless LAN KILL switch is fit to the slit of the base assembly.

- 5. Pass the **USB** cable along to the guide on the base assembly and secure the USB cable with the insulator.
- 6. Connect the **VGA fan cable** to the connector **CN8780** on the system board from the bottom side.

4.13 RTC battery

Removing the RTC battery

The following describes the procedure for removing the RTC battery (See Figure 4-25).

- 1. Disconnect the RTC battery harness from the connector **CN8490** on the system board.
- 2. Pull out the **RTC battery harness** from the **guide** and remove the **RTC battery**.

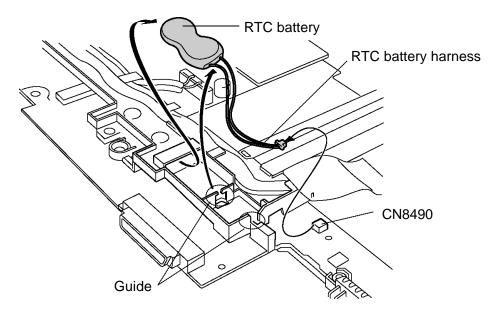


Figure 4-25 Removing the RTC battery

Installing the RTC battery

The following describes the procedure for installing the RTC battery (See Figure 4-25).

- 1. Install the RTC battery and pass the RTC battery harness through the guide.
- 2. Connect the RTC battery harness to the connector **CN8490** on the system board.

4.14 TV tuner module/Guide

4.14.1 TV tuner module

Removing the TV tuner module

The following describes the procedure for removing the TV tuner module (See Figure 4-26).

- 1. Disconnect the **TV tuner harness** from the connector on the TV tuner module.
- 2. Disconnect the **TV tuner coaxial cable** from the connector on the TV tuner module.
- 3. Remove the following **screws** securing the TV tuner module.
 - ? M2?4Z BIND screw x2
- 4. Open the left and right latches holding the **TV tuner module** and remove it.

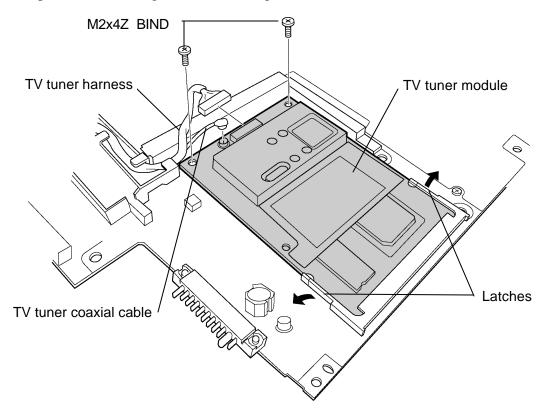


Figure 4-26 Removing the TV tuner module

Installing the TV tuner module

The following describes the procedure for installing the TV tuner module (See Figure 4-26).

- 1. Insert the **TV tuner module** terminals slantwise into the connector on the system board and secure it with the following screws.
 - ? M2?4Z BIND screw x2
- 2. Connect the TV tuner coaxial cable to the connector on the TV tuner module.
- 3. Connect the TV tuner harness to the connector on the TV tuner module.

4.14.2 Guide

Removing the guide

The following describes the procedure for removing the guide (See Figure 4-27).

- 1. Disconnect the **TV tuner harness** from the connector on the TV tuner module.
- 2. Disconnect the **TV tuner coaxial cable** from the connector on the TV tuner module.
- 3. Disconnect the **USB harness** from the connector **CN4612** on the system board.
- 4. Pull out the **USB harness**, **TV tuner harness** and **TV tuner coaxial cable** from the guide.
- 5. Remove the following **screw** and remove the **guide**.
 - ? M2?4Z BIND screw x1

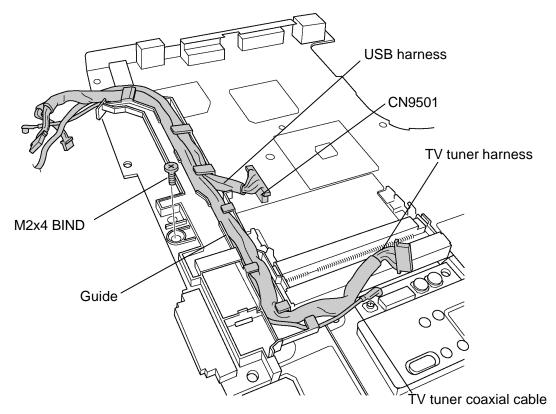


Figure 4-27 Removing the guide

Installing the guide

The following describes the procedure for installing the guide (See Figure 4-27).

- 1. Install the **guide** on the system board and secure it with the following **screw**.
 - ? M2?4Z BIND screw x1
- 2. Pass the **USB harness** along the guide and connect it to the connector **CN4612** on the system board.

NOTE: When arranging the USB harness and TV tuner harness, be sure to pass the USB harness first so that USB harness is connected to CN9501 without passing across the TV tuner harness.

3. Pass the **TV tuner coaxial cable** and the **TV tuner harness** through the guide and connect them to the connectors on the TV tuner module.

4.15 Heat sink/CPU

Removing the heat sink/CPU

The following describes the procedure for removing the heat sink and CPU (See Figure 4-28 and 4-29).

1. After Removing the following screws, remove the heat sink holder and heat sink.

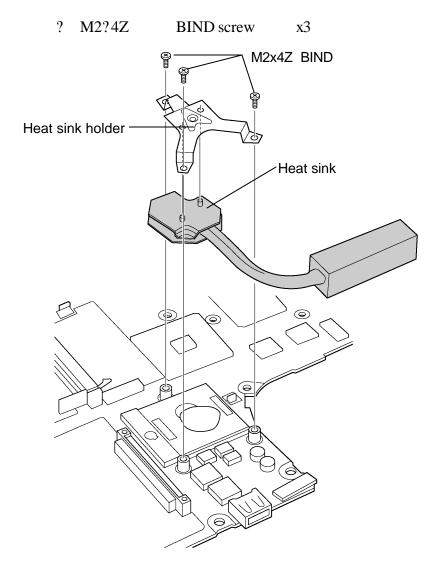


Figure 4-28 Removing the heat sink

- 2. Unlock the **CPU** by rotating the **cam** on the CPU socket 180 degrees to the counterclockwise with a flat-blade screwdriver.
- 3. Remove the **CPU**.

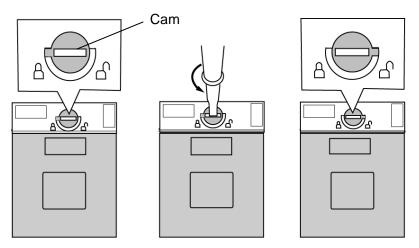


Figure 4-29 Removing the CPU

Installing the heat sink/CPU

The following describes the procedure for installing the heat sink and CPU (See Figure 4-28 to 4-30).

- 1. Check that the mark of cam is in the unlocking position.
- 2. Attach the **CPU** to the correct position in the **CPU socket**.
- 3. Fix the **CPU** by rotating the cam 180 degrees to the clockwise with a flat-blade screwdriver.
- 4. If there is already silicon grease on the CPU, clean it with a cloth. Using a special applicator, apply silicon grease so that the CPU chip on the CPU is completely covered.

NOTE: Apply the silicon grease enough to cover the chip surface using the special applicator.

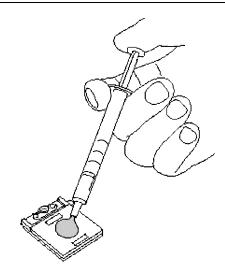


Figure 4-30 Applying silicon grease

- 5. Install the **heat sink** and **heat sink holder** and secure them with the following **screws** in the order of numbers marked on the heat sink holder.
 - ? M2?4Z BIND screw x3

4.16 VGA Heat sink

Removing the VGA heat sink

The following describes the procedure for removing the VGA heat sink (See Figure 4-31).

1. After removing the following screws, remove the VGA heat sink.

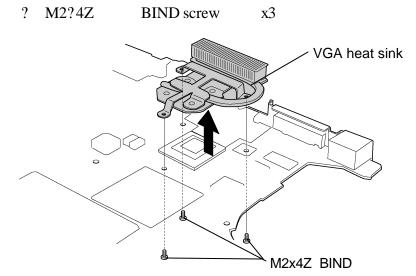


Figure 4-31 Removing the VGA heat sink

Installing the VGA heat sink

The following describes the procedure for installing the VGA heat sink (See Figure 4-30 and 4-31).

If there is already silicon grease on the VGA, clean it with a cloth.
 Using a special applicator, apply silicon grease so that the VGA chip on the VGA is completely covered.

NOTE: Apply the silicon grease enough to cover the chip surface using the special applicator.

- 2. Install the **VGA heat sink** and secure them with the following **screws**.
 - ? M2?4Z BIND screw x3

4.17 PC card cover

Removing the PC card cover

The following describes the procedure for removing the PC card cover (See Figure 4-32).

- 1. Remove the following **screws** securing the PC card cover.
 - ? M2?3Z BIND screw x2
- 2. Open the PC card cover toward the outside to unlatch it from **hooks** and pull up the **PC card cover**.

NOTE: Since the PC card cover is deformed when removing it, you cannot reuse it.

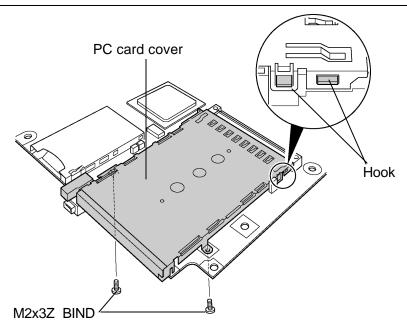


Figure 4-32 Removing the PC card cover

Installing the PC card cover

The following describes the procedure for installing the PC card cover (See Figure 4-32).

- 1. Install the **PC card cover** while locking the **hooks**.
- 2. Secure the PC card cover with the following screws.
 - ? M2?3Z BIND screw x2

4.18 Speaker/VGA fan

Removing the Speaker/VGA fan

The following describes the procedure for removing the speaker and VGA fan (See Figure 4-33).

- 1. Pull out the **speaker cable L** (red cable) under the **insulator** and the glass tapes.
- 2. Remove the **speaker L** from the guide of base assembly.
- 3. Remove the **speaker R** from the guide of base assembly.
- 4. Remove the following **screws** securing the **VGA EARTH SPRINGs** and remove them.
 - 2 M2?3C SUPER THIN HEAD screw x2
- 5. Remove the following screws securing the **VGA fan**.
 - ? M2?4B BIND screw x2
- 6. Remove the VGA fan from the base assembly

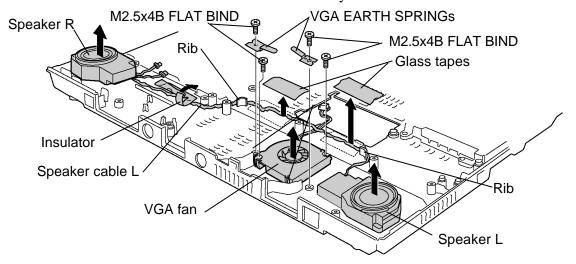


Figure 4-33 Removing the speakers

Installing the Speaker/VGA fan

The following describes the procedure for installing the speaker and VGA fan (See Figure 4-33).

NOTE: When installing speakers, make sure they are fit to the guides closely by pressing them from the top.

Pass the VGA fan cable first on the base assembly so that the speaker (L) cable passes on the cable.

- 1. Install the VGA fan according to screw holes on the base assembly and secure it with the following screws.
 - 2 M2?4B BIND screw x2
- 2. Install the VGA EARTH SPRINGs on the VGA fan and secure them with the following screws.
 - ? M2?3C SUPER THIN HEAD screw x2
- 3. Install the **speaker R** along the guide of the base assembly.
- 4. Install the **speaker L** along the guide of the base assembly.
- 5. Arrange the **speaker cable L** along the ribs and fix it with the insulator and glass tapes.

4.19 Battery latch

Removing the battery latch

The following describes the procedure for removing the battery latch (See Figure 4-34 and 3-35).

- 1. Remove the following screws fixing the battery latch assembly.
 - ? M2?4Z FLAT BIND screw x2
- 2. Slide the battery lock to the arrow direction and push up the battery latch assembly from the bottom side to remove it from the base assembly.

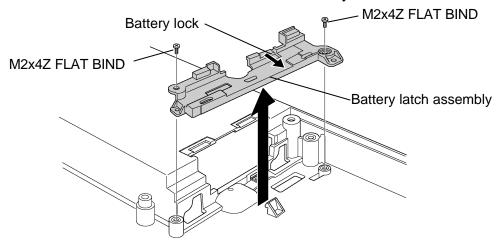


Figure 4-34 Removing the battery latch assembly

- 3. Turn over the **battery latch assembly** and remove the **battery latch** by raising it. Remove the **spring**.
- 4. Remove the **battery lock button**

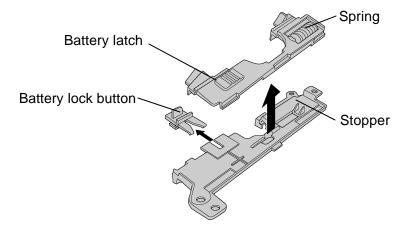


Figure 4-35 Removing the battery latch

Installing the battery latch

The following describes the procedure for installing the battery latch (See Figure 4-34 and 4-35).

- 1. Install the **battery lock button**
- 2. Set the **spring** on the **battery latch** and install the battery latch on the **battery latch** assembly. Make sure the spring is not set over the stopper.
- 3. Install the battery assembly to the base assembly from the HDD side and secure it with the following **screws**.
 - ? M2?4Z FLAT BIND screw x2
- 4. Slide the battery lock to the battery side.
- 5. Make sure the battery latch works smoothly by sliding it from the bottom side.

4.20 Touch pad

Removing the touch pad

The following describes the procedure for removing the touch pad (See Figure 4-36).

- 1. Remove the **glass tape** fixing the touch pad flexible cable.
- 2. Disconnect the **touch pad flat cable** from the touch pad.
- 3. Remove the following **screws** fixing the **touch pad plate** and remove the touch pad plate.
 - ? M2.5?2.8B FLAT BIND screw x4
- 4. Remove the following screws securing the touch pad.
 - ? M2.5?2.8B FLAT BIND screw x2
- 5. Peel off **touch pad** to remove.

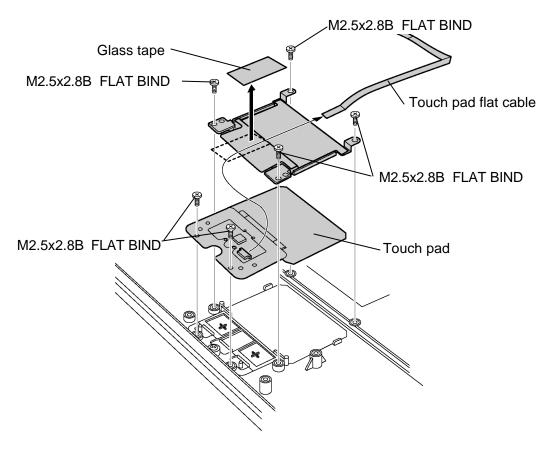


Figure 4-36 Removing the touch pad

Installing the touch pad

The following describes the procedure for installing the touch pad (See Figure 4-36).

NOTE: Do not reuse the touch pad so that it can not be used after peeling off from the computer. Be sure to stick a new touch pad.

- 1. Stick the **touch pad** and secure it with the following **screws**.
 - ? M2.5?2.8B FLAT BIND screw x2
- 2. Install the **touch pad plate** and secure it with the following **screws**.
 - ? M2.5?2.8B FLAT BIND screw x4
- 3. Connect the **touch pad flat cable** to the connector on the touch pad and secure it with a glass tape.

4.21 SJ board

Removing the SJ board

The following describes the procedure for removing the SJ board (See Figure 4-37).

- 1. Disconnect the **microphone cable** from the connector **CN6000** on the SJ board.
- 2. Unlock the connector **CN9560** on the SJ board and disconnect the **SJ board flat** cable from it.
- 3. Remove the following **screw** fixing the SJ board and remove the **SJ board**.
 - ? M2?4Z BIND screw x1
- 4. Remove the glass tape and pull out the **SJ board flat cable** from the **slit** of the middle frame.

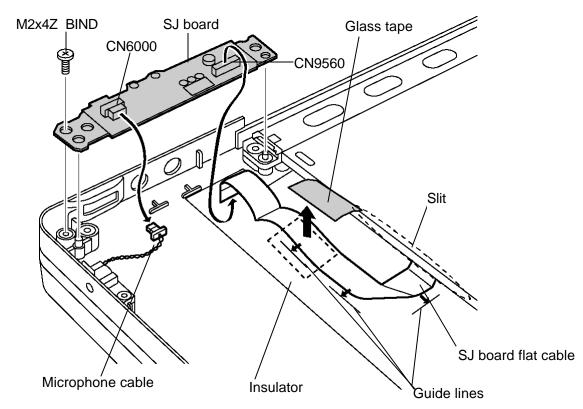


Figure 4-37 Removing the SJ board

Installing the SJ board

The following describes the procedure for installing the SJ board (See Figure 4-37).

- 1. Pass through the **SJ board flat cable** into the **slit** of the middle frame and arrange it along the guide on the insulator. Secure the SJ board flat cable with a glass tape.
- 2. Install the **SJ board** and secure it with the following **screw**.
 - ? M2?4Z BIND screw x1
- 3. Connect the SJ board flat cable to the connector CN9560 on the SJ board.
- 4. Connect the **microphone cable** to the connector **CN6000** on the SJ board.

4.22 Microphone

Removing the microphone

The following describes the procedure for removing the microphone (See Figure 4-38).

- 1. Remove the following **screw** to remove the **microphone hold guide** from the base assembly.
 - ? M2?4Z BIND screw x1
- 2. Detach the **microphone** from the microphone hold guide.
- 3. Detach the **microphone cover** from the microphone.

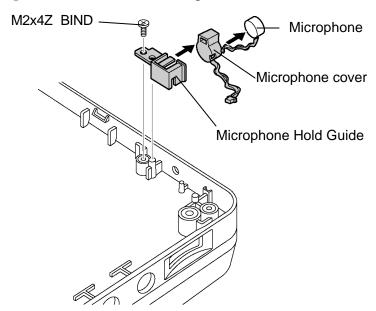


Figure 4-38 Removing the microphone

Installing the microphone

The following describes the procedure for installing the microphone (See Figure 4-38).

- 1. Install the **microphone cover** on the microphone.
- 2. Install the **microphone** to the microphone hold guide.
- 3. Install the **microphone hold guide** along the guide and secure it with the following **screw**.
 - ? M2?4Z BIND screw x1

4.23 LCD unit/FL inverter

Removing the LCD unit/FL inverter

The following describes the procedure for removing the LCD unit and FL inverter (See Figure 4-39 to 4-42).

- 1. Open widely the display panel and pull up both the **hinge caps** to remove by slightly pressing them toward the display.
- 2. Peel off two **mask tapes** and remove the following **screws** securing the display mask.
 - ? M2.5?6B FLAT BIND screw x2
- 3. Insert your fingers between the edge of the display mask and the LCD, and remove the **display mask** while unlatching the display mask.

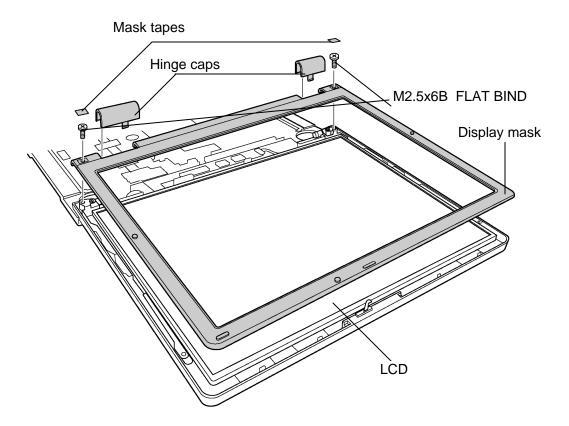


Figure 4-39 Removing the display mask

- 4. Remove the following **screw** fixing the FL inverter.
 - ? M2x4Z SUPER THIN HEAD screw x1
- 5. (for model with wireless LAN or Bluetooth)
 Pull out one **insulator** and peel off the other one adhered to the FL inverter.
- 6. Disconnect the **LCD harnesses** from the connectors **CN1** and **CN2** on the FL inverter.
- 7. Disconnect the **HV harnesses** from the connectors CN3 and CN4 on the FL inverter.
- 8. Remove the **FL inverter** while peeling off the **double-sided tape**.

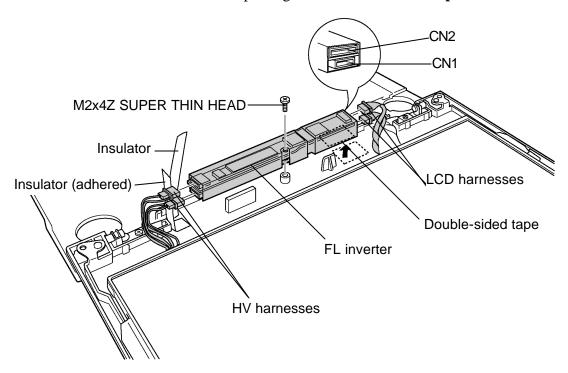


Figure 4-40 Removing the FL inverter

- 9. Remove the following **screws** fixing the LCD unit.
 - ? M2x4Z SUPER THIN HEAD screw x4
- 10. With the bottom edge of the LCD unit on the display cover, lift only the top edge of the LCD unit. After peeling off the **aluminum tape**, disconnect the **LCD harness** from the connector on the back of the LCD unit. Remove the **LCD unit**.

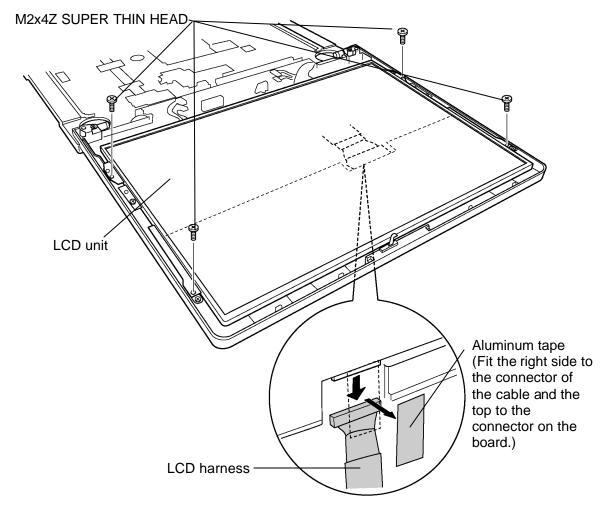


Figure 4-41 Removing the LCD unit

11. Remove the following **screws** to remove the **right and left LCD supports** from the LCD unit.

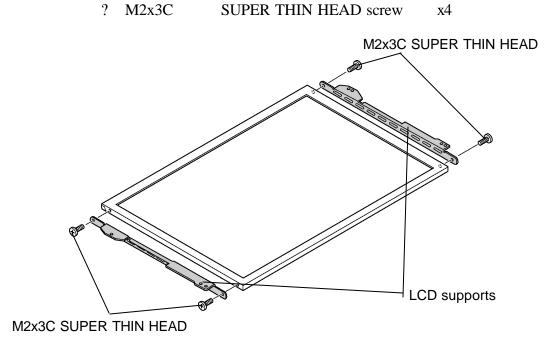


Figure 4-42 Removing the LCD supports

Installing the LCD unit/FL Inverter

The following describes the procedure for installing the LCD unit and FL inverter (See Figure 4-39 to 4-42).

- 1. Secure the **LCD** supports (left and right) to the LCD unit with the following screws.
 - ? M2?3C SUPER THIN HEAD screw x4
- 2. Stand the **LCD unit** on the display cover and connect the LCD harness to the connector on the back of LCD.
- 3. Stick the aluminum tape on the connector of LCD harness.
- 4. Secure the LCD unit with the following **screws**.
 - ? M2?4Z SUPER THIN HEAD screw x4
- 5. Connect **LCD harnesses** to the connector CN1 and CN2 of the FL inverter.

CAUTION: Be careful not to connect the LCD harnesses to the wrong connectors.

- 6. Connect **HV** harnesses to the connector CN3 and CN4 of the FL inverter.
- 7. Install the **FL inverter** while sticking the **double-sided tape** and secure it with the following **screw**.
 - ? M2?4Z SUPER THIN HEAD screw x1
- 8. (for model with wireless LAN or Bluetooth)
 Insert one **insulator** under the LCD unit and stick the other one to the FL inverter.
- 9. Install the **display mask** and lock the latches.

NOTE: When installing the display mask, ensure that there is no gap between the display mask and the display cover.

- 10. Secure the **display mask** with the following **screws** and stick two **mask tapes** on the front.
 - ? M2.5?6B THIN HEAD screw x2
- 11. Install the hinge caps to the both sides.

4.24 Wireless antennas/ LCD harness

4.24.1 Wireless antennas

Removing the wireless antennas

The following describes the procedure for removing the wireless antennas (See Figure 4-44 and 4-44).

- 1. Make sure the wireless LAN antenna cables are pulled on the middle frame. (Refer to 4.8 Display assembly.)
- 2. Turn up the **insulators** and pull out the **bluetooth antenna cable** from the guide of middle frame.

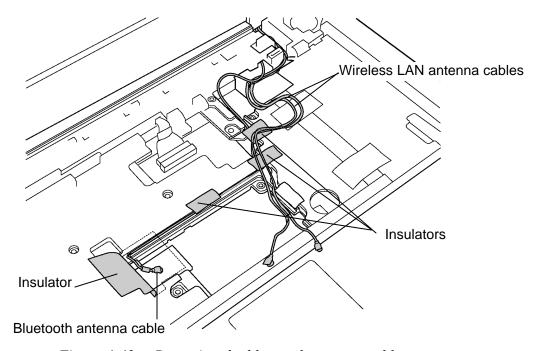


Figure 4-43 Removing the bluetooth antenna cables

3. Peel off the glass tapes fixing the wireless LAN antenna cables and bluetooth antenna cable and peel off the **wireless LAN antennas** and **bluetooth antenna** from the display cover.

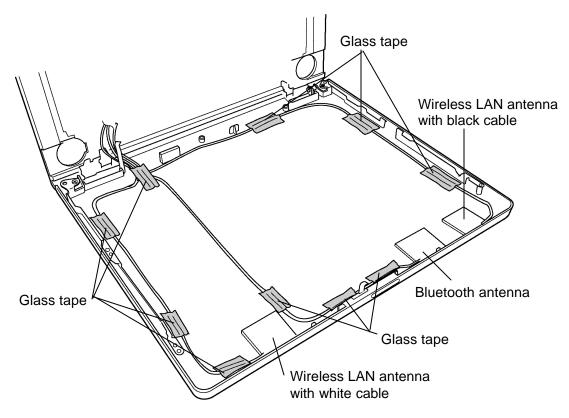


Figure 4-44 Removing the wireless antennas

Installing the wireless antennas

The following describes the procedure for installing the wireless LAN antenna (See Figure 4-43 and 4-44).

- 1. Stick the **wireless LAN antennas** and **bluetooth antenna** on the display cover according to the guide lines.
- 2. Arrange the **wireless LAN antenna cables** and **blutooth antenna cable** on the display cover and fix it with the **glass tapes**.
- 3. Draw out the wireless LAN antenna cables on the middle frame.
- 4. Arrange the **bluetooth antenna cable** along the guide of middle frame and fix it with the **insulators**.

4.24.2 LCD harness

Removing the LCD harness

The following describes the procedure for removing LCD harness (See Figure 4-45 and 4-46).

1. Remove the following **screw** securing the LCD harness holder and remove the **LCD harness holder** (display cover side).

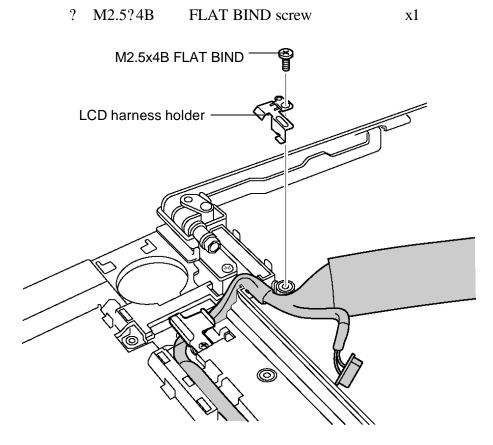


Figure 4-45 Removing the LCD harness holder (display cover side)

- 2. Remove the following **screw** securing the LCD harness holder and remove the **LCD harness holder** (middle frame side).
 - ? M2.5?2.8B

FLAT BIND screw

x1

3. Remove the **LCD harness** from the guide.

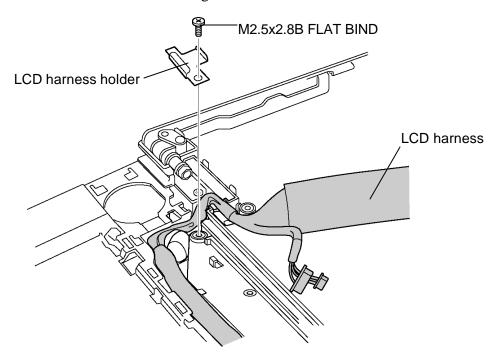


Figure 4-46 Removing the LCD harness holder (middle frame side)

Installing the LCD harness

The following describes the procedure for installing the LCD harness (See Figure 4-45 and 4-46).

- 1. Arrange the **LCD harness** to the guide.
- 2. Install the **LCD harness holder (middle frame side)** and secure it with the following **screw**.
 - ? M2.5?2.8B

FLAT BIND screw

x1

- 3. Attach the **LCD harness holder (display cover side)** and secure it with the following **screw**.
 - ? M2.5?4B

FLAT BIND screw

x1

4.25 Hinge

Removing the Hinge

The following describes the procedure for removing hinge (See Figure 4-47 to 4-49).

1. Remove the following **screws** securing the display cover and detach the **display cover**.

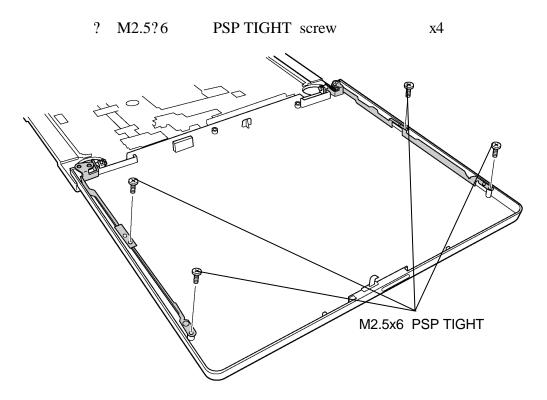


Figure 4-47 Removing the display cover

2. Remove the following **screws** and remove the **hinges** (display cover side).

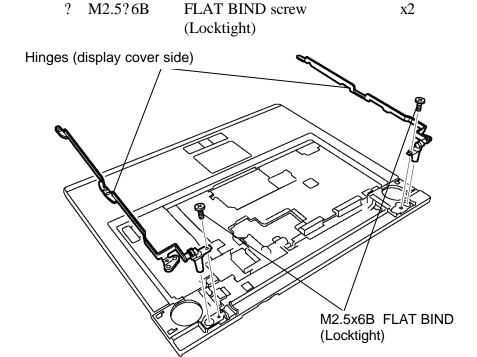


Figure 4-48 Removing the hinge (display cover side)

3. Remove the following **screws** and remove the **hinges** (middle frame side).

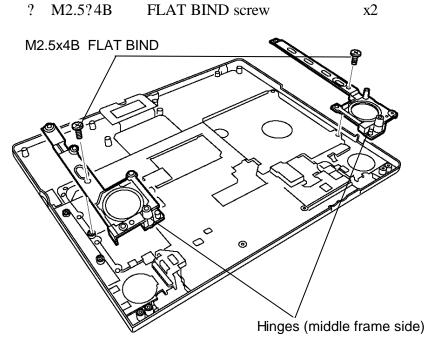


Figure 4-49 Removing the hinge (middle frame side)

Installing the Hinge

The following describes the procedure for installing the hinge (See Figure 4-47 to 4-49).

- 1. Install the **hinges** (**middle frame side**) on the back side of the middle frame and secure them with the following **screws**.
 - ? M2.5?4B FLAT BIND screw x2
- 2. Install the **hinges** (**display cover side**) and secure them with the following **screws** after applying the locktight.

NOTE: Be sure to apply the locktight to the screws specified in the figure.

- ? M2.5?6B FLAT BIND screw x2 (Locktight)
- 3. Install the display cover and secure it with the following screws.
 - ? M2.5?6 PSP TIGHT screw x4

4.26 Fluorescent lamp

This system uses the following LCD module.

Туре	Part No.	Supplier	Section
15.4 inch (W-XGA)	G33C0002A110	Samsung	4.26.1

NOTE: - When working with a LCD module, always use a flat, grounded table.

- Handle the backlight unit in the environment without dust, such as on the clean bench. Keep the worktable free from any screws or other material that may scratch the LCD surface.
- Use an anti-static or protective sheet.
- When replacing the FL unit, cover with a finger protector or similar to prevent dirtying or scratching the LCD panel.
- Take care when handling the lamp. Excessive force may break the lamp.
- Ensure always that the power of the LCD module is turned off before connecting or disconnecting cables and connectors.

4.26.1 Replacing the 15.4-inch (W-XGA) Samsung fluorescent lamp

Removing the 15.4-inch W-XGA Samsung fluorescent lamp

To remove the 15.4-inch W-XGA Samsung Fluorescent Lamp, follow the steps below and refer to Figures 4-50 to 4-54.

The fluorescent lamp is assembled in the backlight unit. To replace the fluorescent lamp, replace the backlight unit.

1. Turn the LCD module face down, and remove the PCB cover.

CAUTION: Be careful not to damage the COF and ICs when removing the PCB cover.

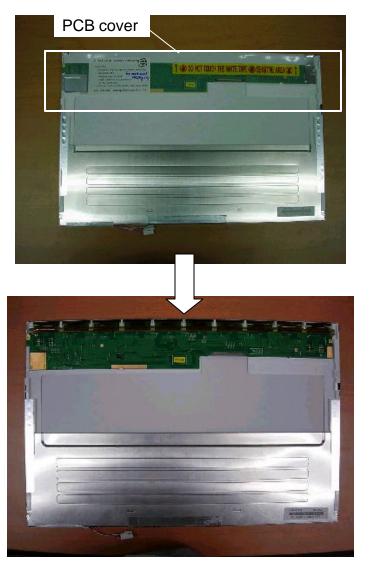


Figure 4-47 Replacing Sharp fluorescent lamp (W-XGA) (1)

2. Remove aluminum tapes stuck on the right and left sides.

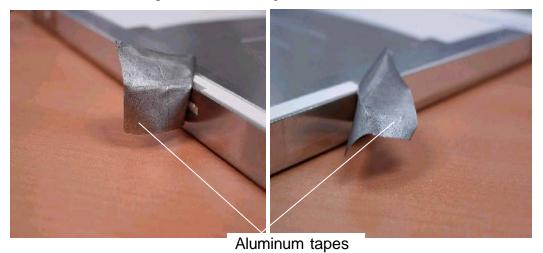


Figure 4-48 Replacing Sharp fluorescent lamp (W-XGA) (2)

3. Remove the lamp wire tape and the aluminum tape stuck on the bottom.

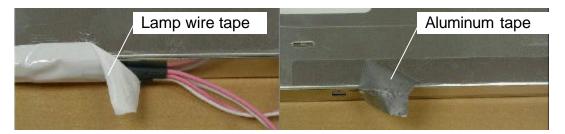


Figure 4-49 Replacing Sharp fluorescent lamp (W-XGA) (3)

4. Unlatch the hooks on the bottom first and then the hooks on the right and left sides to remove the top chassis from the middle frame.

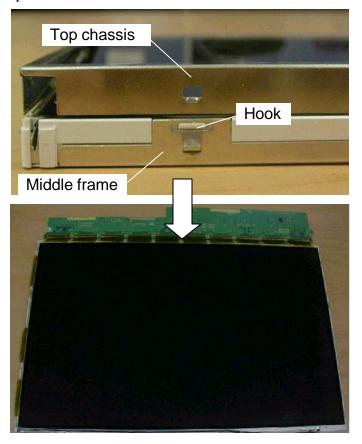


Figure 4-50 Replacing Sharp fluorescent lamp (W-XGA) (4)

5. Remove the panel assembly from the backlight unit.

CAUTION: Be careful not to damage the COF and ICs when removing the panel assembly.

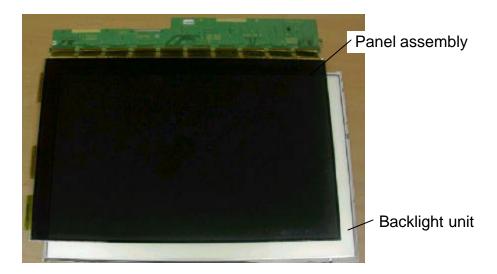


Figure 4-51 Replacing Sharp fluorescent lamp (W-XGA) (6)

Assembling the 15.4-inch W-XGA Samsung fluorescent lamp

The assembly procedure is the reverse of the above disassembly procedure.

Appendices

Appendix Contents

Appendix A	Handling the LCD Module	
Appendix B	Board Layout	B-1
B.1	System Board Front View	B-1
B.2	System Board Back View	B-3
B.3	SD Board Front View	B-5
B.4	SD Board Back View	B-6
B.5	SJ Board Front View	B-7
B.6	SJ Board Back View	B-8
Appendix C	Pin Assignment	C-1
System Board	l (FCLSY*)	
C.1	CN1800 HDD I/F connector (44-pin)	
C.2	CN1820 ODD I/F connector (50-pin)	
C.3	CN2110 PC card I/F connector (70-pin)	
C.4	CN3230 Keyboard I/F connector (34-pin)	C-4
C.5	CN4400 Bluetooth I/F connector (20-pin)	
C.6	CN8810 1st battery connector (10-pin)	
C.7	CN8490 RTC battery connector (3-pin)	
C.8	CN8770 FAN connector (3-pin)	
C.9	CN8780 FAN connector (for VGA) (3-pin)	C-6
C.10	CN4611 USB connector 0 (port 0) (4-pin)	
C.11	CN4612 USB I/F Relay connector (8-pin)	
C.12	CN4630 USB connector 1 (port 2) (4-pin)	
C.13	CN4631 USB connector 2 (port 3) (4-pin)	
C.14	CN8800 DC IN connector (4-pin)	
C.15	CN9500 Sound board I/F connector (50-pin)	C-8
C.16	CN9650 SWITCH I/F connector (20-pin)	C-9
C.17	J4100 Network I/F connector (12-pin)	C-9

C.18	CN4200	1394 I/F connector (4-pin)	
C.19	IS2101	MEDIA BRIDGE I/F connector (42-pin)	C-10
C.20	CN1400	Memory connector A (200-pin)	C-11
C.21	CN1401	Memory connector B (200-pin)	C-14
C.22	CN2200	Mini PCI I/F connector (124-pin)	
C.23	CN2400	WW Tuner I/F connector (124-pin)	C-19
C.24	CN3201	PAD I/F connector (4-pin)	
C.25	PJ5600	LCD I/F connector (41-pin)	
C.26	CN5080	CRT I/F connector (15-pin)	
C.27	CN5501	S-video I/F connector (4-pin)	
C.28	CN3400	Debug port (4-pin)	
C.29	CN5502	D-video I/F connector (14-pin)	
C.30	CN5801	TV Input connector (14-pin)	
SD Board (F	CLSD*)		
C.31	CN3000	MDC I/F connector (30-pin)	
C.32	CN4620	USB I/F Relay connector (8-pin)	
C.33	CN4621	USB I/F connector (port 4) (4-pin)	
C.34	CN6002	Speaker (left) connector (3-pin)	
C.35	CN6003	Speaker (right) connector (2-pin)	
C.36	CN9550	Sound jack board I/F connector (21-pin)	
C.37	CN9510	System board I/F connector (50-pin)	
C.38	J2410	TV Antenna connector (4-pin)	
C.39	CN2410	Coaxial connector (4-pin)	
C.40	J9612	Composite-in connector (5-pin)	
C.41	CN9613	S-video connector (4-pin)	
C.42	CN9614	TV-tuner connector (12-pin)	
C.43	CN9615	SVP connector (14-pin)	
SJ board (FC	LSJ*)		
C.44	CN6000	Internal Microphone I/F connector (2-pin)	
C.45	J6001	External Microphone I/F connector (6-pin)	C-30
C.46	DS6000	Headphone connector (8-pin)	C-30
C.47	CN9560	Sound board I/F connector (21-pin)	C-31

Appendix D	Keyboard Scan/Character Codes	
Appendix E	Key Layout	E-1
E.1	Keyboard Layout	E-1
Appendix F	Wiring Diagrams	F-1
F.1	LAN Loopbak Connector	F-1
Appendix G	BIOS Rewrite Procedures	. G-1
Appendix H	EC/KBC Rewrite Procedures	. H-1
Appendix I	Reliability	I-1

Figures

Figure B-1	System board layout (front)	B-1
Figure B-2	System board layout (back)	B-3
Figure B-3	SD board layout (front)	B-5
Figure B-4	SD board layout (back)	B-6
Figure B-5	SJ board layout (front)	B-7
Figure B-6	SJ board layout (back)	B-8
Figure E-1	Keyboard layout (for US)	E-1
Figure E-2	Keyboard layout (for UK)	E-1
Figure F-1	LAN loopback connector	F-1
Tables		
Table B-1	System board ICs and connectors (front)	B-2
Table B-2	System board ICs and connectors (back)	B-4
Table B-3	SD board connectors (front)	B-5
Table B-4	SD board connectors (back)	B-6
Table B-5	SJ board connectors (front)	B-7
Table B-6	SJ board connectors (back)	B-8
Table C-1	HDD I/F connector (44-pin)	C-1
Table C-2	ODD I/F connector (50-pin)	
Table C-3	PC card I/F connector (70-pin)	C-3
Table C-4	Keyboard I/F connector (34-pin)	
Table C-5	Bluetooth I/F connector (20-pin)	
Table C-6	1st battery connector (10-pin)	
Table C-7	RTC battery connector (3-pin)	
Table C-8	FAN connector (3-pin)	C-6
Table C-9	FAN connector (for VGA) (3-pin)	

Table C-10	USB connector 0 (port 0) (4-pin)	C-6
Table C-11	USB I/F Relay connector (8-pin)	C-7
Table C-12	USB connector 1 (port 2) (4-pin)	C-7
Table C-13	USB connector 2 (port 3) (4-pin)	C-7
Table C-14	DC IN connector (4-pin)	C-7
Table C-15	Sound board I/F connector (50-pin)	C-8
Table C-16	SWITCH I/F connector (20-pin)	C-9
Table C-17	Network I/F connector (12-pin)	C-9
Table C-18	1394 I/F connector (4-pin)	C-10
Table C-19	MEDIA BRIDGE I/F connector (42-pin)	C-10
Table C-20	Memory connector A (200-pin)	C-11
Table C-21	Memory connector B (200-pin)	C-14
Table C-22	Mini PCI I/F connector (124-pin)	C-17
Table C-23	WW Tuner I/F connector (124-pin)	C-19
Table C-24	PAD I/F connector (4-pin)	C-21
Table C-25	LCD I/F connector (41-pin)	C-21
Table C-26	CRT I/F connector (15-pin)	C-22
Table C-27	S-video I/F connector (4-pin)	C-22
Table C-28	Debug port (4-pin)	C-22
Table C-29	D-video I/F connector (14-pin)	C-23
Table C-30	TV Input connector (14-pin)	C-23
Table C-31	MDC I/F connector (30-pin)	C-24
Table C-32	USB I/F Relay connector (8-pin)	C-24
Table C-33	USB I/F connector (port 4) (4-pin)	C-25
Table C-34	Speaker (left) connector (3-pin)	C-25
Table C-35	Speaker (right) connector (2-pin)	C-25
Table C-36	Sound jack board I/F connector (21-pin)	C-26
Table C-37	System board I/F connector (50-pin)	C-27
Table C-38	TV Antenna connector (4-pin)	C-28
Table C-39	Coaxial connector (4-pin)	C-28
Table C-40	Composite-in connector (5-pin)	C-28
Table C-41	S-video connector (4-pin)	C-28

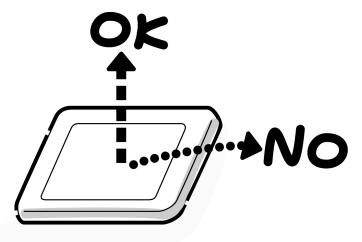
Table C-42	TV-tuner connector (12-pin)	C-29
Table C-43	SVP connector (14-pin)	C-29
Table C-44	Internal Microphone I/F connector (2-pin)	C-30
Table C-45	External Microphone I/F connector (6-pin)	
Table C-46	Headphone connector (8-pin)	
Table C-47	Sound board I/F connector (21-pin)	
Table D-1	Display codes	D-1
Table D-2	Scan codes with left shift key	D-5
Table D-3	Scan codes with Numlock mode	D-6
Table D-4	Scan codes with Fn key	D-6
Table D-5	Scan codes in overlay mode	D-7
Table D-6	No. 124 key scan code	D-7
Table D-7	No. 126 key scan code	D-8
Table H-1	MTBF	H-1

Appendix A Handling the LCD Module

Precautions for handling the LCD module

The LCD module can be easily damaged during assembly or disassembly. Observe the following precautions when handling the LCD module:

1. When installing the LCD module in the LCD cover, be sure to seat it so that it is properly aligned and maximum visibility of the display is maintained.



2. Be careful to align the holes at the four corners of the LCD module with the corresponding holes in the LCD cover before securing the module with screws. Do not force the module into place, because stress can affect its performance.

Also, the panel's polarized surface is easily scarred, so be careful when handling it.





3. If the panel's surface gets dirty, wipe it with cotton or a soft cloth. If it is still dirty, try breathing on the surface to create a light condensate and wipe it again.

If the surface is very dirty, we recommend a CRT cleaning agent. Apply the agent to a cloth and then wipe the panel's surface. Do not apply cleanser directly to the panel.



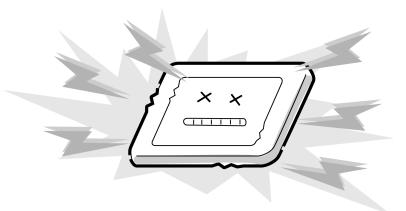
4. If water or other liquid is left on the panel's surface for a long period, it can change the screen's tint or stain it. Be sure to quickly wipe off any liquid.



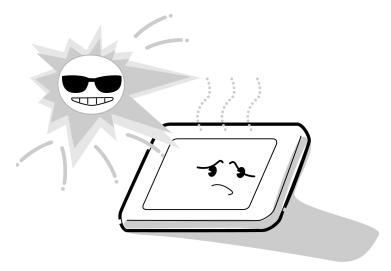
5. Glass is used in the panel, so be careful not to drop it or let it strike a hard object, which could cause breakage or cracks.



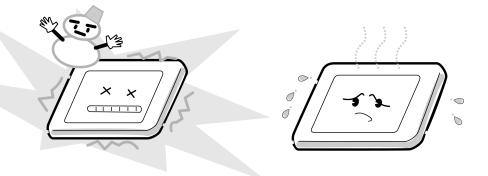
6. CMOS-LSI circuits are used in the module, so guard against damage from electrostatic discharge. Be sure to wear a wrist or ankle ground when handling the module.



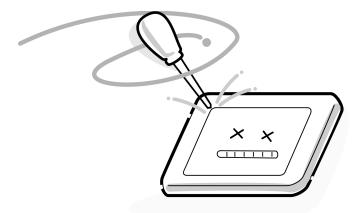
7. Do not expose the module to direct sunlight or strong ultraviolet rays for long periods.



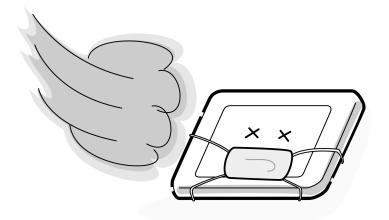
8. Do not store the module at temperatures below specifications. Cold can cause the liquid crystals to freeze, lose their elasticity or otherwise suffer damage.



9. Do not disassemble the LCD module. Disassembly can cause malfunctions.



10. If you transport the module, do not use packing material that contains epoxy resin (amine) or silicon glue (alcohol or oxide). These materials can release gas that can damage the panel's polarization.



Appendix B Board Layout

B.1 System Board Front View

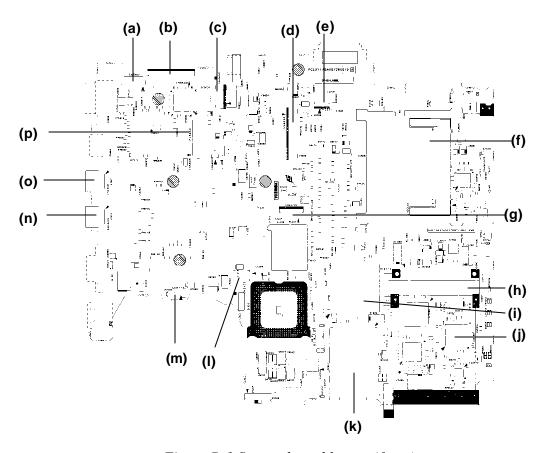


Figure B-1 System board layout (front)

Table B-1 System board ICs and connectors (front)

Mark	Number	Name
(a)	CN5801	TV Input connector
(b)	CN9500	SD board I/F connector
(c)	CN9650	SWITCH I/F connector
(d)	CN3230	Keyboard I/F connector
(e)	CN3201	PAD I/F connector
(f)	CN2200	Mini PCI I/F connector
(g)	CN4400	Bluetooth I/F connector
(h)	CN2110	PC card I/F connector
(i)	IC1600	ICH4-M
(j)	IC3200	EC/KBC
(k)	IS2101	MEDIA BRIDGE I/F connector
(I)	CN3400	Debug port
(m)	CN8770	FAN connector
(n)	CN4630	USB connector 1
(o)	CN4631	USB connector 2
(p)	PJ5600	LCD I/F connector

B.2 System Board Back View

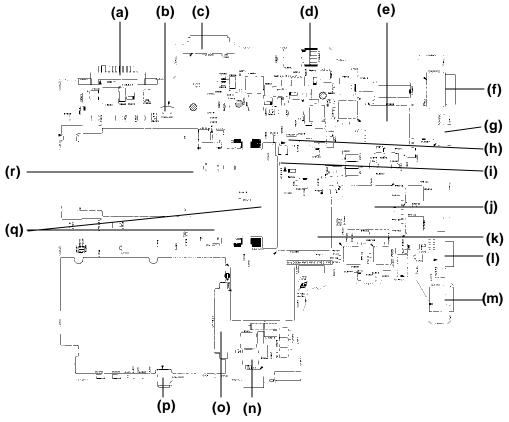


Figure B-2 System board layout (back)

Table B-2 System board ICs and connectors (back)

Mark	Number	Name
(a)	CN8810	1st battery connector
(b)	CN8490	RTC battery connector
(c)	CN1820	ODD I/F connector
(d)	CN8800	DC IN connector
(e)	IC5800	SVP MEM I/F
(f)	CN5502	D-video I/F connector
(g)	CN5501	S-video I/F connector
(h)	CN4612	USB I/F Relay connector
(i)	CN8780	VGA FAN connector
(j)	IC5000	NV36
(k)	IC1200	Odem+
(I)	CN5080	CRT I/F connector
(m)	J4100	Network I/F connector
(n)	CN4611	USB connector 0
(o)	CN1800	HDD I/F connector
(p)	CN4200	1394 I/F connector
(q)	CN1400, CN1401	Memory connector A, B
(r)	CN2400	WW Tuner I/F connector

B.3 SD Board Front View

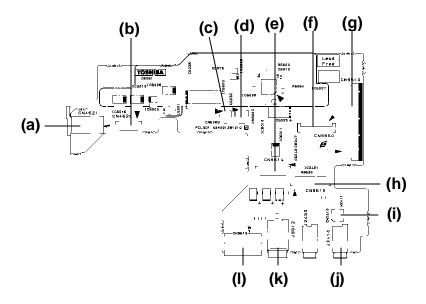


Figure B-3 SD board layout (front)

Table B-3 SD board connectors (front)

Mark	Number	Name	
(a)	CN4621	USB I/F connector	
(b)	CN4620	USB I/F relay connector	
(c)	CN6003	Speaker (right) connector	
(d)	CN6002	Speaker (left) connector	
(e)	CN9614	TV-tuner connector	
(f)	CN9550	SJ board I/F connector	
(g)	CN9510	System board I/F connector	
(h)	CN9615	SVP connector	
(i)	CN2410	Coaxial connector	
(j)	J2410	TV Antenna connector	
(k)	J9612	Composite-in connector	
(I)	CN9613	S-video connector	

B.4 SD Board Back View

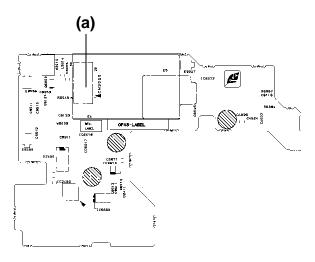


Figure B-4 SD board layout (back)

Table B-4 SD board connectors (back)

Mark	Number	Name
(a)	CN3000	MDC I/F connector

B.5 SJ Board Front View

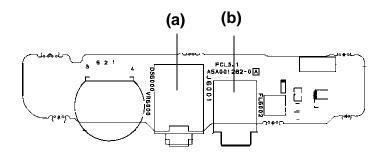


Figure B-5 SJ board layout (front)

Table B-5 SJ board connectors (front)

Mark	Number	Name			
(a)	DS6000	Headphone connector			
(b)	J6001	External Microphone I/F connector			

B.6 SJ Board Back View

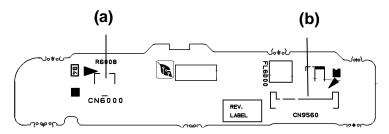


Figure B-6 SJ board layout (back)

Table B-6 SJ board connectors (back)

Mark	Number	Name			
(a)	CN6000	Internal microphone connector			
(b)	CN9560	SD board I/F connector			

Appendix C Pin Assignment

System Board (FCLSY*)

C.1 CN1800 HDD I/F connector (44-pin)

Table C-1 HDD I/F connector (44-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	IDRSTA-P5N	I/O	2	GND	-
3	PDD07-P3P	I/O	4	PDD08-P3P	I/O
5	PDD06-P3P	I/O	6	PDD09-P3P	I/O
7	PDD05-P3P	I/O	8	PDD10-P3P	I/O
9	PDD04-P3P	I/O	10	PDD11-P3P	I/O
11	PDD03-P3P	I/O	12	PDD12-P3P	I/O
13	PDD02-P3P	I/O	14	PDD13-P3P	I/O
15	PDD01-P3P	I/O	16	PDD14-P3P	I/O
17	PDD00-P3P	I/O	18	PDD15-P3P	I/O
19	GND	-	20	N.C	-
21	PDDREQ-P3P	I	22	GND	-
23	PDIOW-P3N	- 1	24	GND	-
25	PDIOR-P3N	I	26	GND	-
27	PIORDY-P3P	I	28	GND	-
29	PDDACK-P3N	- 1	30	GND	-
31	IRQ14-P3P	- 1	32	N.C	-
33	PDA1-P3P	I	34	N.C	-
35	PDA0-P3P	I	36	PDA2-P3P	0
37	PDCS1-P3N	I	38	PDCS3-P3N	0
39	HDDLED-P5N	I	40	GND	-
41	P5V	-	42	P5V	-
43	GND	-	44	N.C	-

C.2 CN1820 ODD I/F connector (50-pin)

Table C-2 ODD I/F connector (50-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	CDAUDL-PXP	I	2	CDAUDR- PXP	I
3	CD-GND	1	4	N.C	-
5	IDRSTB-P5N	0	6	SDD08-P3P	I/O
7	SDD07-P3P	I/O	8	SDD09-P3P	I/O
9	SDD06-P3P	I/O	10	SDD10-P3P	I/O
11	SDD05-P3P	I/O	12	SDD11-P3P	I/O
13	SDD04-P3P	I/O	14	SDD12-P3P	I/O
15	SDD03-P3P	I/O	16	SDD13-P3P	I/O
17	SDD02-P3P	I/O	18	SDD14-P3P	I/O
19	SDD01-P3P	I/O	20	SDD15-P3P	I/O
21	SDD00-P3P	I/O	22	SDDREQ-P3P	I
23	GND	-	24	SDIOR-P3N	0
25	SDIOW-P3N	0	26	GND	-
27	SIORDY-P3P	- 1	28	SDDACK-P3N	0
29	IRQ15-P3P	- 1	30	N.C	-
31	SDA1-P3P	0	32	N.C	0
33	SDA0-P3P	0	34	SDA2-P3P	0
35	SDCS1-P3N	0	36	SDCS3-P3N	0
37	N.C	-	38	P5V	-
39	P5V	-	40	P5V	-
41	P5V	-	42	P5V	-
43	GND	-	44	GND	-
45	GND	-	46	N.C	-
47	N.C	-	48	GND	-
49	N.C	-	50	N.C	-

C.3 CN2110 PC card I/F connector (70-pin)

Table C-3 PC card I/F connector (70-pin) (1/2)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND	-	2	ACAD00-EYP	I/O
3	ACAD01-EYP	I/O	4	ACAD03-EYP	I/O
5	ACAD05-EYP	I/O	6	ACAD07-EYP	I/O
7	ACCBEO-EYN	I/O	8	ACAD09-EYP	I/O
9	ACAD11-EYP	I/O	10	ACAD12-EYP	I/O
11	ACAD14-EYP	I/O	12	ACCBE1-EYN	I/O
13	ACPAR-EYP	I/O	14	ACPERR-EYN	I/O
15	ACGNT-EYN	I/O	16	ACINT-EYN	I/O
17	MCVCCA-EYV	I/O	18	MCVPPA-EYV	I/O
19	ACCLK-EYP	I/O	20	ACIRDY-EYN	I/O
21	ACCBE2-EYN	I/O	22	ACAD18-EYP	I/O
23	ACAD20-EYP	I/O	24	ACAD21-EYP	I/O
25	ACAD22-EYP	I/O	26	ACAD23-EYP	I/O
27	ACAD24-EYP	I/O	28	ACAD25-EYP	I/O
29	ACAD26-EYP	I/O	30	ACAD27-EYP	I/O
31	ACAD29-EYP	I/O	32	ACD02-EYP	I/O
33	ACCLKR-EYN	I/O	34	GND	-
35	GND	-	36	ACCD1-E3N	I/O
37	ACAD02-EYP	I/O	38	ACAD04-EYP	I/O
39	ACAD06-EYP	I/O	40	ACD14-EYP	I/O
41	ACAD08-EYP	I/O	42	ACAD10-EYP	I/O
43	ACVS1-E3P	I/O	44	ACAD13-EYP	I/O
45	ACAD15-EYP	I/O	46	ACAD16-EYP	I/O
47	ACA18-EYP	I/O	48	ACLOCK-EYN	I/O
49	ACSTOP-EYN	I/O	50	ACDEVS-EYN	I/O

PIN No. I/O PIN No. Signal name Signal name 1/0 51 MCVCCA-EYV 1 52 MCVPPA-EYV I/O 53 ACTRDY-EYN I/O 54 ACFRAM-EYN I/O ACAD17-EYP I/O ACAD19-EYP I/O 55 56 ACVS2-E3P I/O I/O 57 58 ACRST-EYN I/O 59 ACSERR-EYN I/O 60 ACREQ-EYN I/O ACCBE3-EYN 62 ACAUDI-EYP 1 61 63 ACSTSC-EYP Т 64 ACAD28-EYP I/O ACAD30-EYP I/O ACAD31-EYP 65 66 I/O ACCD2-E3N **GND** 67 Τ 68 **GND** 69 70 **GND**

Table C-3 PC card I/F connector (70-pin) (2/2)

C.4 CN3230 Keyboard I/F connector (34-pin)

Table C-4 Keyboard I/F connector (34-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	NUMLED-P5N	1	2	ARWLED-P5N	I
3	CAPLED-P5N	1	4	P5V	-
5	KBSC00-S3N	0	6	KBSC01-S3N	0
7	KBSC02-S3N	0	8	KBSC03-S3N	0
9	KBSC04-S3N	0	10	KBSC05-S3N	0
11	KBSC06-S3N	0	12	KBRT00-S3N	0
13	KBSC07-S3N	0	14	KBSC08-S3N	0
15	KBSC09-S3N	0	16	KBRT01-S3N	0
17	KBRT02-S3N	0	18	KBRT03-S3N	0
19	KBSC10-S3N	0	20	KBSC11-S3N	0
21	KBRT04-S3N	0	22	KBRT05-S3N	0
23	KBSC12-S3N	0	24	KBSC13-S3N	0
25	KBRT06-S3N	0	26	KBRT07-S3N	0
27	KBSC14-S3N	0	28	KBSC15-S3N	0
29	P5V	-	30	N.C	-
31	N.C	-	32	N.C	-
33	N.C	-	34	P5V	-

C.5 CN4400 Bluetooth I/F connector (20-pin)

Table C-5 Bluetooth I/F connector (20-pin)

PIN No.	Signal na me	I/O	PIN No.	Signal name	I/O
1	GND	-	2	N.C.	-
3	BTMDL-P3N	0	4	N.C.	-
5	N.C.	-	6	N.C.	-
7	N.C.	-	8	BTRST-S3N	ı
9	N.C.	-	10	N.C.	-
11	GND	-	12	N.C.	-
13	GND	-	14	WCHCLK- P3P	0
15	N.C.	-	16	USBP5-S3P	I/O
17	USBP5-S3N	I/O	18	WCHDAT- P3P	I
19	N.C.	-	20	BT-P3V	I

C.6 CN8810 1st battery connector (10-pin)

Table C-6 1st battery connector (10-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	1/0
1	(+)	0	2	BTMP1	0
3	(DCHG)	0	4	M5V	-
5	PSCL-S5P	I/O	6	PSDA-S5P	I/O
7	GND	-	8	DBT10V-S5N	0
9	GND	-	10	GND	-

C.7 CN8490 RTC battery connector (3-pin)

Table C-7 RTC battery connector (3-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	1/0
1	R3V	0	2	N.C	-
3	GND	-			

C.8 CN8770 FAN connector (3-pin)

Table C-8 FAN connector (3-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	FAN VCC	1	2	GND	-
3	FANG0-P3P	1			

C.9 CN8780 FAN connector (for VGA) (3-pin)

Table C-9 FAN connector (for VGA) (3-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	FAN VCC (VGA)	I	2	GND	-
3	FANG1-P3P	I			

C.10 CN4611 USB connector 0 (port 0) (4-pin)

Table C-10 USB connector 0 (port 0) (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	USB1PS-E5V	1	2	USBP0-S3N	I/O
3	USBP0-S3P	I/O	4	GND	-

C.11 CN4612 USB I/F Relay connector (8-pin)

Table C-11 USB I/F Relay connector (8-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	USB1PS-E5V	1	2	USB1PS-E5V	I
3	USBP4-S3N	I/O	4	USBP4-S3P	I/O
5	GND	-	6	GND	-
7	GND	-	8	N.C.	-

C.12 CN4630 USB connector 1 (port 2) (4-pin)

Table C-12 USB connector 1 (port 2) (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	USB0PS-E5V	1	2	USBP2-S3N	I/O
3	USBP2-S3P	I/O	4	GND	-

C.13 CN4631 USB connector 2 (port 3) (4-pin)

Table C-13 USB connector 2 (port 3) (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	USB0PS-E5V	1	2	USBP3-S3N	I/O
3	USBP3-S3P	I/O	4	GND	-

C.14 CN8800 DC IN connector (4-pin)

Table C-14 DC IN connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND	-	2	GND	-
3	(DCIN)	0	4	(DCIN)	0

C.15 CN9500 Sound board I/F connector (50-pin)

Table C-15 Sound board I/F connector (50-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	CD-GND	-	2	CDAUDL-PXP	I
3	CD-GND	-	4	CDAUDR-PXP	I/O
5	CD-GND	-	6	SND-GND	-
7	SND-GND	-	8	SND-GND	-
9	SND-GND	-	10	SND-GND	-
11	ATBEEP-P3P	1	12	PCBEEP-E3P	ı
13	SND-P5V	-	14	SND-P5V	-
15	SND-P5V	-	16	SND-P5V	-
17	SND-P5V	-	18	AMPSD-S3N	ı
19	P3V	-	20	P3V	-
21	SNDMUT-S3N	1	22	GND	-
23	X14SND-P3P	I/O	24	GND	-
25	M97SY1-P3P	- 1	26	GND	-
27	M97OT1-P3P	1	28	GND	-
29	M97RS1-P3N	1	30	GND	-
31	M97BC1-P3P	1	32	GND	-
33	M97IN1-P3P	1	34	E3V	-
35	E3V	-	36	M97SY2-P3P	I
37	GND	-	38	M97OT2-P3P	I
39	GND	-	40	M97RS2-S3N	ı
41	GND	-	42	M97IN2-E3P	I
43	GND	-	44	SUSCLK	ı
45	GND	-	46	SVSCL-P3P	I/O
47	SVSDA-P3P	I/O	48	FMSTS0-P3P	0
49	VOLBYP-P3N	I/O	50	SPKON-P3N	I/O

C.16 CN9650 SWITCH I/F connector (20-pin)

Table C-16 SWITCH I/F connector (20-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	PBLEDO-S3P	- 1	2	M5V	-
3	PBLEDB-S3P	1	4	PBLEDG-S3P	I
5	PWRSW-S3N	1	6	TVBTN-S3N	I
7	CDBTN-S3N	1	8	GND	-
9	GND	-	10	KBRT00-S3N	I
11	KBRT01-S3N	1	12	KBRT02-S3N	I
13	KBSC16-S3N	- 1	14	KBRT03-S3N	I
15	KBRT04-S3N	- 1	16	KBRT05-S3N	I
17	KBRT06-S3N	1	18	KBRT07-S3N	I
19	PNLOFF-S3N	I	20	N.C.	-

C.17 J4100 Network I/F connector (12-pin)

Table C-17 Network I/F connector (12-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TDP-P3P	1	2	TDN-P3N	1
3	RDP-P3P	1	4	GND	-
5	GND	-	6	RDN-P3N	I/O
7	GND	-	8	GND	-
9	P3V	-	10	LNK-P3N	I/O
11	P3V	-	12	ACT-P3N	I/O

C.18 CN4200 1394 I/F connector (4-pin)

Table C-18 1394 I/F connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TPB0-E3N	I/O	2	TPB0-E3P	I/O
3	TPA0-E3N	I/O	4	TPA0-E3P	I/O

C.19 IS2101 MEDIA BRIDGE I/F connector (42-pin)

Table C-19 MEDIA BRIDGE I/F connector (42-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	MSDAT2-E3P	I/O	2	MSDAT3-E3P	I/O
3	MSBS-E3P	I/O	4	GND	-
5	GND	-	6	FM-E3V	-
7	MSCLK-E3P	I/O	8	MSDAT3-E3P	I/O
9	MSCD-E3N	0	10	MSDAT2-E3P	I/O
11	MSSDIO-E3P	I/O	12	MSDAT1 -E3P	I/O
13	MSBS-E3P	I/O	14	GND	-
15	FM-E3V	-	16	MSCLK-E3P	I/O
17	GND	-	18	MSSDIO-E3P	I/O
19	MSDAT1-E3P	I/O	20	FM-E3V	-
21	SDAT3-E3P	I/O	22	SDAT2-E3P	I/O
23	SDAT1-E3P	I/O	24	SDAT0-E3P	I/O
25	MSDAT3-E3P	I/O	26	MSDAT2-E3P	I/O
27	MSDAT1-E3P	I/O	28	MSSDIO-E3P	I/O
29	GND	-	30	MSCLK-E3P	I/O
31	XDWE-E3N	1	32	SDCMD-E3P	I/O
33	SMCLE-E3P	I/O	34	XDCE-E3N	ı
35	XDRE-E3N	1	36	SMRDY-E3P	I
37	SMCD-E3N	1	38	GND	-
39	GND	-	40	SDCD-E3N	0
41	GND	-	42	SDWP-E3P	0

C.20 CN1400 Memory connector A (200-pin)

Table C-20 Memory connector A (200-pin) (1/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	MR1R25-B1V	-	2	MRVREF-B1V	-
3	GND	-	4	GND	-
5	SDQ00-B2P	I/O	6	SDQ06-B2P	I/O
7	SDQ04-B2P	I/O	8	SDQ01-B2P	I/O
9	2R5-B2V	-	10	2R5-B2V	-
11	SDQS0-B2P	I/O	12	GND	-
13	SDQ05-B2P	I/O	14	SDQ02-B2P	I/O
15	GND	-	16	GND	-
17	SDQ03-B2P	I/O	18	SDQ07-B2P	I/O
19	SDQ13-B2P	I/O	20	SDQ12-B2P	I/O
21	2R5-B2V	-	22	2R5-B2V	-
23	SDQ08-B2P	I/O	24	SDQ09-B2P	I/O
25	SDQS1-B2P	I/O	26	GND	-
27	GND	-	28	GND	-
29	SDQ14-B2P	I/O	30	SDQ11-B2P	I/O
31	SDQ15-B2P	I/O	32	SDQ10-B2P	I/O
33	2R5-B2V	-	34	2R5-B2V	-
35	SCK0-B2P	I	36	2R5-B2V	-
37	SCK0-B2N	I	38	GND	-
39	GND	-	40	GND	-
41	SDQ20-B2P	I/O	42	SDQ22-B2P	I/O
43	SDQ16-B2P	I/O	44	SDQ21-B2P	I/O
45	2R5-B2V	-	46	2R5-B2V	-
47	SDQS2-B2P	I/O	48	GND	-
49	SDQ17-B2P	I/O	50	SDQ19-B2P	I/O
51	GND	-	52	GND	-
53	SDQ18-B2P	I/O	54	SDQ23-B2P	I/O
55	SDQ25-B2P	I/O	56	SDQ29-B2P	I/O
57	2R5-B2V	-	58	2R5-B2V	-
59	SDQ24-B2P	I/O	60	SDQ28-B2P	I/O
61	SDQS3-B2P	I/O	62	GND	-
63	GND	-	64	GND	-

Table C-20 Memory connector A (200-pin) (2/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
65	SDQ26-B2P	I/O	66	SDQ30-B2P	I/O
67	SDQ27-B2P	I/O	68	SDQ31-B2P	I/O
69	2R5-B2V	-	70	2R5-B2V	-
71	SCB5A-B2P	I/O	72	SCB0A-B2P	I/O
73	SCB4A-B2P	I/O	74	SCB1A-B2P	I/O
75	GND	-	76	GND	-
77	SDQS8A-B2P	I/O	78	GND	-
79	SCB2A-B2P	I/O	80	SCB3A-B2P	I/O
81	2R5-B2V	-	82	2R5-B2V	-
83	SCB6A-B2P	I/O	84	SCB7A-B2P	I/O
85	N.C	-	86	N.C	-
87	GND	-	88	GND	-
89	2R5-B2V	-	90	GND	-
91	GND	-	92	2R5-B2V	-
93	2R5-B2V	-	94	2R5-B2V	-
95	SCKE1-B2P	1	96	SCKEO-B2P	1
97	N.C	-	98	N.C	-
99	SMA12-B2P	I	100	SMA11-B2P	1
101	SMA09-B2P	1	102	SMA08-B2P	1
103	GND	-	104	GND	-
105	SMA07-B2P	1	106	SMA06-B2P	I
107	SMA05-B2P	I	108	SMA04-B2P	1
109	SMA03-B2P	I	110	SMA02-B2P	1
111	SMA01-B2P	1	112	SMA00-B2P	1
113	2R5-B2V	-	114	2R5-B2V	-
115	SMA10-B2P	I	116	SBS1-B2P	1
117	SBS0-B2P	1	118	SRAS-B2N	1
119	SWE-B2N	1	120	SCAS-B2N	1
121	SCS0-B2N	1	122	SCS1-B2N	1
123	N.C	-	124	N.C	-
125	GND	-	126	GND	-
127	SDQ37-B2P	I/O	128	SDQ33-B2P	I/O
129	SDQ36-B2P	I/O	130	SDQ32-B2P	I/O
131	2R5-B2V	-	132	2R5-B2V	-
133	SDQS4-B2P	I/O	134	GND	-

Table C-20 Memory connector A (200-pin) (3/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
135	SDQ34-B2P	I/O	136	SDQ39-B2P	I/O
137	GND	-	138	GND	-
139	SDQ38-B2P	I/O	140	SDQ35-B2P	I/O
141	SDQ44-B2P	I/O	142	SDQ41-B2P	I/O
143	2R5-B2V	-	144	2R5-B2V	-
145	SDQ45-B2P	I/O	146	SDQ40-B2P	I/O
147	SDQS5-B2P	I/O	148	GND	-
149	GND	-	150	GND	-
151	SDQ46-B2P	I/O	152	SDQ47-B2P	I/O
153	SDQ42-B2P	I/O	154	SDQ43-B2P	I/O
155	2R5-B2V	-	156	2R5-B2V	-
157	2R5-B2V	-	158	SCK1-B2N	- 1
159	GND	-	160	SCK1-B2P	- 1
161	GND	-	162	GND	-
163	SDQ48-B2P	I/O	164	SDQ54-B2P	I/O
165	SDQ53-B2P	I/O	166	SDQ49-B2P	I/O
167	2R5-B2V	-	168	2R5-B2V	-
169	SDQS6-B2P	I/O	170	GND	-
171	SDQ51-B2P	I/O	172	SDQ50-B2P	I/O
173	GND	-	174	GND	-
175	SDQ52-B2P	I/O	176	SDQ55-B2P	I/O
177	SDQ60-B2P	I/O	178	SDQ57-B2P	I/O
179	2R5-B2V	-	180	2R5-B2V	-
181	SDQ56-B2P	I/O	182	SDQ61-B2P	I/O
183	SDQS7-B2P	I/O	184	GND	-
185	GND	-	186	GND	-
187	SDQ58-B2P	I/O	188	SDQ63-B2P	I/O
189	SDQ59-B2P	I/O	190	SDQ62-B2P	I/O
191	2R5-B2V	-	192	2R5-B2V	-
193	SMBDAT-P3P	I/O	194	GND	-
195	SMBCLK-P3P	1	196	GND	-
197	P3V	-	198	GND	-
199	N.C	_	200	N.C	-

C.21 CN1401 Memory connector B (200-pin)

Table C-21 Memory connector B (200-pin) (1/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	MRVREF-B1V	-	2	MRVREF-B1V	-
3	GND	-	4	GND	-
5	SDQ00-B2P	I/O	6	SDQ06-B2P	I/O
7	SDQ04-B2P	I/O	8	SDQ01-B2P	I/O
9	2R5-B2V	-	10	2R5-B2V	-
11	SDQS0-B2P	I/O	12	GND	-
13	SDQ05-B2P	I/O	14	SDQ02-B2P	I/O
15	GND	-	16	GND	-
17	SDQ03-B2P	I/O	18	SDQ07-B2P	I/O
19	SDQ13-B2P	I/O	20	SDQ12-B2P	I/O
21	2R5-B2V	-	22	2R5-B2V	-
23	SDQ08-B2P	I/O	24	SDQ09-B2P	I/O
25	SDQS1-B2P	I/O	26	GND	-
27	GND	-	28	GND	-
29	SDQ14-B2P	I/O	30	SDQ11-B2P	I/O
31	SDQ15-B2P	I/O	32	SDQ10-B2P	I/O
33	2R5-B2V	-	34	2R5-B2V	-
35	SCK3-B2P	I	36	2R5-B2V	-
37	SCK3-B2N	I	38	GND	-
39	GND	-	40	GND	-
41	SDQ20-B2P	I/O	42	SDQ22-B2P	I/O
43	SDQ16-B2P	I/O	44	SDQ21-B2P	I/O
45	2R5-B2V	-	46	2R5-B2V	-
47	SDQS2-B2P	I/O	48	GND	-
49	SDQ17-B2P	I/O	50	SDQ19-B2P	I/O
51	GND	-	52	GND	-
53	SDQ18-B2P	I/O	54	SDQ23-B2P	I/O
55	SDQ25-B2P	I/O	56	SDQ29-B2P	I/O
57	2R5-B2V	-	58	2R5-B2V	-
59	SDQ24-B2P	I/O	60	SDQ28-B2P	I/O
61	SDQS3-B2P	I/O	62	GND	-

Table C-21 Memory connector B (200-pin) (2/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
63	GND	-	64	GND	-
65	SDQ26-B2P	I/O	66	SDQ30-B2P	I/O
67	SDQ27-B2P	I/O	68	SDQ31-B2P	I/O
69	2R5-B2V	-	70	2R5-B2V	-
71	SCB5B-B2P	I/O	72	SCB0B-B2P	I/O
73	SCB4B-B2P	I/O	74	SCB1B-B2P	I/O
75	GND	-	76	GND	-
77	SDQS8B-B2P	I/O	78	GND	-
79	SCB2B-B2P	I/O	80	SCB3B-B2P	I/O
81	2R5-B2V	-	82	2R5-B2V	-
83	SCB6B-B2P	I/O	84	SCB7B-B2P	I/O
85	N.C	-	86	N.C	-
87	GND	-	88	GND	-
89	2R5-B2V	-	90	GND	-
91	GND	-	92	2R5-B2V	-
93	2R5-B2V	-	94	2R5-B2V	-
95	SCKE3-B2P	I	96	SCKE2-B2P	ı
97	N.C	-	98	N.C	-
99	SMA12-B2P	I	100	SMA11-B2P	ı
101	SMA09-B2P	I	102	SMA08-B2P	ı
103	GND	-	104	GND	-
105	SMA07-B2P	1	106	SMA06-B2P	1
107	SMA05-B2P	1	108	SMA04-B2P	1
109	SMA03-B2P	1	110	SMA02-B2P	1
111	SMA01-B2P	1	112	SMA00-B2P	1
113	2R5-B2V	-	114	2R5-B2V	-
115	SMA10-B2P	1	116	SBS1-B2P	1
117	SBS0-B2P	1	118	SRAS-B2N	1
119	SWE-B2N	1	120	SCAS-B2N	1
121	SCS2-B2N	1	122	SCS3-B2N	1
123	N.C	-	124	N.C	-
125	GND	-	126	GND	-
127	SDQ37-B2P	I/O	128	SDQ33-B2P	I/O
129	SDQ36-B2P	I/O	130	SDQ32-B2P	I/O
131	2R5-B2V	-	132	2R5-B2V	-
133	SDQS4-B2P	I/O	134	GND	-

Table C-21 Memory connector B (200-pin) (3/3)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
135	SDQ34-B2P	I/O	136	SDQ39-B2P	I/O
137	GND	-	138	GND	-
139	SDQ38-B2P	I/O	140	SDQ35-B2P	I/O
141	SDQ44-B2P	I/O	142	SDQ41-B2P	I/O
143	2R5-B2V	-	144	2R5-B2V	-
145	SDQ45-B2P	I/O	146	SDQ40-B2P	I/O
147	SDQS5-B2P	I/O	148	GND	-
149	GND	-	150	GND	-
151	SDQ46-B2P	I/O	152	SDQ47-B2P	I/O
153	SDQ42-B2P	I/O	154	SDQ43-B2P	I/O
155	2R5-B2V	-	156	2R5-B2V	-
157	2R5-B2V	-	158	SCK4-B2N	I
159	GND	-	160	SCK4-B2P	I
161	GND	-	162	GND	-
163	SDQ48-B2P	I/O	164	SDQ54-B2P	I/O
165	SDQ53-B2P	I/O	166	SDQ49-B2P	I/O
167	2R5-B2V	-	168	2R5-B2V	-
169	SDQS6-B2P	I/O	170	GND	-
171	SDQ51-B2P	I/O	172	SDQ50-B2P	I/O
173	GND	-	174	GND	-
175	SDQ52-B2P	I/O	176	SDQ55-B2P	I/O
177	SDQ60-B2P	I/O	178	SDQ57-B2P	I/O
179	2R5-B2V	-	180	2R5-B2V	-
181	SDQ56-B2P	I/O	182	SDQ61-B2P	I/O
183	SDQS7-B2P	I/O	184	GND	-
185	GND	-	186	GND	-
187	SDQ58-B2P	I/O	188	SDQ63-B2P	I/O
189	SDQ59-B2P	I/O	190	SDQ62-B2P	I/O
191	2R5-B2V	-	192	2R5-B2V	-
193	SMBDAT-P3P	I/O	194	P3V	-
195	SMBCLK-P3P	I	196	GND	-
197	P3V	-	198	GND	-
199	N.C	-	200	N.C	

C.22 CN2200 Mini PCI I/F connector (124-pin)

Table C-22 Mini PCI I/F connector (124-pin) (1/2)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	N.C.	-	2	N.C.	-
3	N.C.	-	4	N.C.	-
5	N.C.	-	6	N.C.	-
7	N.C.	-	8	N.C.	-
9	N.C.	-	10	N.C.	-
11	N.C.	-	12	N.C.	-
13	WLON-S5N	- 1	14	N.C.	-
15	GND	-	16	N.C.	-
17	PIRQD-P3N	1	18	P5V	-
19	P3V	-	20	PIRQA-P3N	О
21	N.C.	-	22	N.C.	-
23	GND	-	24	E3V	-
25	X33MPC-P3P	1	26	PCIRS1-S3N	О
27	GND	-	28	P3V	-
29	PREQ2-P3N	1	30	PGNT2-P3N	О
31	P3V	-	32	GND	-
33	AD31-P3P	I/O	34	PME-S3N	0
35	AD29-P3P	I/O	36	WCHCLK-P3P	О
37	GND	-	38	AD30-P3P	I/O
39	AD27-P3P	I/O	40	P3V	-
41	AD25-P3P	I/O	42	AD28-P3P	I/O
43	WCHDAT-P3P	0	44	AD26-P3P	I/O
45	CBE3-P3N	I/O	46	AD24-P3P	I/O
47	AD23-P3P	I/O	48	AD21-P3P	I/O
49	GND	-	50	GND	-
51	AD21-P3P	I/O	52	AD22-P3P	I/O
53	AD19-P3P	I/O	54	AD20-P3P	I/O
55	GND	-	56	PAR-P3P	I/O
57	AD17-P3P	I/O	58	AD18-P3P	I/O
59	CBE2-P3N	I/O	60	AD16-P3P	l/O

Table C-22 Mini PCI I/F connector (124-pin)(2/2)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
61	IRDY-P3N	I/O	62	GND	-
63	P3V	-	64	FRAME-P3N	I/O
65	CLKRUN-P3N	I/O	66	TRDY-P3N	I/O
67	SERR-P3N	1	68	STOP-P3N	I/O
69	GND	-	70	P3V	-
71	PERR-P3N	I/O	72	DEVSEL-P3N	I/O
73	CBE1-P3N	I/O	74	GND	-
75	AD14-P3P	I/O	76	AD15-P3P	I/O
77	GND	-	78	AD13-P3P	I/O
79	AD12-P3P	I/O	80	AD11-P3P	I/O
81	AD10-P3P	I/O	82	GND	-
83	GND	-	84	AD09-P3P	I/O
85	AD08-P3P	I/O	86	CBE0-P3N	I/O
87	AD07-P3P	I/O	88	P3V	-
89	P3V	-	90	AD06-P3P	I/O
91	AD05-P3P	I/O	92	AD04-P3P	I/O
93	N.C.	-	94	AD02-P3P	I/O
95	AD03-P3P	I/O	96	AD00-P3P	I/O
97	P5V	-	98	N.C.	-
99	AD01-P3P	I/O	100	N.C.	-
101	GND	-	102	GND	-
103	N.C.	-	104	GND	-
105	N.C.	-	106	N.C.	-
107	N.C.	-	108	N.C.	-
109	N.C.	-	110	N.C.	-
111	N.C.	-	112	N.C.	-
113	GND	-	114	GND	-
115	N.C.	-	116	N.C.	-
117	GND	-	118	N.C.	-
119	GND	-	120	GND	-
121	N.C.	-	122	N.C.	-
123	N.C.	-	124	E3V	-

C.23 CN2400 WW Tuner I/F connector (124-pin)

Table C-23 WW Tuner I/F connector (124-pin) (1/2)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	N.C.	-	2	N.C.	-
3	N.C.	-	4	N.C.	-
5	N.C.	-	6	N.C.	-
7	N.C.	-	8	N.C.	-
9	GND	-	10	GND	-
11	N.C.	-	12	N.C.	-
13	N.C.	-	14	N.C.	-
15	GND	-	16	N.C.	-
17	N.C.	-	18	T-P5V	-
19	P3V	-	20	PIRQD-P3N	0
21	N.C.	-	22	N.C.	-
23	GND	-	24	N.C.	-
25	X33MPT-P3P	- 1	26	PCIRS1-S3N	0
27	GND	-	28	P3V	-
29	PREQ1-P3N	- 1	30	PGNT1-P3N	0
31	T-P3V	-	32	GND	-
33	AD31-P3P	I/O	34	N.C.	-
35	AD29-P3P	I/O	36	N.C.	-
37	GND	-	38	AD30-P3P	I/O
39	AD27-P3P	I/O	40	T-P3V	-
41	AD25-P3P	I/O	42	AD28-P3P	I/O
43	N.C.	-	44	AD26-P3P	I/O
45	CBE3-P3N	I/O	46	AD24-P3P	I/O
47	AD23-P3P	I/O	48	AD25-P3P	I/O
49	GND	-	50	GND	-
51	AD21-P3P	I/O	52	AD22-P3P	I/O
53	AD19-P3P	I/O	54	AD20-P3P	I/O
55	GND	-	56	PAR-P3P	I/O
57	AD17-P3P	I/O	58	AD18-P3P	I/O
59	CBE2-P3N	I/O	60	AD16-P3P	I/O
61	IRDY-P3N	I/O	62	GND	-

Table C-23 WW Tuner I/F connector (124-pin)(2/2)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
63	T-P3V	-	64	FRAME-P3N	I/O
65	CLKRUN-P3N	I/O	66	TRDY-P3N	I/O
67	SERR-P3N	- 1	68	STOP-P3N	I/O
69	GND	-	70	T-P3V	-
71	PERR-P3N	I/O	72	DEVSEL-P3N	I/O
73	CBE1-P3N	I/O	74	GND	-
75	AD14-P3P	I/O	76	AD15-P3P	I/O
77	GND	-	78	AD13-P3P	I/O
79	AD12-P3P	I/O	80	AD11-P3P	I/O
81	AD10-P3P	I/O	82	GND	-
83	GND	-	84	AD09-P3P	I/O
85	AD08-P3P	I/O	86	CBE0-P3N	I/O
87	AD07-P3P	I/O	88	T-P3V	-
89	T-P3V	-	90	AD06-P3P	I/O
91	AD05-P3P	I/O	92	AD04-P3P	I/O
93	T-P5V	-	94	AD02-P3P	I/O
95	AD03-P3P	I/O	96	AD00-P3P	I/O
97	T-P5V	-	98	T-P5V	-
99	AD01-P3P	I/O	100	N.C.	-
101	GND	-	102	GND	-
103	N.C.	-	104	N.C.	-
105	N.C.	-	106	N.C.	-
107	N.C.	-	108	N.C.	-
109	N.C.	-	110	TMPTUN-SXP	I/O
111	N.C.	-	112	GND	-
113	GND	-	114	GND	-
115	N.C.	-	116	GND	-
117	GND	-	118	GND	-
119	GND	-	120	GND	-
121	N.C.	-	122	N.C.	-
123	T-P5V		124	N.C.	-

C.24 CN3201 PAD I/F connector (4-pin)

Table C-24 PAD I/F connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND	-	2	IPDCLK-P5P	I/O
3	IPDDAT-P5P	I/O	4	GND	-

C.25 PJ5600 LCD I/F connector (41-pin)

Table C-25 LCD I/F connector (41-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	BRT0-P5P	0	2	BRT1-P5P	0
3	BRT2DA-S3P	0	4	GND	-
5	N.C.	-	6	GND	-
7	GND	-	8	GND	-
9	PNL0-P3P	0	10	P3V	-
11	NV3SCL-P3P	I/O	12	NV3SDA-P3P	I/O
13	GND	-	14	TXCK0-P3N	- 1
15	TXCK0-P3P	I	16	GND	-
17	TXDT0-P3N	I	18	TXDT0-P3P	0
19	GND	-	20	TXDT1-P3N	0
21	TXDT1-P3P	I	22	GND	-
23	TXDT2-P3N	I	24	TXDT2-P3P	0
25	GND	-	26	FL-P5V	- 1
27	FL-P5V	I	28	FL-P5V	1
29	FL-P5V	I	30	FL-P5V	1
31	FL-P5V	I	32	PNL-P3V	1
33	PNL-P3V	1	34	PNL1-P3P	0
35	GND	-	36	PNL2-P3P	0
37	GND	-	38	GND	-
39	GND	-	40	GND	-
41	GND				

C.26 CN5080 CRT I/F connector (15-pin)

Table C-26 CRT I/F connector (15-pin)

PIN No.	Signal name	1/0	PIN No.	Signal name	I/O
1	CRTRED-PXP	I	2	CRTGRN- PXP	I
3	CRTBLU-PXP	I	4	N.C	-
5	GND	-	6	GND	-
7	GND	-	8	GND	-
9	DDC-P5V	I	10	GND	-
11	N.C	-	12	NVDSDA-P5P	I/O
13	(AHSYNC- P3P)	0	14	(AVSYNC- P3P)	I/O
15	NVDSCL-P5P	I/O			

C.27 CN5501 S-video I/F connector (4-pin)

Table C-27 S-video I/F connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND	-	2	GND	-
3	(TADACC- PXP)	I	4	(TVDACB- PXP)	_

C.28 CN3400 Debug port (4-pin)

Table C-28 Debug port (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	P3V	-	2	DBGRX-E3P	0
3	(TXD1)	1	4	GND	-

C.29 CN5502 D-video I/F connector (14-pin)

Table C-29 D-video I/F connector (14-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	HDTVY-PXP	I	2	GND	-
3	HDTVPB-PXP	I	4	GND	-
5	HDTVPR-PXP	I	6	GND	-
7	LINOTL-PXP	I	8	(LINE1)	I/O
9	(LINE2)	I/O	10	LINOTR-PXP	I
11	(LINE3)	I/O	12	GND	-
13	LINOT-GND	I	14	P5V	-

C.30 CN5801 TV Input connector (14-pin)

Table C-30 TV Input connector (14-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	GND	-	2	GND	-
3	CHRMIN-PXP	0	4	GND	-
5	LUMAIN-PXP	0	6	GND	-
7	GND	-	8	COMPIN-PXP	0
9	GND	-	10	GND	-
11	LINOTL-PXP	0	12	LINOT-GND	0
13	LINOTR-PXP	0	14	GND	-

SD Board (FCLSD*)

C.31 CN3000 MDC I/F connector (30-pin)

Table C-31 MDC I/F connector (30-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	N.C	-	2	GND	-
3	GND	-	4	N.C	-
5	N.C	-	6	N.C	-
7	N.C	-	8	GND	-
9	N.C	-	10	N.C	-
11	N.C	-	12	N.C	-
13	N.C	-	14	N.C	-
15	GND	-	16	E3V	-
17	E3V	-	18	N.C	-
19	GND	-	20	GND	-
21	N.C	-	22	M97SY2-P3P	1
23	M97OT2-P3P	1	24	N.C	-
25	M97RS2-S3N	I	26	M97IN2-E3P	0
27	GND	-	28	GND	-
29	GND	ı	30	X97BC2-P3P	I/O

C.32 CN4620 USB I/F Relay connector (8-pin)

Table C-32 USB I/F Relay connector (8-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	(VCC)	-	2	(VCC)	-
3	(Port4+)	I/O	4	(Port4-)	I/O
5	GND	-	6	GND	-
7	GND	-	8	N.C.	-

C.33 CN4621 USB I/F connector (port 4) (4-pin)

Table C-33 USB I/F connector (port 4) (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	(USBV)	-	2	(D-0)	I/O
3	(D+0)	I/O	4	GND	-

C.34 CN6002 Speaker (left) connector (3-pin)

Table C-34 Speaker (left) connector (3-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	SPOTR-PXN	0	2	SPOTR-PXP	0
3	SPOTL-PXP	0			

C.35 CN6003 Speaker (right) connector (2-pin)

Table C-35 Speaker (right) connector (2-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	SPOTR-PXN	0	2	SPOTR-PXP	0

C.36 CN9550 Sound jack board I/F connector (21-pin)

Table C-36 Sound jack board I/F connector (21-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	VREF1-P2V	I	2	MICIN-PXP	1
3	LOUTL-PXP	- 1	4	A-GND	-
5	LOUTR-PXP	I	6	A-GND	-
7	VOLOL-PXP	- 1	8	A-GND	-
9	VOLOR-PXP	- 1	10	A-GND	-
11	HEADL-PXP	I	12	A-GND	-
13	HEADR-PXP	- 1	14	A4R7-P4V	-
15	A4R7-P4V	-	16	SPKEN-P4P	1
17	SPD3V-P3V	I	18	DOUT-P3P	1
19	SDPJIN-P3N	1	20	GND	-
21	VOLBYP-P3N	- 1			

C.37 CN9510 System board I/F connector (50-pin)

Table C-37 System board I/F connector (50-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	SPKON-P3N	-	2	VOLBYP-P3N	I/O
3	FMTST0-P3P	- 1	4	SVSDA-P3P	I/O
5	SVSCL-P3P	I/O	6	GND	-
7	SUSCLK-P3P	0	8	GND	-
9	M97IN2-E3P	- 1	10	GND	-
11	M97RS2-S3N	I	12	GND	-
13	M97OT2-P3P	I	14	GND	-
15	M97SY2-P3P	- 1	16	E3V	-
17	E3V	-	18	M97IN1-E3P	I
19	GND	-	20	M97BC1-P3P	I
21	GND	-	22	M97RS1-P3N	ı
23	GND	-	24	M97OT1-P3P	I
25	GND	-	26	M97SY1-P3P	I
27	GND	-	28	X14SND-P3P	I/O
29	GND	-	30	SNDMUT-S3N	I
31	P3V	-	32	P3V	-
33	AMPSD-S3N	- 1	34	SND-P5V	-
35	SND-P5V	-	36	SND-P5V	-
37	SND-P5V	-	38	SND-P5V	-
39	PCBEEP-E3P	- 1	40	ATBEEP-P3P	-
41	SND-GND	-	42	SND-GND	-
43	SND-GND	-	44	SND-GND	-
45	SND-GND	-	46	CD-GND	-
47	CDAUDR-PXP	I/O	48	CD-GND	-
49	CDAUDL-PXP	I	50	CD-GND	-

C.38 J2410 TV Antenna connector (4-pin)

Table C-38 TV antenna connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	(CN9611-3)	I/O	2	(CN9611-1)	I/O
3	(CN9611-2)	I/O	4	(CN9611-4)	I/O

C.39 CN2410 Coaxial connector (4-pin)

Table C-39 Coaxial connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	(CN9610-2)	I/O	2	(CN9610-3)	I/O
3	(CN9610-1)	I/O	4	(CN9610-4)	I/O

C.40 J9612 Composite-in connector (5-pin)

Table C-40 Composite-in connector (5-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	LINR-PXP	0	2	TV-GND	-
3	COMPIN-PXP	0	4	LINL-PXP	0
5	TV-GND	-			

C.41 CN9613 S-video connector (4-pin)

Table C-41 S-video connector (4-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TV-GND	-	2	TV-GND	-
3	LUMAIN-PXP	0	4	CROMIN-PXP	0

C.42 CN9614 TV-tuner connector (12-pin)

Table C-42 TV-tuner connector (12-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TV-GND	-	2	LINL-PXP	I
3	TV-GND	-	4	LINR-PXP	I
5	TV-GND	-	6	COMP01-PXP	I
7	TV-GND	-	8	LUMA01-PXP	I
9	TV-GND	-	10	CROM01-PXP	I
11	TV-GND	-	12	TV-GND	-

C.43 CN9615 SVP connector (14-pin)

Table C-43 SVP connector (14-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	TV-GND	-	2	TV-GND	-
3	CROM02-PXP	1	4	TV-GND	-
5	LUMA02-PXP	1	6	TV-GND	-
7	TV-GND	-	8	COMP02-PXP	1
9	TV-P5V	-	10	TV-GND	-
11	LINOTL-PXP	1	12	A-GND	-
13	LINOTR-PXP	I	14	TV-GND	-

SJ board (FCLSJ*)

C.44 CN6000 Internal Microphone I/F connector (2-pin)

Table C-44 Internal Microphone I/F connector (2-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	(VREF1-P2V)	I	2	A-GND	-

C.45 J6001 External Microphone I/F connector (6-pin)

Table C-45 External Microphone I/F connector (6-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	A-GND	-	2	(MICIN-PXP)	0
3	(BIAS)	0	4	N.C.	-
5	N.C.	-	6	(VREF1-P2V)	0

C.46 DS6000 Headphone connector (8-pin)

Table C-46 Headphone connector (8-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	SPKEN-P4P		2	HEADL-PXP	I
3	HEADR-PXP	1	4	A-GND	-
5	SDPJIN-P3N	1			
7	DOUT-P3P	- 1	8	SPD3V-P3V	
9	GND	-			

C.47 CN9560 Sound board I/F connector (21-pin)

Table C-47 Sound board I/F connector (21-pin)

PIN No.	Signal name	I/O	PIN No.	Signal name	I/O
1	VREF1-P2V	0	2	MICIN-PXP	0
3	LOUTL-PXP	0	4	A-GND	-
5	LOUTR-PXP	0	6	A-GND	-
7	VOLOL-PXP	0	8	A-GND	-
9	VOLOR-PXP	0	10	A-GND	-
11	HEADL-PXP	0	12	A-GND	-
13	HEADR-PXP	0	14	A4R7-P4V	-
15	A4R7-P4V	-	16	SPKEN-P4P	0
17	SPD3V-P3V	0	18	DOUT-P3P	0
19	SDPJIN-P3N	0	20	GND	-
21	VOLBYP-P3N	0			

Appendix D Keyboard Scan/Character Codes

Table D-1 Scan codes (set 1 and set 2) (1/4)

Сар	Voyton	Code	set 1	(Code set 2	2	Note
No.	Keytop	Make	Break	Make	Bre	ak	Note
01	٠ ~	29	A9	0E	F0	0E	
02	1 !	02	82	16	F0	16	
03	2 @	03	83	1E	F0	1E	
04	3 #	04	84	26	F0	26	
05	4 \$	05	85	25	F0	25	
06	5 %	06	86	2E	F0	2E	
07	6 ^	07	87	36	F0	36	
08	7 &	08	88	3D	F0	3D	*2
09	8 *	09	89	3E	F0	3E	*2
10	9 (0A	8A	46	F0	46	*2
11	0)	0B	8B	45	F0	45	
12		0C	8C	4E	F0	4E	
13	= +	0D	8D	55	F0	55	
15	BkSp	0E	8E	66	F0	66	
16	Tab	0F	8F	0D	F0	0D	
17	Q	10	90	15	F0	15	
18	W	11	91	1D	F0	1D	
19	Е	12	92	24	F0	24	
20	R	13	93	2D	F0	2D	
21	Т	14	94	2C	F0	2C	
22	Υ	15	95	35	F0	35	
23	U	16	96	3C	F0	3C	*2
24	I	17	97	43	F0	43	*2
25	0	13	98	44	F0	44	*2
26	Р	19	99	4D	F0	4D	*2
27	[{	1A	9A	54	F0	54	
28] }	1B	9B	5B	F0	5B	

Table D-1 Scan codes (set 1 and set 2) (2/4)

Сар	Keytop	Code	set 1	(Code set 2	2	Note
No.	Reylop	Make	Break	Make	Bre	ak	Note
29	\	2B	AB	5D	F0	5D	*5
30	Caps Lock	ЗА	ВА	58	F0	58	
31	Α	1E	9E	1C	F0	1C	
32	S	1F	9F	1B	F0	1B	
33	D	20	Α0	23	F0	23	
34	F	21	A1	2B	F0	2B	
35	G	22	A2	34	F0	34	
36	Н	23	А3	33	F0	33	
37	J	24	A4	3B	F0	3B	*2
38	K	25	A5	42	F0	42	*2
39	L	26	A6	4B	F0	4B	*2
40	; :	27	A7	4C	F0	4C	*2
41	""	28	A8	52	F0	52	
43	Enter	1C	9C	5A	F0	5A	*3
44	Shift (L)	2A	AA	12	F0	12	
45	No.102 key	56	D6	61	F0	61	
46	Z	2C	AC	1A	F0	1A	
47	Х	2D	AD	22	F0	22	
48	С	2E	AE	21	F0	21	
49	V	2F	AF	2A	F0	2A	
50	В	30	В0	32	F0	32	
51	N	31	B1	31	F0	31	
52	М	32	B2	ЗА	F0	ЗА	*2
53	, <	33	В3	41	F0	41	*2
54	. >	34	B4	49	F0	49	*2
55	/ ?	35	B5	4A	F0	4A	*2
57	Shift (R)	36	В6	59	F0	59	

Table D-1 Scan codes (set 1 and set 2) (3/4)

Сар	Kouton		Code	set 1			(Code s	et 2		Note
No.	Keytop	Ma	ake	Br	eak	Ma	ake		Brea	k	Note
58	Ctrl	1	ID	9)D	,	14	FO)	14	*3
60	Alt (L)	(38	E	38		11	FO)	11	*3
61	Space	(39	E	39	2	29	F0)	29	
62	ALT (R)	E0	38	E0	B8	E0	11	E0	F0	11	
75	Ins	E0	52	E0	D2	E0	70	E0	F0	70	*1
76	Del	E0	53	E0	D3	E0	71	E0	F0	71	*1
79	? ?	ΕO	4B	E0	СВ	E0	6B	E0	F0	6B	*1
80	Home	E0	47	E0	C7	E0	6C	E0	F0	6C	*1
81	End	E0	4F	E0	CF	E0	69	E0	F0	69	*1
83	??	E0	48	E0	C8	E0	75	E0	F0	75	*1
84	??	E0	50	E0	D0	E0	72	E0	F0	72	*1
85	PgUp	E0	49	E0	C9	E0	7D	E0	F0	7D	*1
86	PgDn ?	E0	51	E0	D1	E0	7A	E0	F0	7A	*1
89	? ?	E0	4D	E0	CD	E0	74	E0	F0	74	*1
110	Esc		01		81		76	F0		76	
112	F1		3B		ВВ		05	F0		05	
113	F2		3C		вс		06	F0		06	
114	F3		3D		BD		04	F0		04	
115	F4		3E		BE		0C	F0		0C	
116	F5		3F		BF		03	F0		03	
117	F6		40		C0		0B	F0		0B	
118	F7		41		C1		83	F0		83	
119	F8		42		C2		0A	F0		0A	
120	F9		43		C3		01	F0		01	
121	F10		44		C4		09	F0		09	*3

Table D-1 Scan codes (set 1 and set 2) (4/4)

Сар	Kouton	Cod	e set 1		Code set 2	Note
No.	Keytop	Make	Break	Make	Break	Note
122	F11	57	D7	78	F0 78	*3
123	F12	58	D8	07	F0 07	*3
124	PrintSc	*6	*6	*6	*6	*6
126	Pause	*7	*7	*7	*7	*7
202	Fn	_	_	_	_	*4
203	Win	E0 5B	E0 DB	E0 1F	E0 F0 1F	
204	Арр	E0 5D	E0 DD	E0 2F	E0 F0 2F	

Notes:

- 1. * Scan codes differ by mode.
- 2. * Scan codes differ by overlay function.
- 3. * Combined with the **Fn** key makes different codes.
- 4. * **Fn** key does not generate a code by itself.
- 5. * This key corresponds to key No. 42 in a 102-key model.
- 6. * Refer to Table D-6, No. 124 key scan code.
- 7. * Refer to Table D-7, No. 126 key scan code.

Table D-2 Scan codes with left Shift key

Сар	Key			(Code	set 1							(Code	set 2)			
No.	top		Ma	ike			Bre	eak				Make	•			E	3real	<	
55	/	E0	AA	E0	35	E0	B5	E0	2A	E0	F0	12	E0	4A	E0	F0	4A	E0	12
75	INS	E0	AA	E0	52	E0	D2	E0	2A	E0	F0	12	E0	70	E0	F0	70	E0	12
76	DEL	E0	AA	E0	53	E0	D3	E0	2A	E0	F0	12	E0	71	E0	F0	71	E0	12
79	? ?	E0	AA	E0	4B	E0	СВ	E0	2A	E0	F0	12	E0	6B	E0	F0	6B	E0	12
80	Home	E0	AA	E0	47	E0	C7	E0	2A	E0	F0	12	E0	6C	E0	F0	6C	E0	12
81	End	E0	AA	E0	4F	E0	CF	E0	2A	E0	F0	12	E0	69	E0	F0	69	E0	12
83	??	E0	AA	E0	48	E0	C8	E0	2A	E0	F0	12	E0	75	E0	F0	75	E0	12
84	??	E0	AA	E0	50	E0	D0	E0	2A	E0	F0	12	E0	72	E0	F0	72	E0	12
85	PgUp	E0	AA	E0	49	E0	C9	E0	2A	E0	F0	12	E0	7D	E0	F0	7D	E0	12
86	PgDn	E0	AA	E0	51	E0	D1	E0	2A	E0	F0	12	E0	7A	E0	F0	7A	E0	12
89	? ?	E0	AA	E0	4D	E0	CD	E0	2A	E0	F0	12	E0	74	E0	F0	74	E0	12
203	Win	E0	AA	E0	5B	E0	DB	E0	2A	E0	F0	12	E0	1F	E0	F0	1F	E0	12
204	Арр	E0	AA	E0	5D	E0	DD	E0	2A	E0	F0	12	E0	2F	E0	F0	2F	E0	12

Note: The table above shows scan codes with the left **Shift** key. In combination with the right **Shift** key, scan codes are changed as listed below:

	With left Shift	With right Shift
Set 1	E0 AA	E0 B6
	E0 2A	E0 36
Set 2	E0 F0 12	E0 F0 59
	E0 12	E0 59

Table D-3 Scan codes in Numlock mode

Сар	Key				Code	set	1						(Code	set 2	2			
No.	top		Ма	ke			Br	eak			Ma	ake				Bre	ak		
75	INS	E0	2A	E0	52	E0	D2	E0	AA	E0	12	E0	70	E0	F0	70	E0	F0	12
76	DEL	E0	2A	E0	53	E0	D3	E0	AA	E0	12	E0	71	E0	F0	71	E0	F0	12
79	? ?	E0	2A	E0	4B	E0	СВ	E0	AA	E0	12	E0	6B	E0	F0	6B	E0	F0	12
80	Home	E0	2A	E0	47	E0	C7	E0	AA	E0	12	E0	6C	E0	F0	6C	E0	F0	12
81	End	E0	2A	E0	4F	E0	CF	E0	AA	E0	12	E0	69	E0	F0	69	E0	F0	12
83	??	E0	2A	E0	48	E0	C8	E0	AA	E0	12	E0	75	E0	F0	75	E0	F0	12
84	??	E0	2A	E0	50	E0	D0	E0	AA	E0	12	E0	72	E0	F0	72	E0	F0	12
85	PgUp	E0	2A	E0	49	E0	C9	E0	AA	E0	12	E0	7D	E0	F0	7D	E0	F0	12
86	PgDn	E0	2A	E0	51	E0	D1	E0	AA	E0	12	E0	7A	E0	F0	7A	E0	F0	12
89	? ?	E0	2A	E0	4D	E0	CD	E0	AA	E0	12	E0	74	E0	F0	74	E0	F0	12
203	Win	E0	2A	E0	5B	E0	DB	E0	AA	E0	12	E0	1F	E0	F0	1F	E0	F0	12
204	Арр	E0	2A	E0	5D	E0	DD	E0	AA	E0	12	E0	2F	E0	F0	2F	E0	F0	12

Table D-4 Scan codes with Fn key

Сар			Code	set 1			C	ode se	t 2	
No.	Keytop	N	/lake	В	reak	М	ake		Break	
43	ENT	E0	1C	E0	9C	E0	5A	E0	F0	5A
58	CTRL	E0	1D	E0	9D	E0	14	E0	F0	14
60	LALT	E0	38	E0	B8	E0	11	E0	F0	11
121	ARROW		45		C5		77	F)	77
122	NUMERIC		45		C5		77	F)	77
123	Scrl	46		C5		7E		F0		7E

Table D-5 Scan codes in overlay mode

Сар	Ko	ytop		Code	e set 1			C	ode se	t 2	
No.	Ne	ytop	Ma	ake	Bre	eak	Ма	ke		Break	
09	8	(8)	4	18	С	8	7	5	F0		75
10	9	(9)	4	19	С	9	7	D	F0		7D
11	0	(*)	3	37	В	7	7	С	F0		7C
23	U	(4)	4	ŀΒ	С	В	6	В	F0		6B
24	1	(5)	4	IC .	С	С	7	3	F0		73
25	0	(6)	4	I D	С	D	7	4	F0		74
26	Р	(-)	4	ŀΑ	С	Α	7	В	F0		7B
37	J	(1)	4	ŀF	С	F	6	9	F0		69
38	K	(2)	5	50	D	0	7	2	F0		72
39	L	(3)	5	51	D	1	7.	A	F0		7A
40	;	(+)	4	ŀΕ	С	E	7	9	F0		79
52	М	(0)	5	52	D	2	7	0	F0		70
54		(.)	53		D3		71		F0		71
55	/	(/)	E0	35	E0	B5	40	4A	E0	F0	4A

Table D-6 No.124 key scan code

Key	Shift				Code	e set 1								Code	set 2	2			
top	Office		Ma	ke			Bre	eak			Ma	ake				Br	eak		
Prt Sc	Common	E0	2A	E0	37	E0	В7	E0	AA	E0	12	E0	7C	E0	F0	7C	E0	F0	12
	Ctrl ?		E0	37			E0	В7			E0	7C			E0	F0	7C		
	Shift ?		E0	37			E0	В7			E0	7C			E0	F0	7C		
	Alt ?			54			D4					84			F0	B4			

Table D-7 No.126 key scan code

Key	Shift			Code	e set	1				(Code	set 2	2		
top				M				Ма	ıke						
Pause	Common*	E1	1D	45	E1	9D	C5	E1	14	77	E1	F0	14	F0	77
	Ctrl*	E0	46	E0	C6			E0	7E	E0	F0	7E			

^{*:} This key generates only make codes.

Appendix E Key Layout

E.1 Keyboard Layout

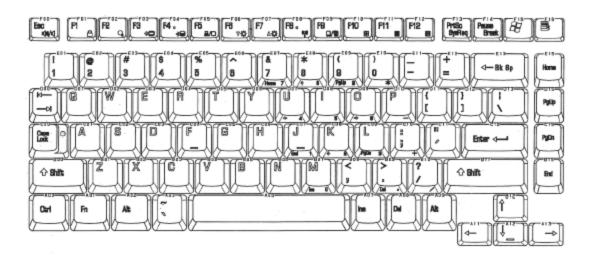


Figure E-1 Keyboard layout (for US)

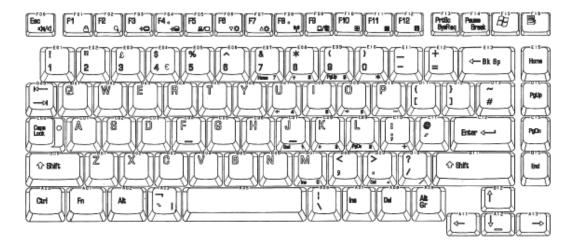


Figure E-2 Keyboard layout (for UK)

Appendix F Wiring Diagrams

F.1 LAN Loopback Connector

```
(1) BIBAP '(TX+) (3) BIDBP (RX+)
(2) BIDAN (TX-) (4) BIDBN (RX-)
```

Figure F-1 LAN loopback connector

Appendix G BIOS Rewrite Procedures

This Appendix explains how to rewrite the system BIOS program when you update the system BIOS.

Tools

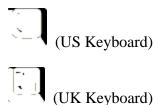
To rewrite the BIOS, you need the following tool:

Rewriting the BIOS

NOTE: 1. Connect the AC adapter to the computer when you rewrite the BIOS.

- 2. Do not turn off the power while you are rewriting the BIOS. If the rewrite fails, it might be impossible to start up the computer.
- 3. If you fail to rewrite BIOS, then when you next turn on the power, a message may be displayed that the contents of the BIOS have been erased. In this case, insert the BIOS/EC/KBC rewriting disk, and the BIOS will be rewritten.
- 1. Set the system to boot mode.
- 2. Turn off the power to the computer.
- 3. Remove the external cables and cards.
- 4. Connect an external FDD and insert the BIOS/EC/KBC rewriting disk into the external FDD.
- 5. Turn on the power while holding down the No. 01 key.

For example



(Keep holding down the key until a message appears on the screen.)

The BIOS rewriting starts.

6. When the process is completed, a beep sounds. Eject the BIOS/EC/KBC rewriting disk and the system is automatically restart.

Appendix H EC/KBC Rewrite Procedures

This Appendix explains how to rewrite the EC/KBC system program when you update the EC/KBC system.

Tools

To rewrite the EC/KBC, you need the following tool:

∠ EC/KBC rewriting disk for the computer

Rewriting the EC/KBC

- **NOTE:** 1. Rewrite the EC/KBS only when instructed by a diagnostic disk release notice.
 - 2. Connect the AC adapter to the computer when you rewrite the EC/KBC.
 - 3. Do not turn off the power while you are rewriting the EC/KBC. If the rewrite fails, it might be impossible to start up the computer.
 - 4. If you fail to rewrite EC/KBC, then when you next turn on the power, a message may be displayed that the contents of the EC/KBC have been erased. In this case, insert the EC/KBC rewriting disk, and the EC/KBC will be rewritten.
 - 5. Normally it takes about 30 seconds to rewrite the EC/KBC. It may take 3 minutes (maximum), depending on the conditions of the computer or ICs. The computer is not hung up. Allow sufficient time. Never reboot or turn off the power to the computer before the rewriting is completed.
 - 1. Set the system to boot mode.
 - 2. Turn off the power to the computer.
 - 3. Remove the external cables and cards.
 - 4. Connect an external FDD and insert the EC/KBC rewriting disk into the external FDD.
 - 5. Turn on the power while holding down the Tab key. (Keep holding down the key until a message appears on the screen.) The EC/KBC rewriting starts.
 - 6. When the EC/KBC rewrite is completed, a beep sounds and the system is automatically turned off.

Appendix I Reliability

The following table shows MTBF (Mean Time Between Failures) in maximum configuration.

Table I-1 MTBF

Component	Time (hours)
System	5,277

Free Manuals Download Website

http://myh66.com

http://usermanuals.us

http://www.somanuals.com

http://www.4manuals.cc

http://www.manual-lib.com

http://www.404manual.com

http://www.luxmanual.com

http://aubethermostatmanual.com

Golf course search by state

http://golfingnear.com

Email search by domain

http://emailbydomain.com

Auto manuals search

http://auto.somanuals.com

TV manuals search

http://tv.somanuals.com